

PCA9450

Power management IC for i.MX 8M application processor family

Rev. 2.2 — 15 September 2021

Product data sheet

1 General description

PCA9450 is a single chip Power Management IC (PMIC) specifically designed to support i.MX 8M family processor in both 1 cell Li-Ion and Li-polymer battery portable application and 5 V adapter non-portable applications. It supports various memory types (DDR4/LPDDR4/DDR3L, etc.) via system UBOOT configuration, which does not require hardware change.

The device provides six high efficiency step-down regulators, five LDOs, one 400 mA load switch, 2-channel level translator and 32.768 kHz crystal oscillator driver. Three buck regulators support Dynamic Voltage Scaling (DVS) feature along with programmable ramping up and down time and those buck regulators support remote sense to compensate IR drop to load from buck regulator. This device is characterized across -40 °C to 105 °C ambient temperature range.

Six step-down regulators are designed to provide power for i.MX 8M application processor and DRAM memory. Two LDOs, LDO1 and LDO2, feature very low quiescent current to provide power for Secure Non-Volatile Storage (SNVS) since these LDOs are always ON when input voltage is valid.

PCA9450 integrates logic translator which is a 2-bit, dual supply translating transceiver with auto direction sensing. It enables bidirectional voltage level translation. It can be used as I²C level translator. 400 mA load switch is to supply 3.3 V power supply to SD card, which has internal discharge resistor.

PCA9450 has three versions: PCA9450AA is companion PMIC for (i.MX 8M Mini), PCA9450B is companion PMIC for i.MX 8M Nano and PCA9450C is companion PMIC for i.MX 8M Plus.

The PCA9450 is offered in 56-pin HVQFN package, 7 mm x 7 mm, 0.4 mm pitch.

2 Features and benefits

- Six high-efficiency step-down regulators
 - Three 3 A buck regulators with DVS feature and remote sense
 - PCA9450AA – Three 3 A buck regulators
 - PCA9450B – Two 3 A buck regulators
 - PCA9450C – 6 A dual-phase buck regulator and 3 A buck regulator
- One 3 A buck regulator
- Two 2 A buck regulators
- Five linear regulators
 - Two 10 mA LDOs
 - One 150 mA LDO
 - One 200 mA LDO
 - One 300 mA LDO



- Support various memory types: DDR4/LPDDR4/DDR3L via system UBOOT configuration, no hardware change required
- 400 mA load switch with built-in active discharge resistor
- 32.768 kHz crystal oscillator driver and buffer output
- Two channel logic level translator
- Power control IO
 - Power ON/OFF control
 - Standby/run mode control
- Fm+ 1 MHz I²C-bus interface
- ESD protection
 - Human Body Model (HBM) : +/- 2000 V
 - Charged Device Model (CDM) : +/-500 V
- 7 mm x 7 mm, 56-pin HVQFN with 0.4 mm pitch

3 Applications

- IoT Devices
- Tablet
- Electronic Point of Sale (ePOS)
- Industrial application

4 Ordering information

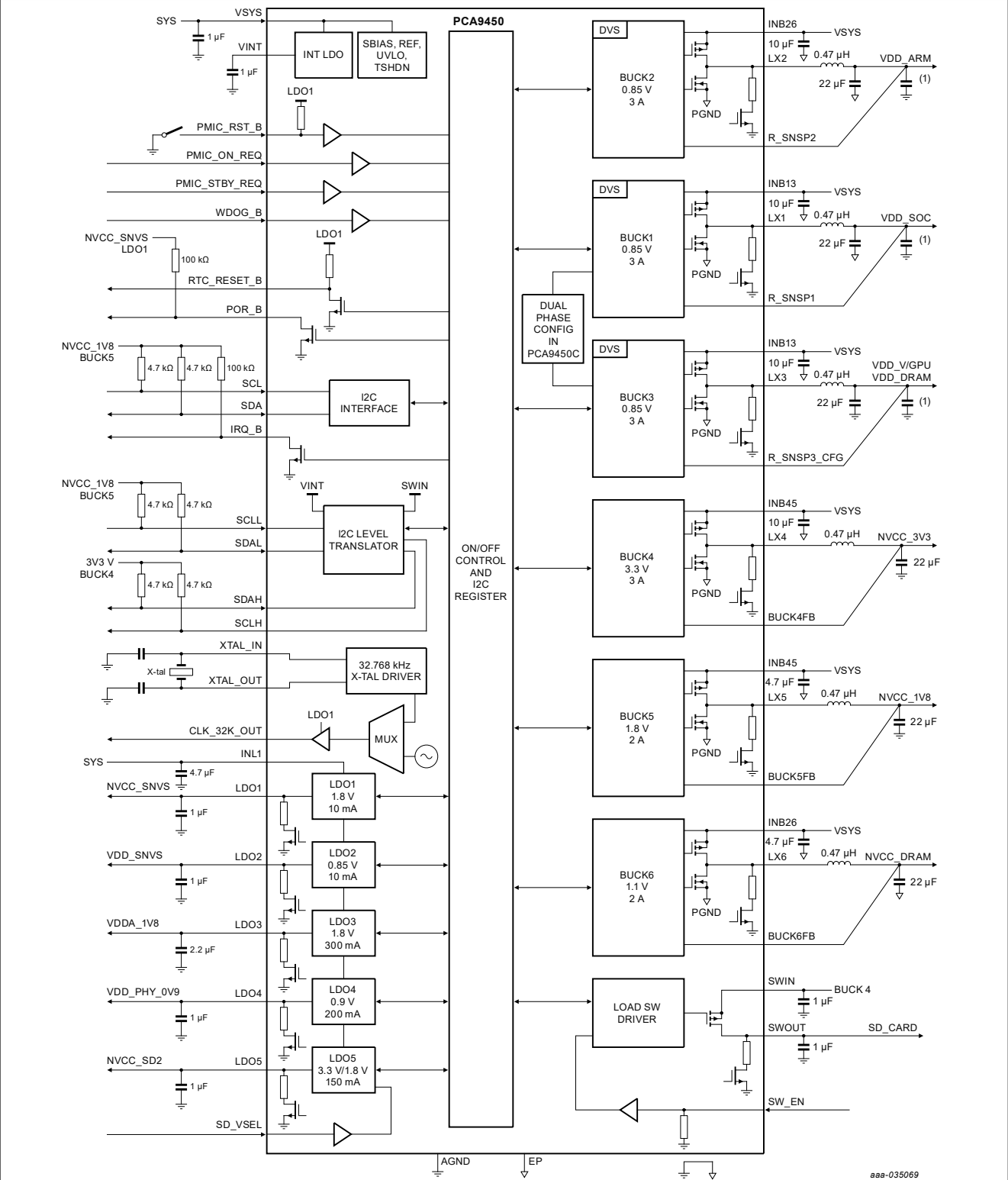
Table 1. Ordering information

| Type number | Topside marking | AP platform | Package | | |
|-------------|-----------------|--------------|---------|--|----------|
| | | | Name | Description | Version |
| PCA9450AAHN | PCA9450AA | i.MX 8M Mini | HVQFN56 | thermal enhanced very thin quad flat package; no leads; 56 terminals; 0.4 mm pitch, 7 mm x 7 mm x 0.85 mm body | SOT949-6 |
| PCA9450BHN | PCA9450B | i.MX 8M Nano | HVQFN56 | thermal enhanced very thin quad flat package; no leads; 56 terminals; 0.4 mm pitch, 7 mm x 7 mm x 0.85 mm body | SOT949-6 |
| PCA9450CHN | PCA9450C | i.MX 8M Plus | HVQFN56 | thermal enhanced very thin quad flat package; no leads; 56 terminals; 0.4 mm pitch, 7 mm x 7 mm x 0.85 mm body | SOT949-6 |

Table 2. Ordering options

| Type number | Orderable part number | Package | Packing method | Minimum order quantity | Temperature range (T _{amb}) | Recommended temperature range (T _J) |
|-------------|-----------------------|---------|----------------|------------------------|---------------------------------------|---|
| PCA9450AAHN | PCA9450AAHNY | HVQFN56 | REEL 13" Q1 DP | 2000 | -40 °C to +105 °C | -40 °C to +125 °C |
| PCA9450BHN | PCA9450BHNY | HVQFN56 | REEL 13" Q1 DP | 2000 | -40 °C to +105 °C | -40 °C to +125 °C |
| PCA9450CHN | PCA9450CHNY | HVQFN56 | REEL 13" Q1 DP | 2000 | -40 °C to +105 °C | -40 °C to +125 °C |

5 Block diagram



(1) This capacitor is decoupling capacitor in MCU side.

Figure 1. Block diagram

6 Pinning information

6.1 Pinning

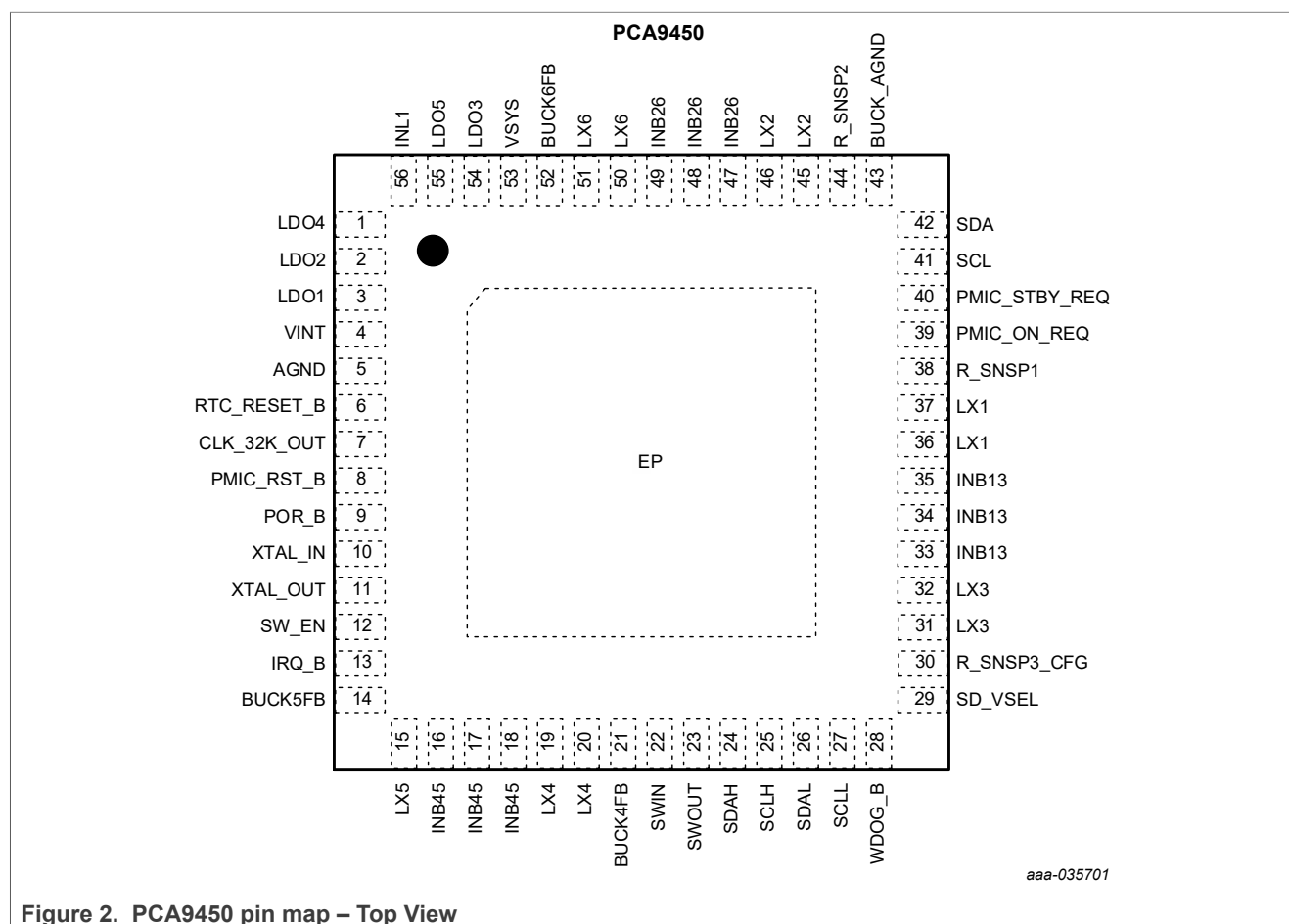


Figure 2. PCA9450 pin map – Top View

6.2 Pin description

Table 3. Pin description

| Pin description | | | |
|-----------------|-----|------|---|
| Symbol | Pin | Type | Description |
| LDO4 | 1 | P | LDO4 output. Bypass with a 1 μ F to Ground. |
| LDO2 | 2 | P | LDO2 output. Bypass with a 1 μ F to Ground. |
| LDO1 | 3 | P | LDO1 output. Bypass with a 1 μ F to Ground. |
| VINT | 4 | P | Internal Power supply output pin. Bypass with 1 μ F to Ground. |
| AGND | 5 | GND | Analog ground pin. It should be connected to ground plane through Via. Do not short to EP directly on top layer |

Table 3. Pin description...continued

| Pin description | | | |
|-----------------|----------|------|--|
| Symbol | Pin | Type | Description |
| RTC_RESET_B | 6 | DO | Reset output pin. It is High-Z after both LDO1 and LDO2 voltage are good. It is internally pulled up with LDO1 power rail |
| CLK_32K_OUT | 7 | DO | 32.768 kHz clock CMOS output with LDO1 power rail. |
| PMIC_RST_B | 8 | DI | PMIC reset input pin. It is internally pulled up with LDO1 power rail. Once it is asserted low, PMIC performs reset. |
| POR_B | 9 | DO | Power On reset output pin. Open drain output requiring external pull up resistor. |
| XTAL_IN | 10 | AI | 32.768 kHz crystal oscillator input, tie to GND if X-tal is not used |
| XTAL_OUT | 11 | AO | 32.768 kHz crystal oscillator output, leave floating if X-tal is not used |
| SW_EN | 12 | DI | Load switch enable input pin. It has internal 1.5 MΩ pull down resistor. |
| IRQ_B | 13 | DO | Open drain output to indicate Interrupt issued. It requires external pull up resistor. |
| BUCK5FB | 14 | AI | BUCK5 output voltage sensing pin. If BUCK5 is not used, tie to INB45. |
| LX5 | 15 | P | BUCK5 switching node. If BUCK5 is not used, leave it floating. |
| INB45 | 16,17,18 | P | BUCK4 / BUCK5 Input pins. Bypass with 10 μF and 4.7 μF to Ground |
| LX4 | 19,20 | P | BUCK4 switching node. If BUCK4 is not used, leave them floating. |
| BUCK4FB | 21 | AI | BUCK4 output voltage sensing pin. If BUCK4 is not used, tie to INB45. |
| SWIN | 22 | P | Load switch input pin. Bypass with a 1 μF to Ground. Leave it floating if not used (must connect to BUCK4, 3.3 V, if I ² C level translator is used). |
| SWOUT | 23 | P | Load switch output pin. Bypass with a 1 μF to Ground. Leave it floating if not used. |
| SDAH | 24 | DIO | Level translator high voltage IO pin, SDA referenced to SWIN, 3.3 V |
| SCLH | 25 | DO | Level translator high voltage IO pin, SCL referenced to SWIN, 3.3 V |
| SDAL | 26 | DIO | Level translator low voltage IO pin, SDA referenced to VINT, 1.8 V |
| SCLL | 27 | DO | Level translator low voltage IO pin, SCL referenced to VINT, 1.8 V |
| WDOG_B | 28 | DI | Active low watchdog reset input pin from application processor. |

Table 3. Pin description...continued

| Pin description | | | |
|-----------------|----------|------|--|
| Symbol | Pin | Type | Description |
| SD_VSEL | 29 | DI | LDO5 voltage selection input pin. LDO5 output is 3.3 V when it is driven low and 1.8 V when driven high. VSEL pin should be tied low or high. Do not leave it floating. |
| R_SNSP3_CFG | 30 | AI | BUCK3 output voltage remote sense pin in PCA9450AA. Logic input pin in PCA9450B/C. This pin should be tied to SYS in PCA9450B, where BUCK3 is disabled. This pin is tied to GND in PCA9450C, where BUCK1 and BUCK3 are configured as dual phase buck regulator. |
| LX3 | 31,32 | P | BUCK3 switching node If BUCK3 is not used by shorting R_SNSP3_CFG to VSYS, leave LX3 pins floating. |
| INB13 | 33,34,35 | P | BUCK1 / BUCK3 Input. Bypass with two 10 μ F to Ground |
| LX1 | 36,37 | P | BUCK1 switching node. Leave it floating if not used. |
| R_SNSP1 | 38 | AI | BUCK1 output voltage remote sensing pin. Tie to INB13 if not used. |
| PMIC_ON_REQ | 39 | DI | PMIC ON input from Application processor. When it is asserted high, the device starts power on sequence. |
| PMIC_STBY_REQ | 40 | DI | Standby mode input from Application processor. When it is asserted high, device enters STANDBY mode. |
| SCL | 41 | DI | I2C serial clock pin |
| SDA | 42 | DIO | I2C serial data pin |
| BUCK_AGND | 43 | GND | Buck reference GND for BUCK1,2,3. It should be connected to ground plane through Via. Do not short to EP directly on top layer |
| R_SNSP2 | 44 | AI | BUCK2 output voltage remote sensing pin. Tie to INB26 if not used. |
| LX2 | 45,46 | P | BUCK2 switching node. Leave them floating if not used. |
| INB26 | 47,48,49 | P | BUCK2 / BUCK6 Input. Bypass with 10 μ F and 4.7 μ F to Ground |
| LX6 | 50,51 | P | BUCK6 switching node. Leave it floating if not used. |
| BUCK6FB | 52 | AI | BUCK6 output voltage sensing pin. Tie to INB26 if not used. |
| VSYS | 53 | P | Internal power input. Bypass with a 1 μ F to Ground |
| LDO3 | 54 | P | LDO3 output. Bypass with a 2.2 μ F to Ground. |
| LDO5 | 55 | P | LDO5 output. Bypass with a 1 μ F to Ground. |
| INL1 | 56 | P | Power input pin for LDO1, LDO2, LDO3, LDO4 and LDO5. Bypass with a 4.7 μ F to Ground. |
| EP | | GND | Exposed PAD. All buck PGNDs are internally connected. |

7 Functional description

7.1 Features

The PCA9450 is a power management integrated circuit (PMIC) designed to be the primary power management for NXP application processors, i.MX 8M Mini, Nano and Plus.

- Buck regulators
 - BUCK1, BUCK2, BUCK3 : 0.6 V to 2.1875 V, 12.5 mV step, 3000 mA
 - BUCK4 : 0.6 V to 3.4 V, 25 mV step, 3000 mA
 - BUCK5, BUCK6 : 0.6 V to 3.4 V, 25 mV step, 2000 mA
 - Dynamic Voltage scaling on BUCK1, BUCK2 and BUCK3
 - Support remote sensing on BUCK1, BUCK2 and BUCK3
 - BUCK1-BUCK3 configurable as a 6 A dual phase regulator (PCA9450C)
 - Monitor fault condition
- LDO regulators
 - LDO1, 1.6 V to 1.9 V, 3.0 V to 3.3 V 100 mV step, 10 mA
 - LDO2, 0.8 V to 1.15 V with 50 mV step, 10 mA
 - LDO3, 0.8 V to 3.3 V with 100 mV step, 300 mA
 - LDO4, 0.8 V to 3.3 V with 100 mV step, 200 mA
 - LDO5, 0.8 V to 3.3 V with 100 mV step, 150 mA, Voltage selection through SD_VSEL pin
 - Monitor fault condition
- Support various memory types: DDR4/LPDDR4/DDR3L via system UBOOT configuration, no hardware change required
- 400 mA Load switch for SD card
 - Built-in OCP protection
 - GPIO/I2C control
 - Built-in Active discharge resistor
- Two Channel logic level translator
- 32.768 kHz Crystal Oscillator driver
 - Mux output with internal 32 kHz output
- Protection and Monitoring: Soft start, Power Rails Fault detection, UVLO, Thermal Shutdown
- Configurable reset behavior from WDOGB, PMIC_RST_B and SW_RST Register
- Power control IO
 - PMIC_ON_REQ, PMIC_STBY_REQ
- Fm+ 1 MHz I²C-bus interface
- Type3 PCB applicable

7.2 Functional diagram

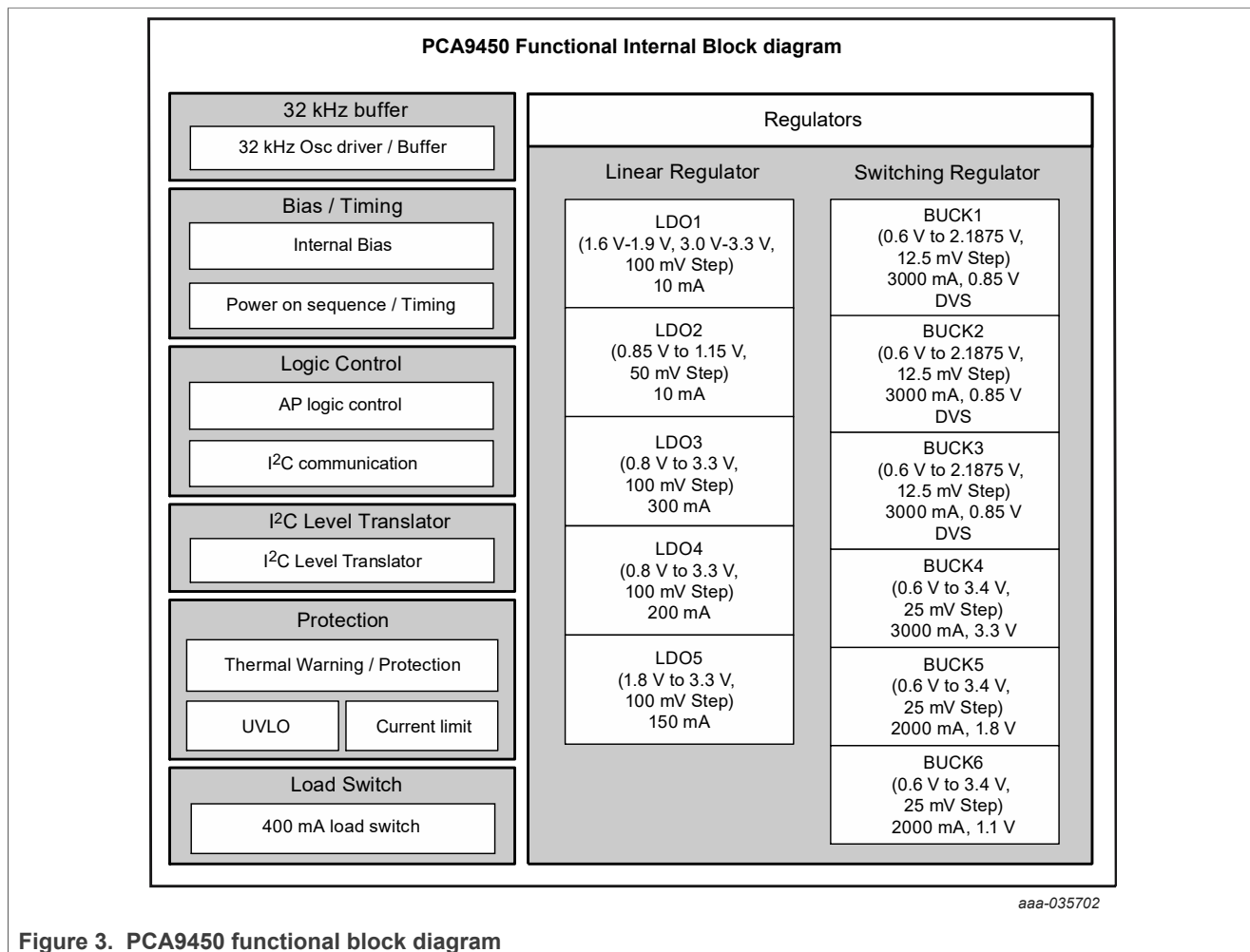


Figure 3. PCA9450 functional block diagram

The PCA9450 is a single chip Power Management IC (PMIC) specifically designed to support i.MX 8M family processor in both 1 cell Li-Ion and Li-polymer battery portable application and 5 V adapter non-portable applications.

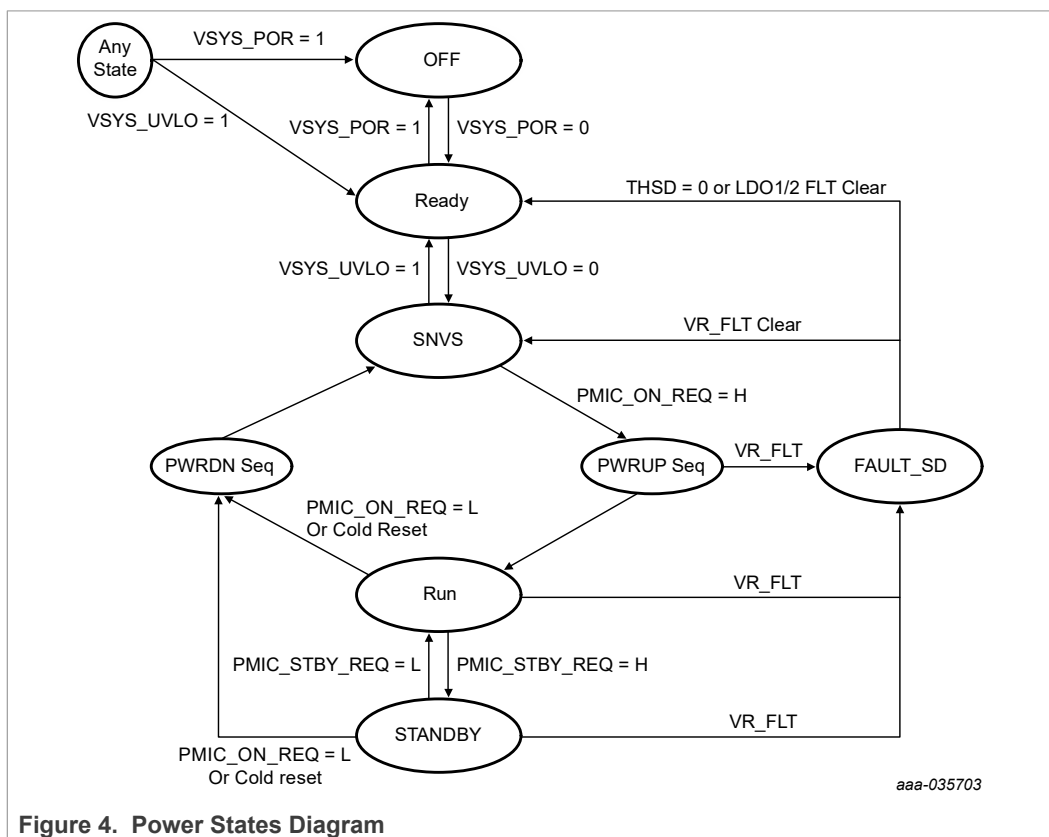
PCA9450 is provided in three versions: PCA9450AA, PCA9450B and PCA9450C depending on target application processor. [Table 4](#) shows the selection guide.

Table 4. PCA9450 selection guide

| Part number | AP Platform | BUCK1 | BUCK3 | LDO4 | R_SNSP3_CFG |
|------------------|--------------|---|--------------------------------------|--------------------------------|-----------------------------------|
| PCA9450AA | i.MX 8M Mini | 3 A for SOC (ON by default) | 3 A for VPU/GPU/DRAM (ON by default) | 0.9 V for VDDA (ON by default) | R_SNSP3_CFG is feedback of BUCK 3 |
| PCA9450B | i.MX 8M Nano | 3 A for SOC / VPU/GPU/DRAM (ON by default) | Disabled | OFF by default | R_SNSP3_CFG = VSYS |
| PCA9450C | i.MX 8M Plus | 6 A Dual phase for SOC/VPU/GPU/DRAM (ON by default) | | OFF by default | R_SNSP3_CFG = GND |

7.3 Power modes

PCA9450 has eight power modes: OFF, READY, SNVS, RUN, STADNBY, PWRDN, PWRUP and FAULT_SD. Figure 4 shows the state transition diagram showing the conditions to enter and exit each state.



7.3.1 Off mode

PCA9450 enters OFF mode from any state when VSYS falls below V_{SYS_POR} threshold. All regulators are off and all registers get reset in this mode.

7.3.2 READY mode

PCA9450 enters READY mode from OFF mode when VSYS is higher than V_{SYS_POR} . Internal LDO VINT is enabled and loads Multiple Time Program (MTP) data to registers. Once MTP loading is done, it is ready to transition to SNVS mode.

7.3.3 SNVS mode

PCA9450 enters Secure Non-Volatile Storage mode (SNVS) when VSYS exceeds V_{SYS_UVLO} threshold. LDO1 and LDO2 are powered up and 32.768 kHz buffer starts running. RTC_RESET_B is pulled high in t_{RTC_RST} after both LDO1 and LDO2 voltage come up.

PMIC_ON_REQ input is masked until RTC_RESET_B is released. PCA9450 starts power up sequence if PMIC_ON_REQ is asserted high in this mode.

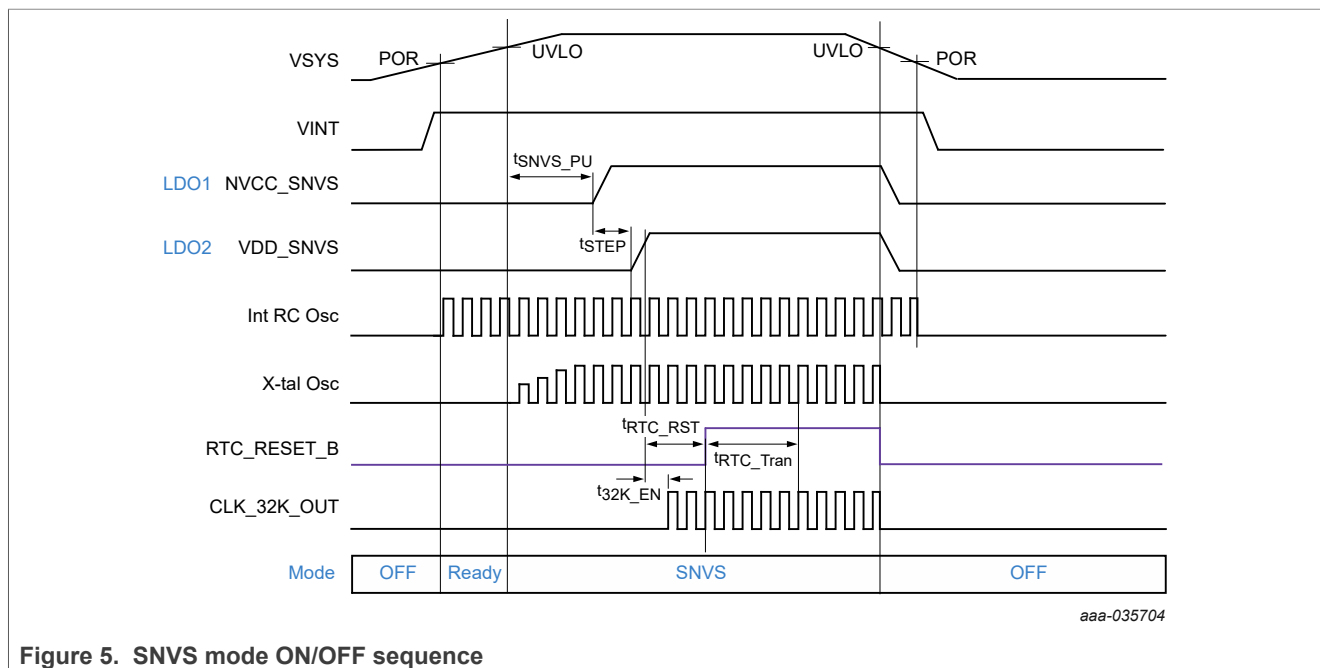


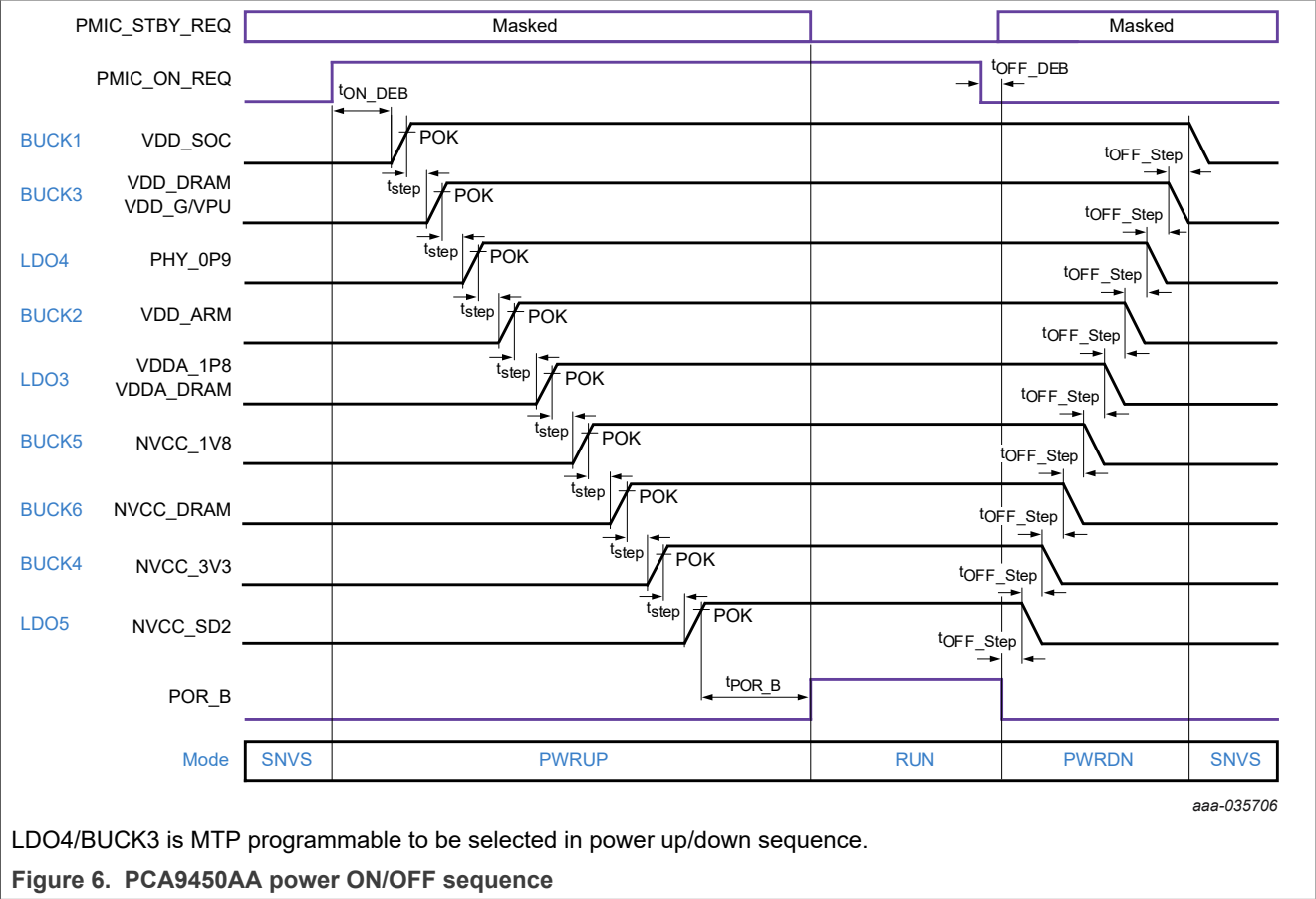
Figure 5. SNVS mode ON/OFF sequence

Table 5. SNVS mode

| Time | Description | Value |
|-----------------|---|-------|
| t_{SNVS_PU} | Time to LDO1 turn on from VSYS UVLO detected | 20 ms |
| t_{STEP} | Time to LDO2 ON from LDO1 POK | 2 ms |
| t_{RTC_RST} | Time to RTC_RESET_B release from LDO2 POK | 20 ms |
| t_{32K_EN} | Time to 32k buffer Enable from LDO2 POK | 10 ms |
| t_{RTC_Tran} | Time to transition to Xtal output from RC osc after RTC_RESET_B release | 1 sec |

7.3.4 PWRUP mode

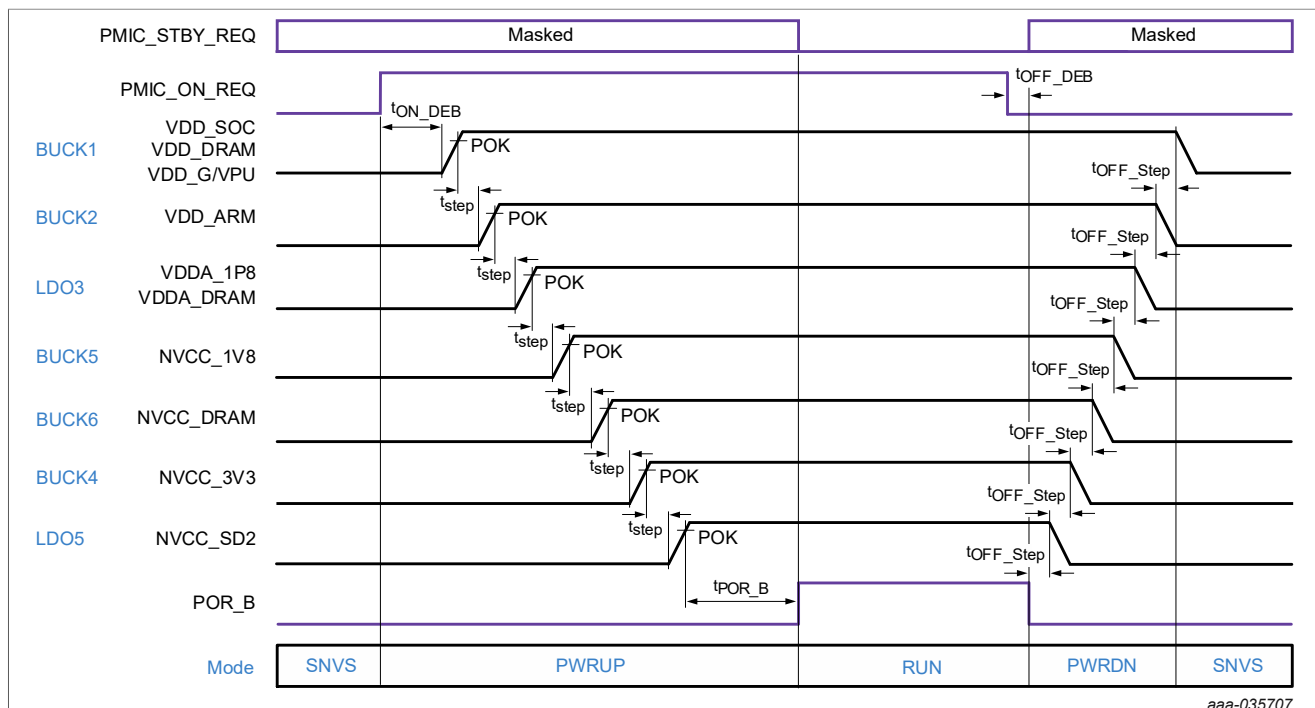
After RTC_RESET_B is released in SNVS mode, it starts power up with pre-defined sequence when PMIC_ON_REQ is asserted high for longer than debounce time, t_{ON_DEB} , which is programmable in PWR_CTRL reg. BUCK1 begins turning ON at first and then each power rail is followed with t_{step} after POK of predecessor power rail. During PWRUP mode, PMIC_STBY_REQ signal is masked until POR_B is released. The PWRUP mode ends up releasing POR_B and PCA9450 is transitioned to RUN mode. [Figure 6](#) shows Power on sequence of PCA9450AA.



LDO4/BUCK3 is MTP programmable to be selected in power up/down sequence.

Figure 6. PCA9450AA power ON/OFF sequence

BUCK3 and LDO4 are OFF by default in PCA9450B and PCA9450C. Those regulators are removed in the power up sequence, shown in [Figure 7](#).



aaa-035707

LDO4/BUCK3 is MTP programmable to be selected in power up/down sequence.

Figure 7. PCA9450B/C power ON/OFF sequence

Table 6. PWRUP mode

| Time | Description | Value |
|-----------------|--|-------------|
| t_{ON_DEB} | Time to power-on start from PMIC_ON_REQ high | 20 ms |
| t_{STEP} | Time to next power rail ON from prev rail POK | 2 ms |
| t_{PORB} | Time to POR_B release from the last rail POK | 20 ms |
| t_{OFF_STEP} | Time to next power rail off from prev rail off | 8 ms |
| t_{OFF_DEB} | Time to POR_B low from PMIC_ON_REQ falling | 120 μ s |

If any of regulators doesn't generate POK within $t_{FLT_SH_PU}$ after receiving digital enable during PWRUP mode, it is transitioned to Fault_SD mode.

7.3.5 PWRDN mode

When PMIC_ON_REQ is low for t_{OFF_DEB} in RUN or STANDBY mode, PCA9450 enters PWRDN mode. It starts with pulling down POR_B and then turning off each power rail in t_{OFF_STEP} and transitions to SNVS mode.

7.3.6 RUN mode

PCA9450 operates in RUN mode when PMIC_ON_REQ is driven high and PMIC_STBY_REQ is driven low. BUCK1, BUCK2 and BUCK3 output voltage are set to BUCK1OUT_DVS0, BUCK2OUT_DVS0 and BUCK3OUT_DVS0 register value, respectively, when PRESET_EN bit in DVS123_DVS register is set to "0". When

PMIC_STBY_REQ is asserted high in this mode, it is transitioned to STANDBY mode.
PMIC_ON_REQ is asserted low, it moves to PWRDN mode.

7.3.7 STANDBY mode

PCA9450 transitions to STANDBY mode from RUN mode when both PMIC_ON_REQ and PMIC_STBY_REQ are driven high. BUCK1 and BUCK3 output voltage is set to BUCK1OUT_DVS1 and BUCK3OUT_DVS1 and BUCK2 are turned off when DVS_CTRL bit in each BUCKx_CTRL register is configured to 1.

If PMIC_ON_REQ is asserted low, then it transitions to PWRDN mode. If PMIC_STBY_REQ is driven low, then it transitions to RUN mode.

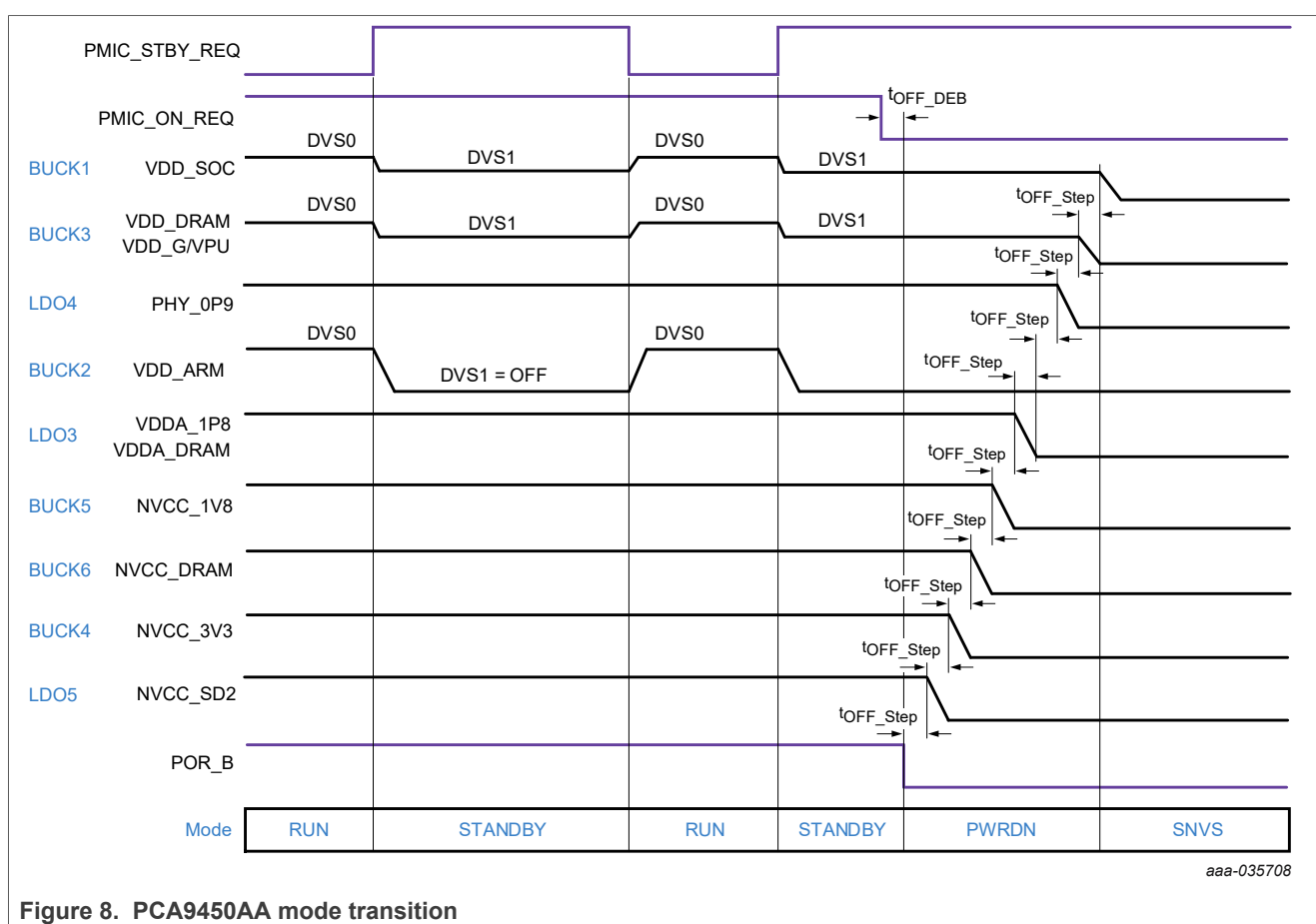


Table 7. Power modes summary

X : Don't care

| Power mode | VSYS | PMIC_ON_REQ | PMIC_STBY_REQ |
|------------|---------------------------|-------------|---------------|
| OFF | $V_{SYS} < V_{SYS_POR}$ | X | X |
| READY | $V_{SYS} > V_{SYS_POR}$ | X | X |
| SNVS | $V_{SYS} > V_{SYS_UVLO}$ | Low | X |
| STANDBY | $V_{SYS} > V_{SYS_UVLO}$ | High | High |

Table 7. Power modes summary...continued

X : Don't care

| Power mode | VSYS | PMIC_ON_REQ | PMIC_STBY_REQ |
|------------|---------------------------|-------------|---------------|
| RUN | $V_{SYS} > V_{SYS_UVLO}$ | High | Low |

7.3.8 FAULT_SD

PCA9450 has three types of fault sources.

1. **Thermal shutdown** : Transition to SNVS mode or READY mode after FAULT_SD mode.

When junction temperature reaches T_{JSHDN} , it enters FAULT_SD mode after t_{FLT_THSD} where regulators are turned off simultaneously. It stays at FAULT_SD until junction temperature falls below T_{JSHDN} . If the temperature drops below T_{JSHDN} , then it moves to READY state if any of LDO1 and LDO2 fault is triggered when thermal shutdown

happens, and it moves to SNVS mode if neither LDO1 or LDO2 fault is triggered when thermal shutdown happens.

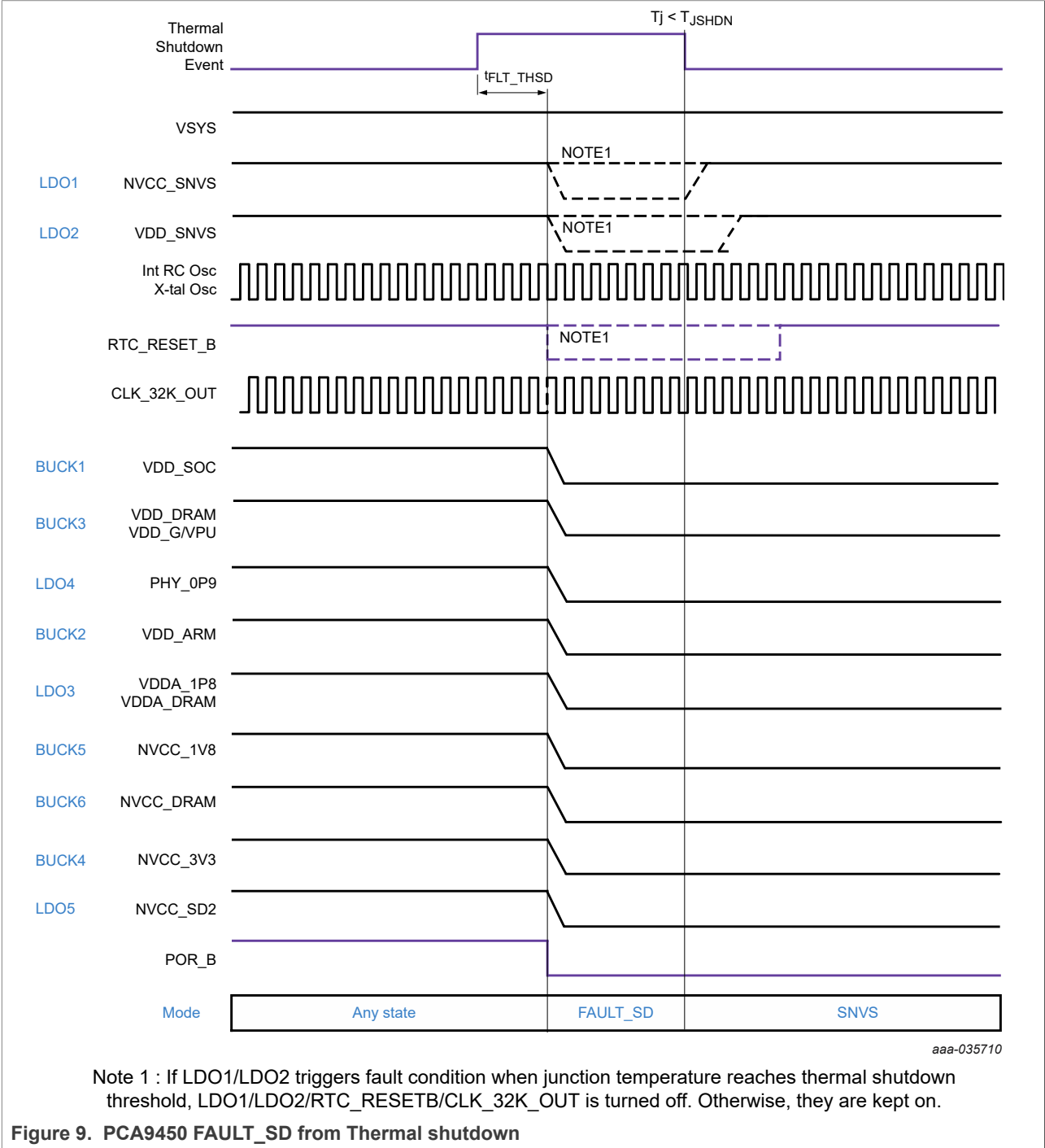


Table 8. t_{FLT_THSD}

| Time | Description | Value |
|-----------------|---|-------------|
| t_{FLT_THSD} | Time to reset released from Fault event | 120 μ s |

2. **Voltage regulator fault during power up:** Transition to READY mode after FAULT_SD mode.
Any POK of voltage regulators doesn't come up within $t_{FLT_SD_PU}$ after regulator is enabled during power up sequence. It stops power-up sequence and then moves to FAULT_SD where all regulators are turned off. It stays at FAULT_SD for $t_{FLT_SD_STAY}$ and transitions to READY state.
3. **Voltage regulator fault in STANDBY and RUN MODE:** Move to FAULT_SD mode in $t_{FLT_SD_WAIT}$ after Fault is detected. Transition to SNVS mode or READY mode from FAULT_SD mode when fault is removed.
During RUN and STANDBY mode, VR Fault status bit in VRFLT1_STS and VRFLT2_STS registers is latched to "1" when corresponding regulator voltage falls below POK threshold for t_{DEB_POKB} , or POK doesn't go high within $t_{FLT_POK_MSK}$ after regulator is enabled.
If the fault status bit is masked in VRFLT1_MASK and VRFLT2_MASK registers, it doesn't enter FAULT_SD mode. Instead, PCA9450 stays at current mode. If the fault register bit is unmasked, it starts $t_{FLT_SD_WAIT}$ timer. Application processor can determine to enter FAULT_SD mode or not, by masking the VR Fault status bit in VRFLTx_MASK registers before the timer expires. PCA9450 enters FAULT_SD mode when the timer expires. PCA9450 stays in FAULT_SD mode for $t_{FLT_SD_STAY}$.

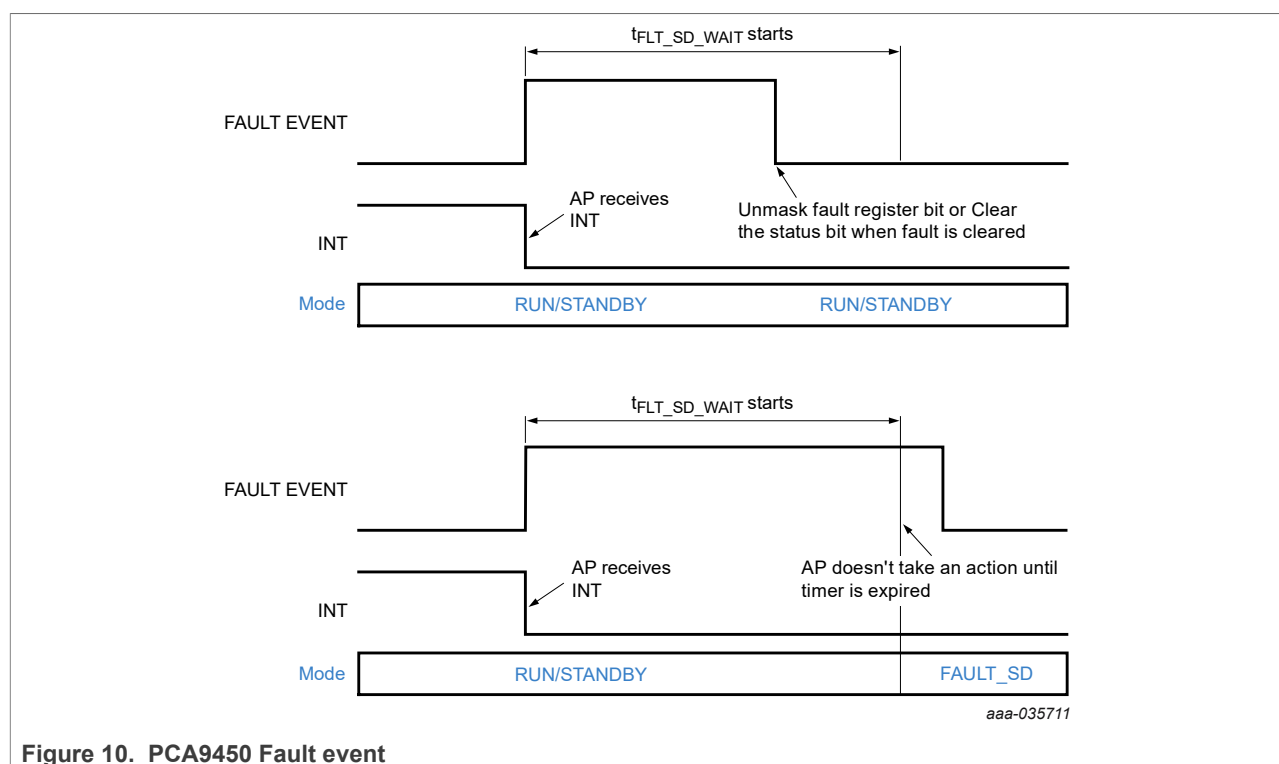
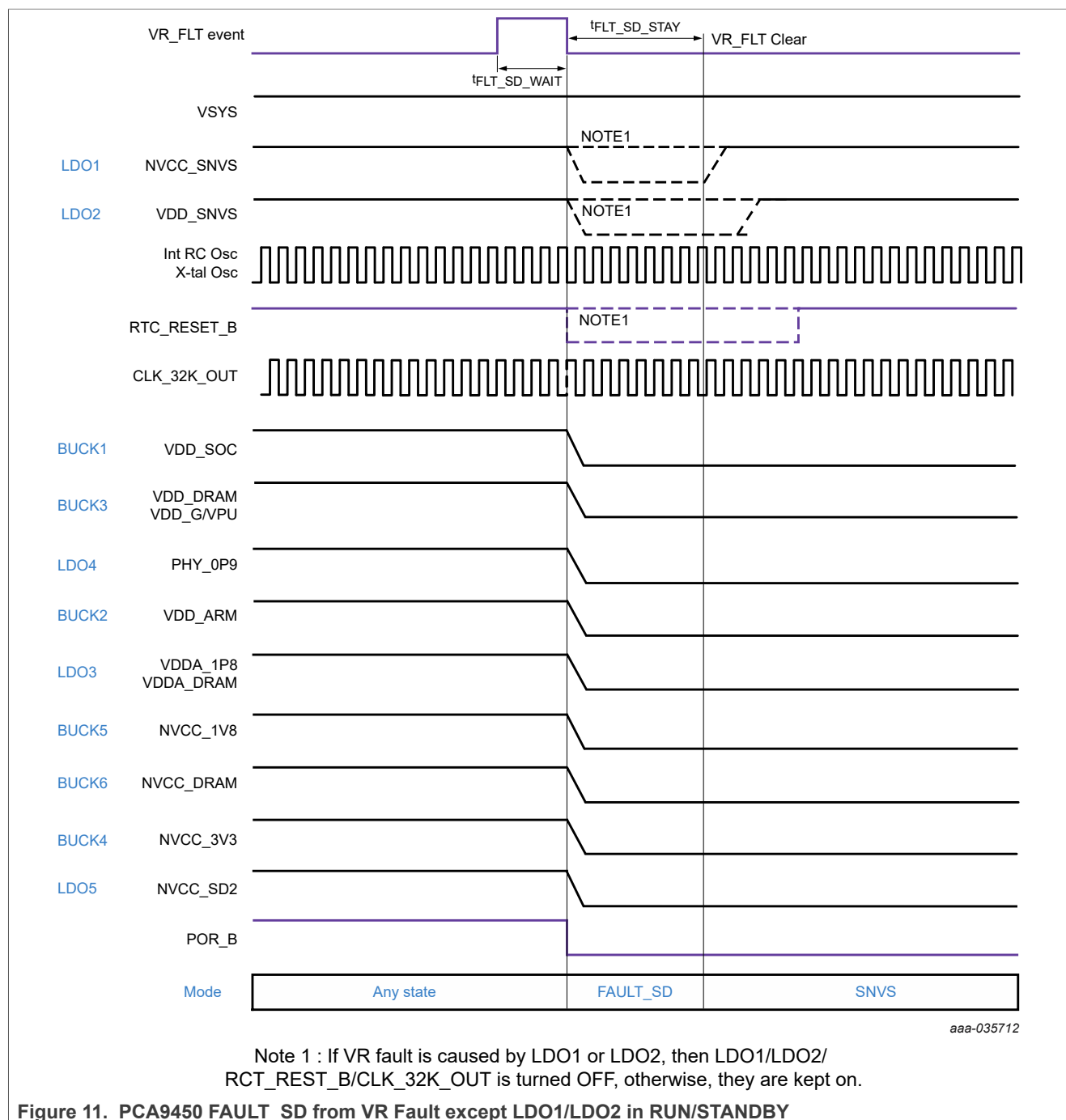


Figure 10. PCA9450 Fault event

PCA9450 moves to READY mode after FAULT_SD mode if the regulator fault is caused by LDO1 or LDO2. Otherwise, it moves to SNVS mode after FAULT_SD.

If either LDO1 or LDO2 has fault in SNVS mode, then it enters FAULT_SD mode regardless of VRFLT1 Mask bit.

PCA9450 doesn't enter FAULT_SD mode from load switch overcurrent fault.

Table 9. $t_{FLT_SD_WAIT}$

| Time | Description | Value |
|---------------------|---|--------|
| $t_{FLT_SD_WAIT}$ | Time to reset released from Fault event | 100 ms |

7.4 PMIC reset

PCA9450 has three reset input sources: WDOG_B pin, PMIC_RST_B pin and I2C reset bit.

The reset behavior is configured in RESET_CTRL register for WDOG_B pin and PMIC_RST_B pin. I2C reset behavior is configured in SW_RST register.

Table 10. 0x08 – RESET_CTRL

| 0x08 – RESET_CTRL | | | | Reset Type | S |
|-------------------|--------------|------|-------|--|---|
| Bit | Name | Type | Reset | Description | |
| 7:6 | WDOG_B_CFG | R/W | 00 | When WDOG_B is asserted to L, PMIC behavior 00b = WDOG_B reset is disabled 01b = Warm Reset, POR_B pin is asserted low for 20 ms 10b = Cold Reset, All voltage regulators are recycled except LDO1/LDO2 11b = Cold Reset, All voltage regulators are recycled | |
| 5:4 | PMIC_RST_CFG | R/W | 10 | When PMIC_RST_B is asserted to L, PMIC behavior 00b = PMIC_RST_B reset is disabled 01b = Warm Reset, POR_B pin is asserted low for 20 ms 10b = Cold Reset, All voltage regulators are recycled except LDO1/LDO2 11b = Cold Reset, All voltage regulators are recycled | |

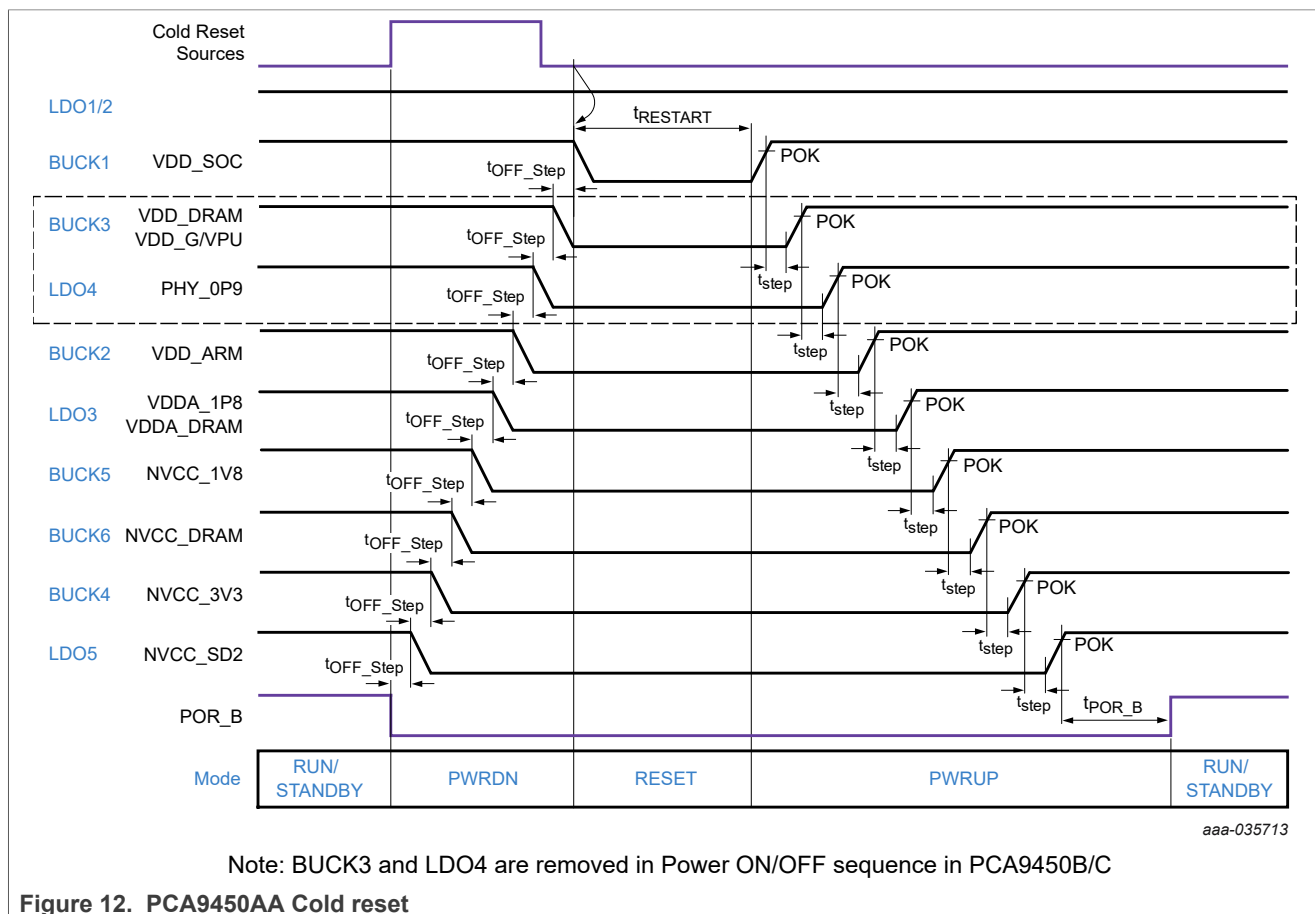
Table 11. 0x06 – SW_RST

| 0x06 – SW_RST | | | | Reset Type | O |
|---------------|--------|------|-------|--|---|
| Bit | Name | Type | Reset | Description | |
| 7:0 | SW_RST | R/W | 0x00 | Software reset register. This register read back to "0x00" right after writing the value. 0x00 = No action 0x05 = Reset all registers to default value 0x14 = Cold reset (Power recycle all regulators except LDO1, LDO2 and CLK_32K_OUT) 0x35 = Warm Reset (Toggle POR_B for 20 ms) 0x64 = Cold reset (Power recycle all regulators) Others = No action | |

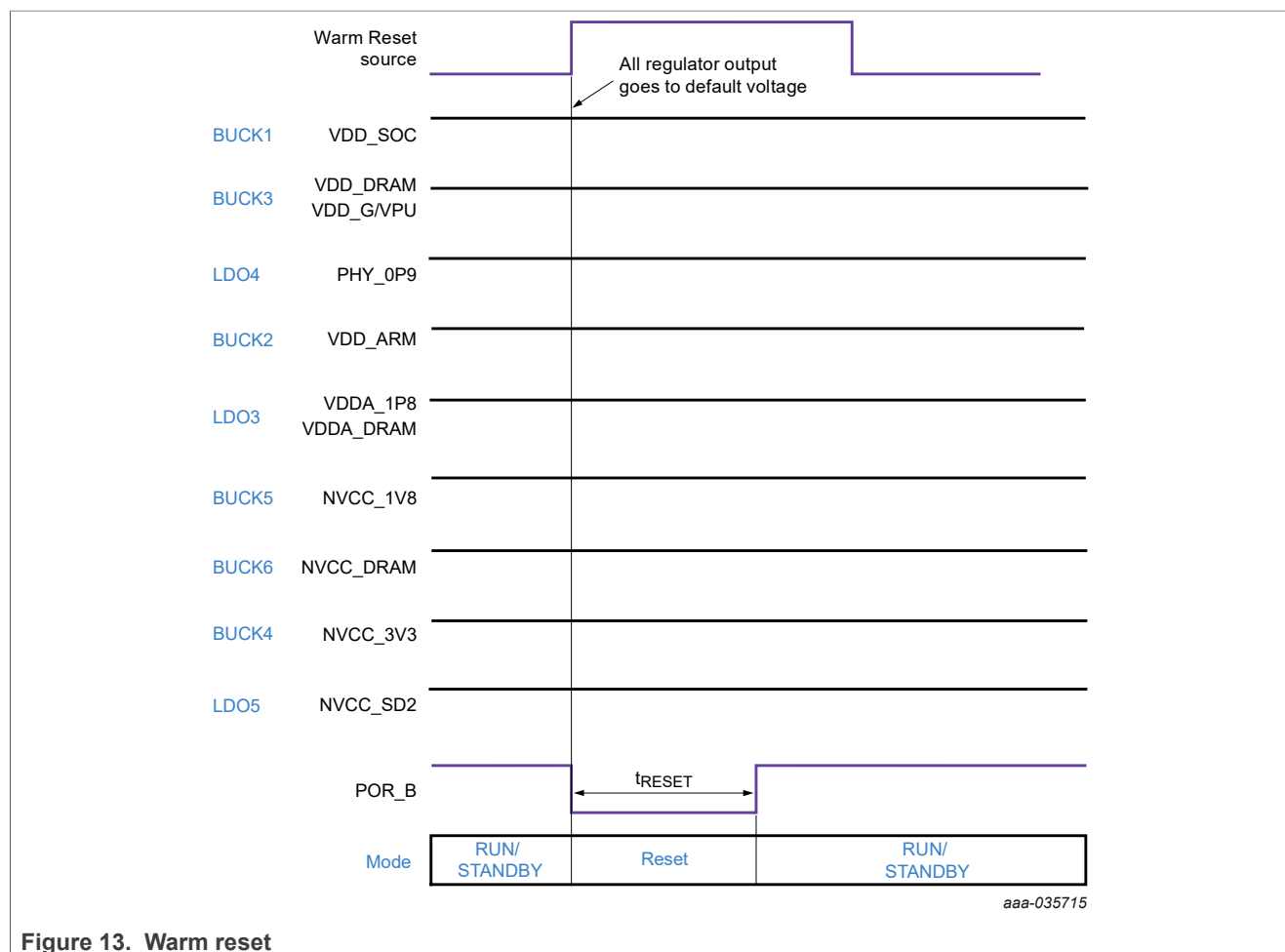
WDOG_B is asserted low, and gets reset depending on WDOG_B_CFG bit configuration. When the bits are set to 2b00, the reset by WDOG_B pin is disabled. If the bits are set to 2b01, warm reset is performed, where POR_B is pulled low for 20 ms and resets I2C O type registers to default value keeping power rails remaining ON. If the bits are set to 2b11, it performs Cold reset, where all voltage regulators except LDO1 and LDO2 are power recycled and I2C O type registers get reset to default value.

When PMIC_RST_B is asserted low, it also gets reset depending on PMIC_RST_CFG bits configuration. When the bits are set to 2b00, any reset by PMIC_RST_B pin is disabled. If the bits are set to 2b01, warm reset is performed, in which pulling POR_B low for 20 ms and reset I2C O type registers to default value keeping power rails remaining ON.

Cold reset event is generated by either of I2C reset, WDOG_B falling edge or PMIC_RST_B falling edge after debounce time. Once it is detected, POR_B is pulled low and takes power down sequence. For cold reset from WDOG_B and I2C reset, PCA9450 stays at RESET for t_{RESTART} and then starts power on sequence even though WDOG_B pin is still low. For cold reset from PMIC_RST_B, t_{RESTART} timer starts after PMIC_RST_B is asserted high; in other words, PCA9450 starts power on sequence in t_{RESTART} after PMIC_RST_B pin is released high.

Table 12. t_{RESTART}

| Time | Description | Value |
|----------------------|--|--------|
| t_{RESTART} | Time to power ON seq from end of power OFF seq during cold reset | 250 ms |

Table 13. t_{RESET}

| Time | Description | Value |
|--------------------|------------------------------|-------|
| t_{RESET} | POR_B low time at Warm reset | 20 ms |

7.5 Regulator control in each power mode

Table 14 shows PCA9450AA regulator ON/OFF control in each power mode by default. It can be reconfigured through I2C registers.

Table 14. PCA9450AA Regulator Control summary

| Power Rail | | Default Voltage | OFF | SNVS | STANDBY | RUN |
|------------|-----------------------------|-----------------|-----|------|---------|-----|
| LDO1 | NVCC_SNVS | 1.8 V | OFF | ON | ON | ON |
| LDO2 | VDD_SNVS | 0.85 V | OFF | ON | ON | ON |
| BUCK1 | VDD_SOC | 0.85 V | OFF | OFF | ON | ON |
| BUCK3 | VDD_DRAM VDD_GPU VDD_VPU | 0.85 V | OFF | OFF | ON | ON |
| LDO4 | PHY_0P9 | 0.9 V | OFF | OFF | ON | ON |

Table 14. PCA9450AA Regulator Control summary...continued

| Power Rail | | Default Voltage | OFF | SNVS | STANDBY | RUN |
|------------|-----------|-----------------|-----|------|---------|-----|
| BUCK2 | VDD_ARM | 0.85 V | OFF | OFF | OFF | ON |
| LDO3 | VDDA_1P8 | 1.8 V | OFF | OFF | ON | ON |
| BUCK5 | NVCC_1V8 | 1.8 V | OFF | OFF | ON | ON |
| BUCK6 | NVCC_DRAM | 1.1 V | OFF | OFF | ON | ON |
| BUCK4 | NVCC_3V3 | 3.3 V | OFF | OFF | ON | ON |
| LDO5 | NVCC_SD2 | 3.3 V / 1.8 V | OFF | OFF | ON | ON |

[Table 15](#) shows PCA9450B/PCA9450C regulator ON/OFF control in each power mode by default. It can be reconfigured through I2C registers.

Table 15. PCA9450B/PCA9450C Regulator Control summary

| Power Rail | | Default Voltage | OFF | SNVS | STANDBY | RUN |
|------------|----------------------------------|-----------------|-----|------|---------|-----|
| LDO1 | NVCC_SNVS | 1.8 V | OFF | ON | ON | ON |
| LDO2 | VDD_SNVS | 0.85 V | OFF | ON | ON | ON |
| BUCK1 | VDD_SOC VDD_DRAM VDD_GPU VDD_VPU | 0.85 V | OFF | OFF | ON | ON |
| LDO4 | | 0.9 V | OFF | OFF | OFF | OFF |
| BUCK2 | VDD_ARM | 0.85 V | OFF | OFF | OFF | ON |
| LDO3 | VDDA_1P8 | 1.8 V | OFF | OFF | ON | ON |
| BUCK5 | NVCC_1V8 | 1.8 V | OFF | OFF | ON | ON |
| BUCK6 | NVCC_DRAM | 1.1 V | OFF | OFF | ON | ON |
| BUCK4 | NVCC_3V3 | 3.3 V | OFF | OFF | ON | ON |
| LDO5 | NVCC_SD2 | 3.3 V / 1.8 V | OFF | OFF | ON | ON |

7.6 Regulator summary

The PCA9450 features six buck regulators, five linear regulators and one load switch to supply voltage rails powering the application processor and peripheral devices. The buck regulators are supplied directly from the main input supply. The input to all of the buck regulators must be tied to VSYS, whether they are powered on or off.

7.6.1 BUCK regulator

The PCA9450AA has six high-efficiency low Iq buck regulators. Each buck regulator features soft start and overcurrent protection. Buck regulator operates in two modes: PFM and PWM mode. It automatically transitions from PFM to PWM mode when FPWM bit is set to "0". Internal active discharge resistor is installed in each buck regulator output to discharge voltage on output capacitors when regulator is off. It is configurable through I2C register. [Table 16](#) shows buck regulator summary.

BUCK1 and BUCK3 are configured as dual-phase buck regulator in PCA9450C and provide up to 6 A. [Table 17](#) shows PCA9450C buck summary.

Table 16. PCA9450AA Buck Summary

| BUCK# | INPUT PIN | Default VOUT [V] | VOUT range [V] | Step size [mV] | Default ON/OFF | Current rating [mA] |
|-------|-----------|------------------|----------------|----------------|----------------|---------------------|
| BUCK1 | INB13 | 0.85 | 0.6 - 2.1875 | 12.5 | ON | 3000 |
| BUCK2 | INB26 | 0.85 | 0.6 - 2.1875 | 12.5 | ON | 3000 |
| BUCK3 | INB13 | 0.85 | 0.6 - 2.1875 | 12.5 | ON | 3000 |
| BUCK4 | INB45 | 3.3 | 0.6 - 3.4 | 25 | ON | 3000 |
| BUCK5 | INB45 | 1.8 | 0.6 - 3.4 | 25 | ON | 2000 |
| BUCK6 | INB26 | 1.1 | 0.6 - 3.4 | 25 | ON | 2000 |

Table 17. PCA9450C Buck Summary

| Buck# | INPUT PIN | Default VOUT [V] | VOUT range [V] | Step size [mV] | Default ON/OFF | Current rating [mA] |
|-------|-----------|------------------|----------------|----------------|----------------|---------------------|
| BUCK1 | INB13 | 0.85 | 0.6 - 2.1875 | 12.5 | ON | 6000 |
| BUCK2 | INB26 | 0.85 | 0.6 - 2.1875 | 12.5 | ON | 3000 |
| BUCK4 | INB45 | 3.3 | 0.6 - 3.4 | 25 | ON | 3000 |
| BUCK5 | INB45 | 1.8 | 0.6 - 3.4 | 25 | ON | 2000 |
| BUCK6 | INB26 | 1.1 | 0.6 - 3.4 | 25 | ON | 2000 |

7.6.1.1 Dynamic voltage scaling

BUCK1, BUCK2 and BUCK3 support DVS (Dynamic Voltage Scaling). If PRESET_EN bit in BUCK123_DVS register is set to 1, BUCK1/BUCK2/BUCK3 outputs are controlled by Bx_DVS_PRESET bits in BUCK123_DVS. It enables those buck outputs to be controlled by writing one register at a time.

If PRESET_EN bit is set to 0, those buck regulators outputs are determined by BUCKxOUT_DVS0 and BUCKxOUT_DVS1 depending on PMIC_STBY_REQ pin. When PMIC_STBY_REQ is asserted low, each buck output voltage is determined by BUCKxOUT_DVS0 register, if the PMIC_STBY_REQ is asserted high, BUCKxOUT_DVS1 register is selected as each buck output voltage. [Figure 14](#) shows the DVS voltage section diagram.

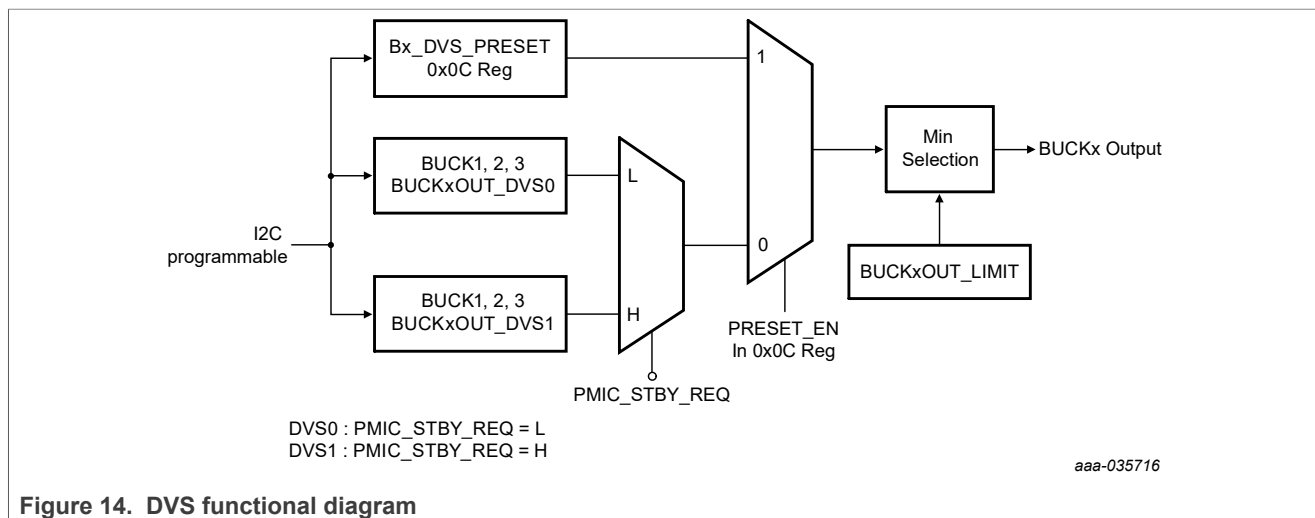


Figure 14. DVS functional diagram

The programmable voltage ramp-up and ramp-down are applied during the DVS voltage transition. The ramp rate is configured by RAMP[7:6] bits in each BUCKxCTRL registers.

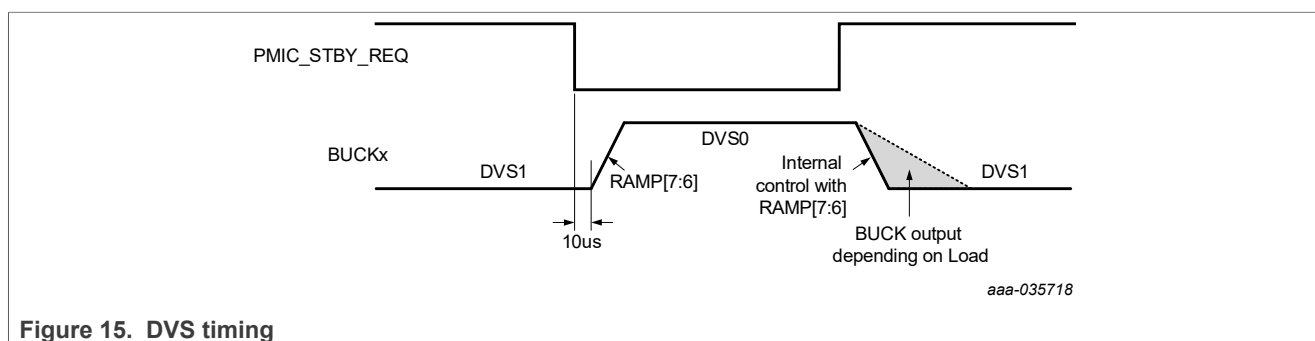


Figure 15. DVS timing

7.6.1.2 BUCK output voltage limiting

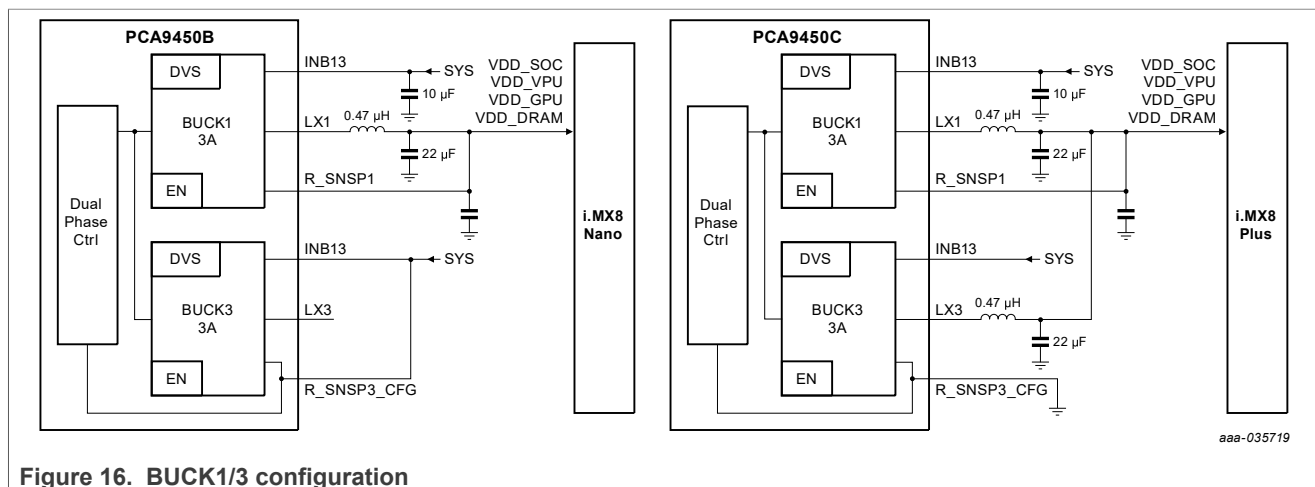
Application processor may accidentally write higher voltage than absolute maximum voltage rating of its power input, which may cause significant damage on application processor. PCA9450 has registers to limit the maximum voltage to prevent such an incident.

BUCK1, BUCK2 and BUCK3 maximum output are limited by BUCKxOUT_LIMIT, respectively. Even if buck output is configured to higher than the limit voltage configured in BUCKxOUT_LIMIT register, the actual buck output is clamped to the limiting voltage set by BUCKxOUT_LIMIT register.

7.6.1.3 Dual-phase configuration

BUCK1 and BUCK3 are configured as dual phase buck in PCA9450C by connecting R_SNSP3_CFG pin to GND, where this dual phase buck regulator is controlled through BUCK1 registers. All BUCK3 registers are not responsive under dual-phase configuration.

When R_SNSP3_CFG pin is tied to INB13 in PCA9450B, BUCK3 is disabled. BUCK1 supplies VDD_SOC/VDD_VPU/VDD_GPU/VDD_DRAM in i.MX 8M Nano application processor.



aaa-035719

Figure 16. BUCK1/3 configuration

7.6.2 LDO and load switch

The PCA9450 has five LDOs and one load switch. LDO1 and LDO2 are supposed to supply SNVS core in application processor. These two LDOs feature ultra-low quiescent current, 2 µA typical, since they are always ON when V_{SY} is valid.

For all LDO and the load switch, each has designated active discharge resistor configurable through I2C.

Table 18. LDO summary

| LDO# | INPUT PIN | Default VOUT [V] | VOUT range [V] | Step size [mV] | Default ON/OFF | Current rating [mA] |
|------|-----------|------------------|------------------|----------------|-------------------|---------------------|
| LDO1 | INL1 | 1.8 | 1.6-1.9, 3.0-3.3 | 100 | ON | 10 |
| LDO2 | INL1 | 0.85 | 0.8 – 1.15 | 50 | ON | 10 |
| LDO3 | INL1 | 1.8 | 0.8 - 3.3 | 100 | ON | 300 |
| LDO4 | INL1 | 0.9 | 0.8 - 3.3 | 100 | ON ^[1] | 200 |
| LDO5 | INL1 | 3.3/1.8 | 1.8 - 3.3 | 100 | ON | 150 |
| SW | SWIN | - | - | - | OFF | 400 |

[1] ON by default in PCA9450AA, OFF by default in PCA9450B and PCA9450C

7.7 32 kHz Crystal Oscillator Driver

The PCA9450 consists of a crystal oscillator driver with an external load capacitor and CLK_32K_OUT buffer referenced to LDO1 voltage. When V_{SY} exceeds POR threshold and internal power V_{INT} is good, internal 32 kHz oscillator and 32.768 kHz crystal oscillator start oscillating. Crystal oscillator typically takes few seconds to be stabilized. PCA9450 outputs the internal 32 kHz RC oscillator initially, while internal counter counts crystal oscillator output in t_{RTC_Tran} after RTC_RESET_B is released. If the counter reaches 100, then CLK_32K_OUT buffer input is switched to the external crystal oscillator from internal 32 kHz oscillator. Clock stretch is applied during this clock source transition to prevent unwanted glitch. If external 32.768 kHz crystal oscillator is not populated, CLK_32K_OUT pin outputs 32 kHz clock from internal 32 kHz oscillator.

For more detailed information on selecting crystal oscillator and load capacitance, refer to [Section 9.2.2](#).

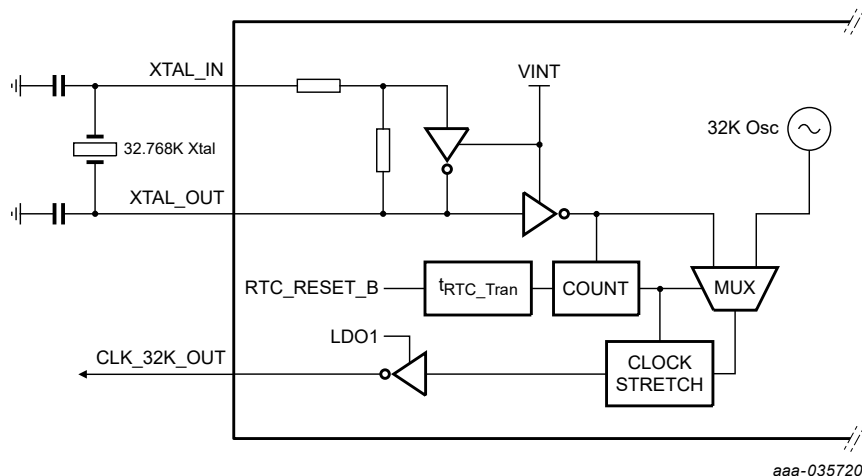


Figure 17. 32 kHz Crystal oscillator driver block diagram

7.8 Load switch

PCA9450 integrates 400 mA load switch which is used to supply SD card VDD. SWIN is connected to BUCK4 output, 3.3 V, in this application. It is enabled by SW_EN pin or SW_EN[1:0] bits in LOADSW_CTRL register. It has soft start feature to reduce inrush current during turn-on. This load switch has overcurrent protection and short circuit protection by monitoring voltage difference between SWIN and SWOUT. When the switch current exceeds overcurrent threshold (I_{OC}) for overcurrent debounce time (t_{OC_DEB}), SW_OCP bit in VRFLT1_STS register is set to 1 and the fault behavior is determined by SW_OC[1:0] configuration in LOADSW_CTRL register. When the switch current exceeds short-circuit current threshold (I_{SC}), SW_OCP bit in VRFLT1_STS register is set to 1 and switch is turned off right away.

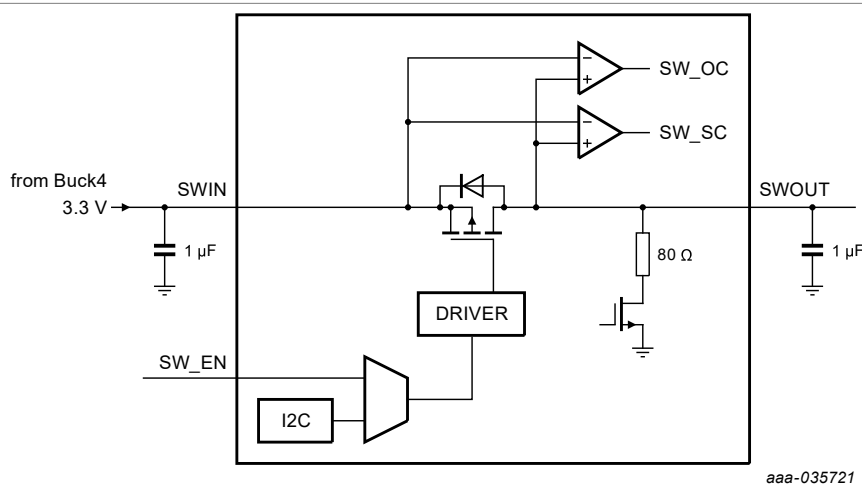


Figure 18. Load switch internal block diagram

7.9 I²C level translator

PCA9450 I²C level translator is a "switch" type voltage translator, and employs two key circuits to enable voltage translation:

1. A pass-gate transistor (N-channel) that ties the ports together.
2. An output edge-rate accelerator that detects and accelerates rising edges on the I/O pins.

The gate bias voltage of the pass gate transistor (T3) is set at approximately one threshold voltage above the VCC level of the low-voltage side. During a LOW-to-HIGH transition the output one-shot accelerates the output transition by switching on the PMOS transistors (T1, T2) bypassing the 10 kΩ pull-up resistors and increasing current drive capability. The one-shot is activated once the input transition reaches approximately VCCI/2; it is de-activated approximately 50 ns after the output reaches VCCO/2. During the acceleration time the driver output resistance is between approximately 50 Ω and 70 Ω. To avoid signal contention and minimize dynamic ICC, the user should wait for the one-shot circuit to turn off before applying a signal in the opposite direction. Pull-up resistors are included in the device for DC current sourcing capability.

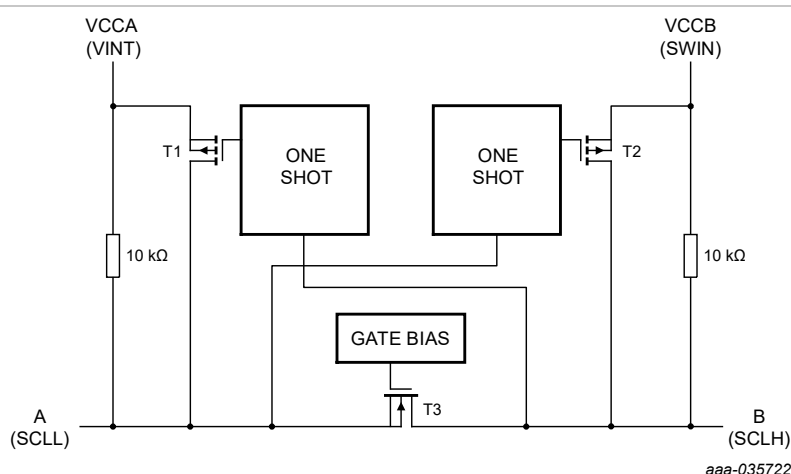


Figure 19. Architecture of I2C Level translator (One channel)

Each A port I/O has an internal 10 kΩ pull-up resistor to VCCA, and each B port I/O has an internal 10 kΩ pull-up resistor to VCCB. If a smaller value of pull-up resistor is required, an external resistor must be added parallel to the internal 10 kΩ, affecting the VOL level. When Level translator is disabled through I2C, the internal pull up resistors are disconnected.

PCA9450 I2C Level translator is controlled by I2C register, CONFIG2 Reg. When it is configured to disabled, all I/Os assume the high-impedance OFF-state. The enable time (ten) indicates the amount of time the user must allow for one one-shot circuitry to become operational after it is enabled.

7.10 Interrupt management

The IRQ_B pin is an interface to the software-controlled system that indicates any interrupt bit status change of INT1 register. The IRQ_B pin is pulled low when any unmasked interrupt bit status is changed and it is released high once application processor reads INT1 register.

The INT1 bits are latched to 1 whenever corresponding STATUS1 bits are changed and the latch is cleared when the INT1 register is read. The INT1_MASK bits are used to enable or disable individual interrupt bits of INT1 register. The STATUS1 register indicates the current status and is not latched.

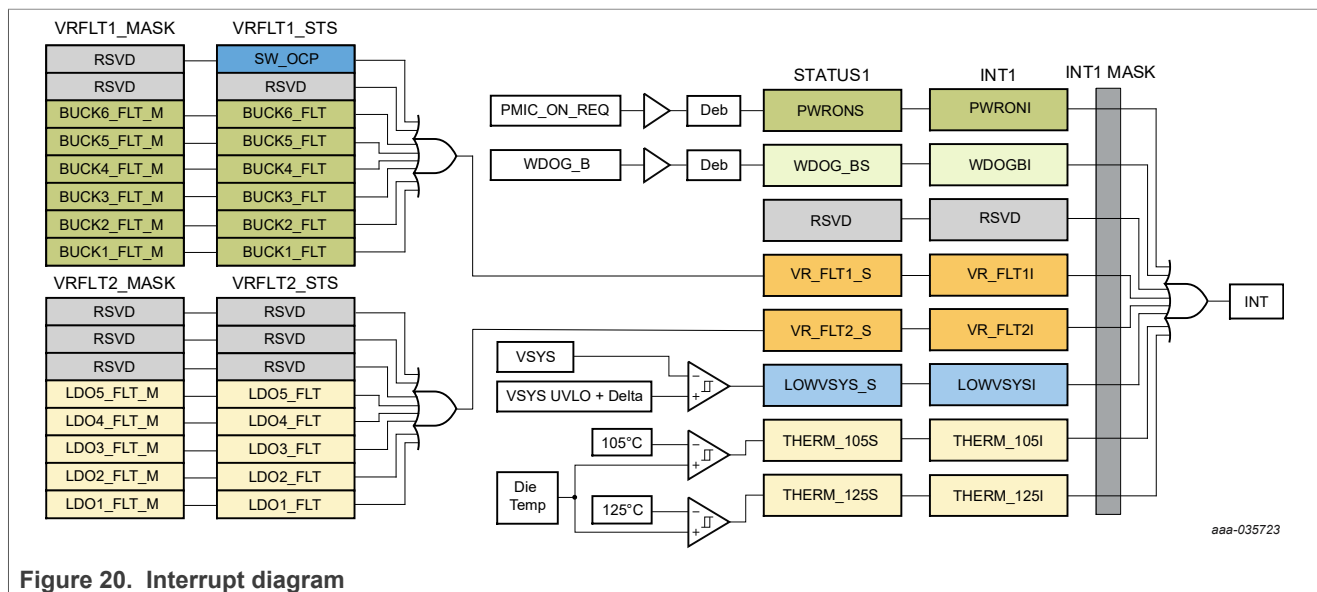


Figure 20. Interrupt diagram

8 Software interface

PCA9450 implements I2C-bus slave interface and it interfaces with the host system. The host processor can issue commands, monitor status and receive response through this bus. A detailed description of the I2C-bus specification, with applications, is given in UM10204, “[I2C-bus specification and user manual](#)” [Ref. 4]. PCA9450 supports I2C-bus data transfers in Standard-mode (100 kbit/s), Fast-mode (400 kbit/s) and Fast-mode plus (1 Mbit/s).

The I2C address at Power-On Reset is shown in [Table 19](#)

Table 19. PCA9450 I2C Slave Address

| 7-bit Slave Address | 8-bit Write Address | 8-bit Read Address |
|---------------------|---------------------|--------------------|
| 0x25, 0b 010 0101 | 0x4A, 0b 0100 1010 | 0x4B, 0b 0100 1011 |

I2C register reset type

Type S1 : Reset condition = $VSYS < V_{SYS_POR}$

Type S : Reset condition = $VSYS < V_{SYS_UVLO}$

Type O : Reset condition = $(VSYS < V_{SYS_UVLO}) \parallel (\text{Cold Reset}) \parallel (\text{Warm Reset}) \parallel (\text{Falling edge of PMIC_ON_REQ}) \parallel (\text{SW_RST}) \parallel (\text{FAULT_SD})$

8.1 Register map

Table 20. Register map

| Add | | Name | Description | | | | | | | R/W | Reset Type | Reset Value | |
|------|----------------|------|-------------|---------------|--------------|---------------|--------------|----------------|--------------|--------------|------------|-------------|------|
| | | | B7 | B6 | B5 | B4 | B3 | B2 | B1 | | | | B0 |
| 0x00 | Device_ID | | CHIP_ID | | | | RSVD | | | | R | S | 0x11 |
| 0x01 | INT1 | | PWERONI | WDOGBI | RSVD | VR_FLT1I | VR_FLT2I | LOWVSYSI | THERM_105I | THERM_125I | R/C | S | 0x00 |
| 0x02 | INT1_MSK | | PWRONI_M | WDOGB_M | RSVD | VR_FLT1_M | VR_FLT2_M | LOWVSYS_M | THERM_105_M | THERM_125_M | R/W | S | 0xFF |
| 0x03 | STATUS1 | | PWRONS | WDOGBS | RSVD | VR_FLT1S | VR_FLT2S | LOWVSYSS | THERM_105S | THERM_125S | R | S | 0x00 |
| 0x04 | STATUS2 | | RSVD | RSVD | RSVD | RSVD | POWER_STATUS | | | | R | S1 | 0x00 |
| 0x05 | PWRON_STAT | | PWRON | WDOG | SW_RST | PMIC_RST | RSVD | RSVD | RSVD | RSVD | R/C | S | 0x00 |
| 0x06 | SW_RST | | SW_RST | | | | | | | R/W | O | 0x00 | |
| 0x07 | PWR_CTRL | | Ton_Deb | | Toff_Deb | Tstep | | Toff_step | | Trestart | R/W | S | 0x4C |
| 0x08 | RESET_CTRL | | WDOGB_CFG | | PMIC_RST_CFG | | RSVD | T_PMIC_RST_DEB | | | R/W | S | 0x21 |
| 0x09 | CONFIG1 | | LOW_VSYS | | VSYS_UVLO | | RSVD | RSVD | tFLT_SD_WAIT | THERM_SD_DIS | R/W | S1 | 0x50 |
| 0x0A | CONFIG2 | | RSVD | RSVD | RSVD | RSVD | RSVD | RSVD | I2C_LT_EN | | R/W | O | 0x00 |
| 0x0C | BUCK123_DVS | | PRESET_EN | B3_DVS_PRESET | | B1_DVS_PRESET | | B2_DVS_PRESET | | | R/W | O | 0xA9 |
| 0x0D | BUCK1OUT_LIMIT | | RSVD | B1_LIMIT | | | | | | | R/W | O | 0x1C |
| 0x0E | BUCK2OUT_LIMIT | | RSVD | B2_LIMIT | | | | | | | R/W | O | 0x20 |
| 0x0F | BUCK3OUT_LIMIT | | RSVD | B3_LIMIT | | | | | | | R/W | O | 0x1C |
| 0x10 | BUCK1CTRL | | RAMP | | RSVD | DVS_CTRL | BUCK1AD | FPWM | B1_ENMODE | | R/W | O | 0x49 |
| 0x11 | BUCK1OUT_DVS0 | | RSVD | B1_DVS0 | | | | | | | R/W | O | 0x14 |
| 0x12 | BUCK1OUT_DVS1 | | RSVD | B1_DVS1 | | | | | | | R/W | O | 0x14 |
| 0x13 | BUCK2CTRL | | RAMP | | RSVD | DVS_CTRL | BUCK2AD | FPWM | B2_ENMODE | | R/W | O | 0x4A |
| 0x14 | BUCK2OUT_DVS0 | | RSVD | B2_DVS0 | | | | | | | R/W | O | 0x14 |

Table 20. Register map...continued

| Add | | Name | | Description | | | | | | R/W | Reset Type | Reset Value |
|------|---------------|---------|---------|-------------|-----------|-----------|-----------|-----------|-----------|-------|------------|-------------|
| | | | | B7 | B6 | B5 | B4 | B3 | B2 | | | |
| 0x15 | BUCK2OUT_DVS1 | RSVD | B2_DVS1 | | | | | | R/W | O | 0x14 | |
| 0x16 | BUCK3CTRL | RAMP | | RSVD | DVS_CTRL | BUCK3AD | FPWM | B3_ENMODE | | R/W | O | 0x49 |
| 0x17 | BUCK3OUT_DVS0 | RSVD | B3_DVS0 | | | | | | R/W | O | 0x14 | |
| 0x18 | BUCK3OUT_DVS1 | RSVD | B3_DVS1 | | | | | | R/W | O | 0x14 | |
| 0x19 | BUCK4CTRL | RSVD | RSVD | RSVD | RSVD | BUCK4AD | FPWM | B4_ENMODE | | R/W | O | 0x09 |
| 0x1A | BUCK4OUT | RSVD | B4_OUT | | | | | | R/W | O | 0x6C | |
| 0x1B | BUCK5CTRL | RSVD | RSVD | RSVD | RSVD | BUCK5AD | FPWM | B5_ENMODE | | R/W | O | 0x09 |
| 0x1C | BUCK5OUT | RSVD | B5_OUT | | | | | | R/W | O | 0x30 | |
| 0x1D | BUCK6CTRL | RSVD | RSVD | RSVD | RSVD | BUCK6AD | FPWM | B6_ENMODE | | R/W | O | 0x09 |
| 0x1E | BUCK6OUT | RSVD | B6_OUT | | | | | | R/W | O | 0x14 | |
| 0x20 | LDO_AD_CTRL | LDO1_AD | LDO2_AD | LDO3_AD | LDO4_AD | LDO5_AD | RSVD | RSVD | RSVD | R/W | O | 0xF8 |
| 0x21 | LDO1CTRL | ENMODE | | RSVD | RSVD | RSVD | L1_OUT | | | R/W | O | 0xC2 |
| 0x22 | LDO2CTRL | ENMODE | | RSVD | RSVD | RSVD | L2_OUT | | | R/W | O | 0xC1 |
| 0x23 | LDO3CTRL | ENMODE | | RSVD | L3_OUT | | | | R/W | O | 0x4A | |
| 0x24 | LDO4CTRL | ENMODE | | RSVD | L4_OUT | | | | R/W | O | 0x41 | |
| 0x25 | LDO5CTRL_L | ENMODE | | RSVD | RSVD | L5_OUT_L | | | R/W | O | 0x4F | |
| 0x26 | LDO5CTRL_H | RSVD | RSVD | RSVD | RSVD | L5_OUT_H | | | R/W | O | 0x00 | |
| 0x27 | RSVD | RSVD | | | | | | R/W | O | 0x00 | | |
| 0x28 | RSVD | RSVD | | | | | | R/W | O | 0x00 | | |
| 0x29 | RSVD | RSVD | | | | | | R/W | O | 0x00 | | |
| 0x2A | LOADSW_CTRL | SW_AD | RSVD | RSVD | SW_SC | SW_OC | | SWEN | | R/W | O | 0x85 |
| 0x2B | VRFLT1_STS | SW_OCP | RSVD | BUCK6_FLT | BUCK5_FLT | BUCK4_FLT | BUCK3_FLT | BUCK2_FLT | BUCK1_FLT | R/W/C | S | 0x00 |
| 0x2C | VRFLT2_STS | RSVD | RSVD | RSVD | LDO5_FLT | LDO4_FLT | LDO3_FLT | LDO2_FLT | LDO1_FLT | R/W/C | S | 0x00 |

Table 20. Register map...continued

| Add | Name | Description | | | | | | | | R/W | Reset Type | Reset Value |
|------|-------------|-------------|------|-------------|-------------|-------------|-------------|-------------|-------------|-----|------------|-------------|
| | | B7 | B6 | B5 | B4 | B3 | B2 | B1 | B0 | | | |
| 0x2D | VRFLT1_MASK | RSVD | RSVD | BUCK6_FLT_M | BUCK5_FLT_M | BUCK4_FLT_M | BUCK3_FLT_M | BUCK2_FLT_M | BUCK1_FLT_M | R/W | S | 0x3F |
| 0x2E | VRFLT2_MASK | RSVD | RSVD | RSVD | LDO5_FLT_M | LDO4_FLT_M | LDO3_FLT_M | LDO2_FLT_M | LDO1_FLT_M | R/W | S | 0x1F |

8.2 Register details

8.2.1 0x00 Device_ID

The device identification code stores a unique identifier for each version and/or revision of a PCA9450, so that the connected processor recognizes it automatically.

Table 21. 0x00 Device_ID

| 0x00 – Device_ID | | | | Reset Type | S |
|------------------|---------|------|-------|--|---|
| Bit | Name | Type | Reset | Description | |
| 7:4 | CHIP_ID | R | 0001 | Chip ID 0001b = PCA9450AA 0011b = PCA9450B, PCA9450C | |
| 3:0 | RSVD | R | 0001 | Reserved | |

8.2.2 0x01 INT1

Interrupt source register. Either of unmasked register bits is set to 1, IRQ_B pin is pulled low. This register is Read and Clear.

Table 22. 0x01 INT1

| 0x01 – INT1 | | | | Reset Type | S |
|-------------|------------|------|-------|--|---|
| Bit | Name | Type | Reset | Description | |
| 7 | PWRONI | R/C | 0 | PWRON interrupt bit 0b = PWRONS bit has not been changed 1b = PWRONS bit has been changed | |
| 6 | WDOGBI | R/C | 0 | WDOGB interrupt bit 0b = WDOG_BS bit has not been changed 1b = WDOG_BS bit has been changed | |
| 5 | RSVD | R/C | 0 | Reserved | |
| 4 | VR_FLT1I | R/C | 0 | Voltage regulator Group1 Fault interrupt 0b = VR_FLT1S bit has not been changed 1b = VR_FLT1S bit has been changed | |
| 3 | VR_FLT2I | R/C | 0 | Voltage regulator Group2 Fault interrupt 0b = VR_FLT2S bit has not been changed 1b = VR_FLT2S bit has been changed | |
| 2 | LOWVSYSI | R/C | 0 | Low-SYS Voltage interrupt bit 0b = LOWVSYS bit has not been changed 1b = LOWVSYS bit has been changed | |
| 1 | THERM_105I | R/C | 0 | Die temperature 105 °C interrupt 0b = THERM_105S bit has not been changed 1b = THERM_105S bit has been changed | |
| 0 | THERM_125I | R/C | 0 | Die temperature 125 °C interrupt 0b = THERM_125S bit has not been changed 1b = THERM_125S bit has been changed | |

8.2.3 0x02 INT1_MSK

The INT1_MSK register enables the masking (disabling) of the different interrupt signals of register INT1. When unmasked, interrupt events trigger the IRQB pin to be pulled low when the matching flag bit in the register INT1 is set.

Table 23. 0x02 INT1_MSK

| 0x02 – INT1_MSK | | | | Reset Type | S |
|-----------------|-------------|------|-------|---|---|
| Bit | Name | Type | Reset | Description | |
| 7 | PWRON_M | R/W | 1 | PWRON interrupt mask bit 0b = Enable PWRON interrupt 1b = Mask PWRON interrupt | |
| 6 | WDOGB_M | R/W | 1 | WDOGBI interrupt mask bit 0b = Enable WDOGBI interrupt 1b = Mask WDOGBI interrupt | |
| 5 | RSVD | R/W | 1 | Reserved | |
| 4 | VR_FLT1_M | R/W | 1 | VR_FLT1I interrupt mask bit 0b = Enable VR_FLT1I interrupt 1b = Mask VR_FLT1I interrupt | |
| 3 | VR_FLT2_M | R/W | 1 | VR_FLT2I interrupt mask bit 0b = Enable VR_FLT2I interrupt 1b = Mask VR_FLT2I interrupt | |
| 2 | LOWVSYS_M | R/W | 1 | LOWVINI interrupt mask bit 0b = Enable LOWVINI interrupt 1b = Mask LOWVINI interrupt | |
| 1 | THERM_105_M | R/W | 1 | THERM_105 interrupt mask bit 0b = Enable THERM_105 interrupt 1b = Mask THERM_105 interrupt | |
| 0 | THERM_125_M | R/W | 1 | THERM_125 interrupt mask bit 0b = Enable THERM_125 interrupt 1b = Mask THERM_125 interrupt | |

8.2.4 0x03 STATUS1

STATUS1 register show current status. Any status bit change set corresponding interrupt bit to 1.

Table 24. 0x03 STATUS1

| 0x03 – STATUS1 | | | | Reset Type | S |
|----------------|---------|------|-------|--|---|
| Bit | Name | Type | Reset | Description | |
| 7 | PWRONS | R | 0 | PMIC_ON_REQ pin status after debounce time 0b = PMIC_ON_REQ pin is low 1b = PMIC_ON_REQ pin is high | |
| 6 | WDOG_BS | R | 0 | WDOG_B pin status 0b = WDOG_B pin is low 1b = WDOG_B pin is high | |
| 5 | RSVD | R | 0 | Reserved | |

Table 24. 0x03 STATUS1...continued

| 0x03 – STATUS1 | | | | Reset Type | S |
|----------------|------------|------|-------|--|---|
| Bit | Name | Type | Reset | Description | |
| 4 | VR_FLT1S | R | 0 | Voltage Regulator Fault status, See 0x2B Register. 0b = All voltage regulators are OK 1b = Either of voltage regulators is in Fault state | |
| 3 | VR_FLT2S | R | 0 | Voltage Regulator POK status, See 0x2C Registers. 0b = All voltage regulators are OK 1b = Either of voltage regulators is in Fault state | |
| 2 | LOWVSYS | R | 0 | VSYS low voltage status 0b = VSYS > Low VSYS threshold 1b = VSYS ≤ Low VSYS threshold | |
| 1 | THERM_105S | R | 0 | Die temperature 105 °C status 0b = Die temperature is below 105 °C 1b = Die temperature is above 105 °C | |
| 0 | THERM_125S | R | 0 | Die temperature 125 °C status 0b = Die temperature is below 125 °C 1b = Die temperature is above 125 °C | |

8.2.5 0x04 STATUS2

STATUS2 register shows current PCA9450 power status.

Table 25. 0x04 STATUS2

| 0x04 – STATUS2 | | | | Reset Type | S1 |
|----------------|--------------|------|-------|--|----|
| Bit | Name | Type | Reset | Description | |
| 7:4 | RSVD | R | 0000 | Reserved | |
| 3:0 | POWER_STATUS | R | 0000 | Current PCA9450 power status 0000b = OFF 0001b = READY 0010b = SNVS 0011b = PWRUP 0100b = RUN 0101b = STANDBY 0110b = PWRDN 0111b = WARM RESET 1000b = COLD RESET 1001b = FAULT Shutdown 1010b – 1111b = Reserved | |

8.2.6 0x05 PWRON_STAT

Power ON source register. It is latched to 1 until the bit is read back.

Table 26. 0x05 PWRON_STAT

| 0x05 – PWRON_STAT | | | | Reset Type | S |
|-------------------|----------|------|-------|--|---|
| Bit | Name | Type | Reset | Description | |
| 7 | PWRON | R/C | 0 | 1b = Power ON triggered by PMIC_ON_REQ. This bit will be set right after completing power up sequence. | |
| 6 | WDOG | R/C | 0 | 1b = This bit is set after cold reset by WDOGB pin | |
| 5 | SW_RST | R/C | 0 | 1b = This bit is set after cold reset by SW_RST bit | |
| 4 | PMIC_RST | R/C | 0 | 1b = This bit is set after cold reset by PMIC_RST_B | |
| 3 | RSVD | R/C | 0 | Reserved | |
| 2 | RSVD | R/C | 0 | Reserved | |
| 1 | RSVD | R/C | 0 | Reserved | |
| 0 | RSVD | R/C | 0 | Reserved | |

8.2.7 0x06 SW_RST

Software reset register through I2C.

Table 27. 0x06 SW_RST

| 0x06 – SW_RST | | | | Reset Type | O |
|---------------|--------|------|-------|---|---|
| Bit | Name | Type | Reset | Description | |
| 7:0 | SW_RST | R/W | 0x00 | Software reset register. This register is read back to "0x00" right after writing the value. 0x00 = No action 0x05 = Reset all registers to default value 0x14 = Cold reset (Power recycle all regulators except LDO1, LDO2 and CLK_32K_OUT) 0x35 = Warm Reset (Toggle POR_B for 20 ms) 0x64 = Cold reset (Power recycle all regulators) Others = No action | |

8.2.8 0x07 PWR_CTRL

Debounce timer configuration register

Table 28. 0x07 PWR_CTRL

| 0x07 – PWR_CTRL | | | | Reset Type | S |
|-----------------|----------|------|-------|--|---|
| Bit | Name | Type | Reset | Description | |
| 7:6 | Ton_Deb | R/W | 01 | Debounce time for PMIC_ON_REQ high. 00b = 120 μ s 01b = 20 ms 10b = 100 ms 11b = 750 ms | |
| 5 | Toff_Deb | R/W | 0 | Debounce time for PMIC_ON_REQ is asserted low 0b = 120 μs 1b = 2 ms | |

Table 28. 0x07 PWR_CTRL....continued

| 0x07 – PWR_CTRL | | | | Reset Type | S |
|-----------------|-----------|------|-------|--|---|
| Bit | Name | Type | Reset | Description | |
| 4:3 | Tstep | R/W | 01 | Time step configuration during power on sequence 00b = 1 ms 01b = 2 ms 10b = 4 ms 11b = 8 ms | |
| 2:1 | Toff_step | R/W | 10 | Time step configuration during power down sequence 00b = 2 ms 01b = 4 ms 10b = 8 ms 11b = 16 ms | |
| 0 | Trestart | R/W | 0 | Time to stay regulators off during Cold reset 0b = 250 ms 1b = 500 ms | |

8.2.9 0x08 RESET_CTRL

Reset behavior configuration register through WDOG_B and PMIC_RST_B pin.

Table 29. 0x08 RESET_CTRL

| 0x08 – RESET_CTRL | | | | Reset Type | S |
|-------------------|----------------|------|-------|--|---|
| Bit | Name | Type | Reset | Description | |
| 7:6 | WD0G_B_CFG | R/W | 00 | When WDOG_B is asserted to low, PMIC reset behavior 00b = WDOG_B reset is disabled 01b = Warm Reset, POR_B pin is asserted low for 20 ms 10b = Cold Reset, All voltage regulators are recycled except LDO1/ LDO2 11b = Cold Reset, All voltage regulators are recycled | |
| 5:4 | PMIC_RST_CFG | R/W | 10 | When PMIC_RST_B is asserted to low, PMIC reset behavior 00b = PMIC_RST_B reset is disabled 01b = Warm Reset, POR_B pin is asserted low for 20 ms 10b = Cold Reset, All voltage regulators are recycled except LDO1/LDO2 11b = Cold Reset, All voltage regulators are recycled | |
| 3 | RSVD | R/W | 0 | Reserved | |
| 2:0 | T_PMIC_RST_DEB | R/W | 001 | PMIC_RST_B debounce time 000b = 10 ms 001b = 50 ms 010b = 100 ms 011b = 500 ms 100b = 1 sec 101b = 2 sec 110b = 4 sec 111b = 8 sec | |

8.2.10 0x09 CONFIG1

VSYS_UVLO and LOW VSYS configuration register

Table 30. 0x09 CONFIG1

| 0x09 – CONFIG1 | | | | Reset Type | S1 |
|----------------|--------------|------|-------|---|----|
| Bit | Name | Type | Reset | Description | |
| 7:6 | LOW_VSYS | R/W | 01 | Low VSYS threshold above V_{SYS_UVLO} 00b = 100 mV 01b = 200 mV 10b = 300 mV 11b = 400 mV | |
| 5:4 | VSYS_UVLO | R/W | 01 | VSYS UVLO Rising threshold 00b = 2.85 V 01b = 3.0 V 10b = 3.15 V 11b = 3.3 V | |
| 3:2 | RSVD | R/W | 00 | Reserved | |
| 1 | tFLT_SD_WAIT | R/W | 0 | Wait time for AP action when regulator fault occurs 0b = 100 ms 1b = 120 μ s | |
| 0 | THERM_SD_DIS | R/W | 0 | Thermal shutdown disable bit 0b = Enable Thermal shutdown 1b = Disable Thermal shutdown | |

8.2.11 0x0A CONFIG2

I2C Level translator control register

Table 31. 0x0A CONFIG2

| 0x0A – CONFIG2 | | | | Reset Type | O |
|----------------|-----------|------|-------|---|---|
| Bit | Name | Type | Reset | Description | |
| 7 | RSVD | R/W | 0 | Reserved | |
| 6:4 | RSVD | R/W | 000 | Reserved | |
| 3:2 | RSVD | R/W | 00 | Reserved | |
| 1:0 | I2C_LT_EN | R/W | 00 | I2C level translator enable 00b = Forced Disable 01b = Enable only when STANDBY and RUN mode 10b = Enable only when RUN mode 11b = Forced enable | |

8.2.12 0x0C BUCK123_DVS

BUCK1, BUCK2, BUCK3 DVS control register with preset value

Table 32. 0x0C BUCK123_DVS

| 0x0C – BUCK123_DVS | | | | Reset Type | O |
|--------------------|---------------|------|-------|--|---|
| Bit | Name | Type | Reset | Description | |
| 7 | PRESET_EN | R/W | 1 | BUCK123 output voltage selection 0b = BUCK voltage is determined by each BUCKxOUT_DVS0 or BUCKxOUT_DVS1. 1b = BUCK voltage is determined by Bx_DVS_PRESET bits. | |
| 6:5 | B3_DVS_PRESET | R/W | 01 | BUCK3 (VPU/GPU) Preset voltage option, only for PCA9450AA. 00b = 0.8 V 01b = 0.85 V 10b = 0.9 V 11b = 0.95 V | |
| 4:3 | B1_DVS_PRESET | R/W | 01 | BUCK1 (SOC) Preset voltage option 00b = 0.8 V 01b = 0.85 V 10b = 0.9 V 11b = 0.95 V | |
| 2:0 | B2_DVS_PRESET | R/W | 001 | BUCK2 (ARM) Preset voltage option 000b = 0.8 V 001b = 0.85 V 010b = 0.9 V 011b = 0.95 V 100b – 111b = 1.0 V | |

8.2.13 0x0D BUCK1OUT_LIMIT

BUCK1 output voltage limit register

Table 33. 0x0D BUCK1OUT_LIMIT

| 0x0D – BUCK1OUT_LIMIT | | | | Reset Type | O |
|-----------------------|----------|------|-------------|--|---|
| Bit | Name | Type | Reset | Description | |
| 7 | RSVD | R/W | 0 | Reserved | |
| 6:0 | B1_LIMIT | R/W | 001 1100 | BUCK1 output voltage limit Programmable from 0.60 V to 2.1875 V in 12.5 mV step Default = 0.95 V | |

8.2.14 0x0E BUCK2OUT_LIMIT

BUCK2 output voltage limit register

Table 34. 0x0E BUCK2OUT_LIMIT

| 0x0E – BUCK2OUT_LIMIT | | | | Reset Type | O |
|-----------------------|------|------|-------|-------------|---|
| Bit | Name | Type | Reset | Description | |
| 7 | RSVD | R/W | 0 | Reserved | |

Table 34. 0x0E BUCK2OUT_LIMIT...continued

| 0x0E – BUCK2OUT_LIMIT | | | | Reset Type | O |
|-----------------------|----------|------|-------------|--|---|
| Bit | Name | Type | Reset | Description | |
| 6:0 | B2_LIMIT | R/W | 010 0000 | BUCK2 output voltage limit Programmable from 0.60 V to 2.1875 V in 12.5 mV step Default = 1.00 V | |

8.2.15 0x0F BUCK3OUT_LIMIT

BUCK3 output voltage limit register. This register is only for PCA9450AA

Table 35. 0x0F BUCK3OUT_LIMIT

| 0x0F – BUCK3OUT_LIMIT | | | | Reset Type | O |
|-----------------------|----------|------|-------------|--|---|
| Bit | Name | Type | Reset | Description | |
| 7 | RSVD | R/W | 0 | Reserved | |
| 6:0 | B3_LIMIT | R/W | 001 1100 | BUCK3 output voltage limit Programmable from 0.60 V to 2.1875 V in 12.5 mV step Default = 0.95 V | |

8.2.16 0x10 BUCK1CTRL

BUCK1 control register for Ramp, DVS control, Active discharge, FPWM and Enable.

Table 36. 0x10 BUCK1CTRL

| 0x10 – BUCK1CTRL | | | | Reset Type | O |
|------------------|-----------|------|-------|--|---|
| Bit | Name | Type | Reset | Description | |
| 7:6 | RAMP | R/W | 01 | BUCK1 DVS speed 00b = 25 mV / 1 μ s 01b = 25 mV / 2 μs 10b = 25 mV / 4 μ s 11b = 25 mV / 8 μ s | |
| 5 | RSVD | R/W | 0 | Reserved | |
| 4 | DVS_CTRL | R/W | 0 | DVS Control configuration 0b = BUCK voltage is determined by BUCK1VOUT_DVS0 register regardless of PMIC_STBY_REQ 1b = DVS control through PMIC_STBY_REQ | |
| 3 | BUCK1AD | R/W | 1 | BUCK1 Active discharge 0b = Always disable Active discharge resistor 1b = Enable Active discharge resistor when regulator is OFF | |
| 2 | FPWM | R/W | 0 | Forced PWM mode 0b = Automatic PFM and PWM mode transition 1b = Forced PWM mode | |
| 1:0 | B1_ENMODE | R/W | 01 | BUCK1 enable mode 00b = OFF 01b = ON by PMIC_ON_REQ = H 10b = ON by PMIC_ON_REQ = H && PMIC_STBY_REQ = L 11b = Always ON | |

8.2.17 0x11 BUCK1OUT_DVS0

BUCK1 DVS output voltage at PMIC_STBY_REQ = L

Table 37. 0x11 BUCK1OUT_DVS0

| 0x11 – BUCK1OUT_DVS0 | | | | Reset Type | O |
|----------------------|---------|------|-------------|---|---|
| Bit | Name | Type | Reset | Description | |
| 7 | RSVD | R/W | 0 | Reserved | |
| 6:0 | B1_DVS0 | R/W | 001 0100 | BUCK1 DVS0 Output voltage Programmable from 0.60 V to 2.1875 V in 12.5 mV step. Table 12 Default = 0.85 V | |

8.2.18 0x12 BUCK1OUT_DVS1

BUCK1 DVS output voltage at PMIC_STBY_REQ = H

Table 38. 0x12 BUCK1OUT_DVS1

| 0x12 – BUCK1OUT_DVS1 | | | | Reset Type | O |
|----------------------|---------|------|-------------|---|---|
| Bit | Name | Type | Reset | Description | |
| 7 | RSVD | R/W | 0 | Reserved | |
| 6:0 | B1_DVS1 | R/W | 001 0100 | BUCK1 DVS1 Output voltage Programmable from 0.60 V to 2.1875 V in 12.5 mV step. Table 12 Default = 0.85 V | |

8.2.19 0x13 BUCK2CTRL

BUCK2 control register for Ramp, DVS control, Active discharge, FPWM and Enable.

Table 39. 0x13 BUCK2CTRL

| 0x13 – BUCK2CTRL | | | | Reset Type | O |
|------------------|----------|------|-------|--|---|
| Bit | Name | Type | Reset | Description | |
| 7:6 | RAMP | R/W | 01 | BUCK2 DVS speed 00b = 25 mV / 1 μ s 01b = 25 mV / 2 μs 10b = 25 mV / 4 μ s 11b = 25 mV / 8 μ s | |
| 5 | RSVD | R/W | 0 | Reserved | |
| 4 | DVS_CTRL | R/W | 0 | DVS Control configuration 0b = BUCK voltage is determined by BUCK2VOUT_DVS0 register regardless of PMIC_STBY_REQ 1b = DVS control through PMIC_STBY_REQ | |
| 3 | BUCK2AD | R/W | 1 | BUCK2 Active discharge 0b = Always disable Active discharge resistor 1b = Enable Active discharge resistor when regulator is OFF | |
| 2 | FPWM | R/W | 0 | Forced PWM mode 0b = Automatic PFM and PWM mode transition 1b = Forced PWM mode | |

Table 39. 0x13 BUCK2CTRL....continued

| 0x13 – BUCK2CTRL | | | | Reset Type | O |
|------------------|-----------|------|-------|---|---|
| Bit | Name | Type | Reset | Description | |
| 1:0 | B2_ENMODE | R/W | 10 | BUCK2 enable mode 00b = OFF 01b = ON by PMIC_ON_REQ = H 10b = ON by PMIC_ON_REQ = H && PMIC_STBY_REQ = L 11b = Always ON | |

8.2.20 0x14 BUCK2OUT_DVS0

BUCK2 DVS output voltage at PMIC_STBY_REQ = L

Table 40. 0x14 BUCK2OUT_DVS0

| 0x14 – BUCK2OUT_DVS0 | | | | Reset Type | O |
|----------------------|---------|------|-------------|---|---|
| Bit | Name | Type | Reset | Description | |
| 7 | RSVD | R/W | 0 | Reserved | |
| 6:0 | B2_DVS0 | R/W | 001 0100 | BUCK2 DVS0 Output voltage Programmable from 0.60 V to 2.1875 V in 12.5 mV step. Table 45 Default = 0.85 V | |

8.2.21 0x15 BUCK2OUT_DVS1

BUCK2 DVS output voltage at PMIC_STBY_REQ = H

Table 41. 0x15 BUCK2OUT_DVS1

| 0x15 – BUCK2OUT_DVS1 | | | | Reset Type | O |
|----------------------|---------|------|-------------|---|---|
| Bit | Name | Type | Reset | Description | |
| 7 | RSVD | R/W | 0 | Reserved | |
| 6:0 | B2_DVS1 | R/W | 001 0100 | BUCK2 DVS1 Output voltage Programmable from 0.60 V to 2.1875 V in 12.5 mV step. Table 45 Default = 0.85 V | |

8.2.22 0x16 BUCK3CTRL

BUCK3 control register for Ramp, DVS control, Active discharge, FPWM and Enable.
The registers related to BUCK3 are only for PCA9450AA.

Table 42. 0x16 BUCK3CTRL

| 0x16 – BUCK3CTRL | | | | Reset Type | O |
|------------------|------|------|-------|--|---|
| Bit | Name | Type | Reset | Description | |
| 7:6 | RAMP | R/W | 01 | BUCK3 DVS speed 00b = 25 mV / 1 μ s 01b = 25 mV / 2 μs 10b = 25 mV / 4 μ s 11b = 25 mV / 8 μ s | |
| 5 | RSVD | R/W | 0 | Reserved | |

Table 42. 0x16 BUCK3CTRL....continued

| 0x16 – BUCK3CTRL | | | | Reset Type | O |
|------------------|-----------|------|-------|--|---|
| Bit | Name | Type | Reset | Description | |
| 4 | DVS_CTRL | R/W | 0 | DVS Control configuration 0b = BUCK voltage is determined by BUCK3VOUT_DVS0 register regardless of PMIC_STBY_REQ 1b = DVS control through PMIC_STBY_REQ | |
| 3 | BUCK3AD | R/W | 1 | BUCK3 Active discharge 0b = Always disable Active discharge resistor 1b = Enable Active discharge resistor when regulator is OFF | |
| 2 | FPWM | R/W | 0 | Forced PWM mode 0b = Automatic PFM and PWM mode transition 1b = Forced PWM mode | |
| 1:0 | B3_ENMODE | R/W | 01 | BUCK3 enable mode 00b = OFF 01b = ON by PMIC_ON_REQ = H 10b = ON by PMIC_ON_REQ = H && PMIC_STBY_REQ = L 11b = Always ON | |

8.2.23 0x17 BUCK3OUT_DVS0

BUCK3 DVS output voltage at PMIC_STBY_REQ = L

Table 43. 0x17 BUCK3OUT_DVS0

| 0x17 – BUCK3OUT_DVS0 | | | | Reset Type | O |
|----------------------|---------|------|-------------|---|---|
| Bit | Name | Type | Reset | Description | |
| 7 | RSVD | R/W | 0 | Reserved | |
| 6:0 | B3_DVS0 | R/W | 001 0100 | BUCK3 DVS0 Output voltage Programmable from 0.60 V to 2.1875 V in 12.5 mV step. Table 45 Default = 0.85 V | |

8.2.24 0x18 BUCK3OUT_DVS1

BUCK3 DVS output voltage a PMIC_STBY_REQ = H

Table 44. 0x18 BUCK3OUT_DVS1

| 0x18 – BUCK3OUT_DVS1 | | | | Reset Type | O |
|----------------------|---------|------|-------------|---|---|
| Bit | Name | Type | Reset | Description | |
| 7 | RSVD | R/W | 0 | Reserved | |
| 6:0 | B3_DVS1 | R/W | 001 0100 | BUCK3 DVS1 Output voltage Programmable from 0.60 V to 2.1875 V in 12.5 mV step. Table 45 Default = 0.85 V | |

Table 45. BUCK1, BUCK2, BUCK3 Output voltage table

| Code | Voltage | Code | Voltage | Code | Voltage | Code | Voltage |
|------|----------|------|----------|------|----------|------|----------|
| 0x00 | 0.6000 V | 0x20 | 1.0000 V | 0x40 | 1.4000 V | 0x60 | 1.8000 V |
| 0x01 | 0.6125 V | 0x21 | 1.0125 V | 0x41 | 1.4125 V | 0x61 | 1.8125 V |
| 0x02 | 0.6250 V | 0x22 | 1.0250 V | 0x42 | 1.4250 V | 0x62 | 1.8250 V |
| 0x03 | 0.6375 V | 0x23 | 1.0375 V | 0x43 | 1.4375 V | 0x63 | 1.8375 V |
| 0x04 | 0.6500 V | 0x24 | 1.0500 V | 0x44 | 1.4500 V | 0x64 | 1.8500 V |
| 0x05 | 0.6625 V | 0x25 | 1.0625 V | 0x45 | 1.4625 V | 0x65 | 1.8625 V |
| 0x06 | 0.6750 V | 0x26 | 1.0750 V | 0x46 | 1.4750 V | 0x66 | 1.8750 V |
| 0x07 | 0.6875 V | 0x27 | 1.0875 V | 0x47 | 1.4875 V | 0x67 | 1.8875 V |
| 0x08 | 0.7000 V | 0x28 | 1.1000 V | 0x48 | 1.5000 V | 0x68 | 1.9000 V |
| 0x09 | 0.7125 V | 0x29 | 1.1125 V | 0x49 | 1.5125 V | 0x69 | 1.9125 V |
| 0x0A | 0.7250 V | 0x2A | 1.1250 V | 0x4A | 1.5250 V | 0x6A | 1.9250 V |
| 0x0B | 0.7375 V | 0x2B | 1.1375 V | 0x4B | 1.5375 V | 0x6B | 1.9375 V |
| 0x0C | 0.7500 V | 0x2C | 1.1500 V | 0x4C | 1.5500 V | 0x6C | 1.9500 V |
| 0x0D | 0.7625 V | 0x2D | 1.1625 V | 0x4D | 1.5625 V | 0x6D | 1.9625 V |
| 0x0E | 0.7750 V | 0x2E | 1.1750 V | 0x4E | 1.5750 V | 0x6E | 1.9750 V |
| 0x0F | 0.7875 V | 0x2F | 1.1875 V | 0x4F | 1.5875 V | 0x6F | 1.9875 V |
| 0x10 | 0.8000 V | 0x30 | 1.2000 V | 0x50 | 1.6000 V | 0x70 | 2.0000 V |
| 0x11 | 0.8125 V | 0x31 | 1.2125 V | 0x51 | 1.6125 V | 0x71 | 2.0125 V |
| 0x12 | 0.8250 V | 0x32 | 1.2250 V | 0x52 | 1.6250 V | 0x72 | 2.0250 V |
| 0x13 | 0.8375 V | 0x33 | 1.2375 V | 0x53 | 1.6375 V | 0x73 | 2.0375 V |
| 0x14 | 0.8500 V | 0x34 | 1.2500 V | 0x54 | 1.6500 V | 0x74 | 2.0500 V |
| 0x15 | 0.8625 V | 0x35 | 1.2625 V | 0x55 | 1.6625 V | 0x75 | 2.0625 V |
| 0x16 | 0.8750 V | 0x36 | 1.2750 V | 0x56 | 1.6750 V | 0x76 | 2.0750 V |
| 0x17 | 0.8875 V | 0x37 | 1.2875 V | 0x57 | 1.6875 V | 0x77 | 2.0875 V |
| 0x18 | 0.9000 V | 0x38 | 1.3000 V | 0x58 | 1.7000 V | 0x78 | 2.1000 V |
| 0x19 | 0.9125 V | 0x39 | 1.3125 V | 0x59 | 1.7125 V | 0x79 | 2.1125 V |
| 0x1A | 0.9250 V | 0x3A | 1.3250 V | 0x5A | 1.7250 V | 0x7A | 2.1250 V |
| 0x1B | 0.9375 V | 0x3B | 1.3375 V | 0x5B | 1.7375 V | 0x7B | 2.1375 V |
| 0x1C | 0.9500 V | 0x3C | 1.3500 V | 0x5C | 1.7500 V | 0x7C | 2.1500 V |
| 0x1D | 0.9625 V | 0x3D | 1.3625 V | 0x5D | 1.7625 V | 0x7D | 2.1625 V |
| 0x1E | 0.9750 V | 0x3E | 1.3750 V | 0x5E | 1.7750 V | 0x7E | 2.1750 V |
| 0x1F | 0.9875 V | 0x3F | 1.3875 V | 0x5F | 1.7875 V | 0x7F | 2.1875 V |

8.2.25 0x19 BUCK4CTRL

BUCK4 control register for Active discharge, FPWM and Enable.

Table 46. 0x19 BUCK4CTRL

| 0x19 – BUCK4CTRL | | | | Reset Type | O |
|------------------|-----------|------|-------|---|---|
| Bit | Name | Type | Reset | Description | |
| 7:4 | RSVD | R/W | 0000 | Reserved | |
| 3 | BUCK4AD | R/W | 1 | BUCK4 Active discharge 0b = Always disable Active discharge resistor 1b = Enable Active discharge resistor when regulator is OFF | |
| 2 | FPWM | R/W | 0 | Forced PWM mode 0b = Automatic PFM and PWM mode transition 1b = Forced PWM mode | |
| 1:0 | B4_ENMODE | R/W | 01 | BUCK4 enable mode 00b = OFF 01b = ON by PMIC_ON_REQ = H 10b = ON by PMIC_ON_REQ = H && PMIC_STBY_REQ = L 11b = Always ON | |

8.2.26 0x1A BUCK4OUT

BUCK4 output voltage configuration register

Table 47. 0x1A BUCK4OUT

| 0x1A – BUCK4OUT | | | | Reset Type | O |
|-----------------|--------|------|-------------|---|---|
| Bit | Name | Type | Reset | Description | |
| 7 | RSVD | R/W | 0 | Reserved | |
| 6:0 | B4_OUT | R/W | 110 1100 | BUCK4 Output voltage Programmable from 0.60 V to 3.40 V in 25 mV step. Table 52 Default = 3.3 V | |

8.2.27 0x1B BUCK5CTRL

BUCK5 control register for Active discharge, FPWM and Enable.

Table 48. 0x1B BUCK5CTRL

| 0x1B – BUCK5CTRL | | | | Reset Type | O |
|------------------|-----------|------|-------|---|---|
| Bit | Name | Type | Reset | Description | |
| 7:4 | RSVD | R/W | 0000 | Reserved | |
| 3 | BUCK5AD | R/W | 1 | BUCK5 Active discharge 0b = Always disable Active discharge resistor 1b = Enable Active discharge resistor when regulator is OFF | |
| 2 | FPWM | R/W | 0 | Forced PWM mode 0b = Automatic PFM and PWM mode transition 1b = Forced PWM mode | |
| 1:0 | B5_ENMODE | R/W | 01 | BUCK5 enable mode 00b = OFF 01b = ON by PMIC_ON_REQ = H 10b = ON by PMIC_ON_REQ = H && PMIC_STBY_REQ = L 11b = Always ON | |

8.2.28 0x1C BUCK5OUT

BUCK5 output voltage configuration register

Table 49. 0x1C BUCK5OUT

| 0x1C – BUCK5OUT | | | | Reset Type | O |
|-----------------|--------|------|-------------|---|---|
| Bit | Name | Type | Reset | Description | |
| 7 | RSVD | R/W | 0 | Reserved | |
| 6:0 | B5_OUT | R/W | 011 0000 | BUCK5 Output voltage Programmable from 0.60 V to 3.40 V in 25 mV step. Table 52 Default = 1.8 V | |

8.2.29 0x1D BUCK6CTRL

BUCK6 control register for Active discharge, FPWM and Enable.

Table 50. 0x1D BUCK6CTRL

| 0x1D – BUCK6OUT | | | | Reset Type | O |
|-----------------|-----------|------|-------|---|---|
| Bit | Name | Type | Reset | Description | |
| 7:4 | RSVD | R/W | 0000 | Reserved | |
| 3 | BUCK6AD | R/W | 1 | BUCK6 Active discharge 0b = Always disable Active discharge resistor 1b = Enable Active discharge resistor when regulator is OFF | |
| 2 | FPWM | R/W | 0 | Forced PWM mode 0b = Automatic PFM and PWM mode transition 1b = Forced PWM mode | |
| 1:0 | B6_ENMODE | R/W | 01 | BUCK6 enable mode 00b = OFF 01b = ON by PMIC_ON_REQ = H 10b = ON by PMIC_ON_REQ = H && PMIC_STBY_REQ = L 11b = Always ON | |

8.2.30 0x1E BUCK6OUT

BUCK6 output voltage configuration register

Table 51. 0x1E BUCK6OUT

| 0x1E – BUCK6CTRL | | | | Reset Type | O |
|------------------|--------|------|-------------|---|---|
| Bit | Name | Type | Reset | Description | |
| 7 | RSVD | R/W | 0 | Reserved | |
| 6:0 | B6_OUT | R/W | 001 0100 | BUCK6 Output voltage Programmable from 0.60 V to 3.40 V in 25 mV step. Table 52 Default = 1.1 V | |

Table 52. BUCK4, BUCK5, BUCK6 Output voltage table

| Code | Voltage | Code | Voltage | Code | Voltage | Code | Voltage |
|------|---------|------|---------|------|---------|------|---------|
| 0x00 | 0.600 V | 0x20 | 1.400 V | 0x40 | 2.200 V | 0x60 | 3.000 V |
| 0x01 | 0.625 V | 0x21 | 1.425 V | 0x41 | 2.225 V | 0x61 | 3.025 V |
| 0x02 | 0.650 V | 0x22 | 1.450 V | 0x42 | 2.250 V | 0x62 | 3.050 V |
| 0x03 | 0.675 V | 0x23 | 1.475 V | 0x43 | 2.275 V | 0x63 | 3.075 V |
| 0x04 | 0.700 V | 0x24 | 1.500 V | 0x44 | 2.300 V | 0x64 | 3.100 V |
| 0x05 | 0.725 V | 0x25 | 1.525 V | 0x45 | 2.325 V | 0x65 | 3.125 V |
| 0x06 | 0.750 V | 0x26 | 1.550 V | 0x46 | 2.350 V | 0x66 | 3.150 V |
| 0x07 | 0.775 V | 0x27 | 1.575 V | 0x47 | 2.375 V | 0x67 | 3.175 V |
| 0x08 | 0.800 V | 0x28 | 1.600 V | 0x48 | 2.400 V | 0x68 | 3.200 V |
| 0x09 | 0.825 V | 0x29 | 1.625 V | 0x49 | 2.425 V | 0x69 | 3.225 V |
| 0x0A | 0.850 V | 0x2A | 1.650 V | 0x4A | 2.450 V | 0x6A | 3.250 V |
| 0x0B | 0.875 V | 0x2B | 1.675 V | 0x4B | 2.475 V | 0x6B | 3.275 V |
| 0x0C | 0.900 V | 0x2C | 1.700 V | 0x4C | 2.500 V | 0x6C | 3.300 V |
| 0x0D | 0.925 V | 0x2D | 1.725 V | 0x4D | 2.525 V | 0x6D | 3.325 V |
| 0x0E | 0.950 V | 0x2E | 1.750 V | 0x4E | 2.550 V | 0x6E | 3.350 V |
| 0x0F | 0.975 V | 0x2F | 1.775 V | 0x4F | 2.575 V | 0x6F | 3.375 V |
| 0x10 | 1.000 V | 0x30 | 1.800 V | 0x50 | 2.600 V | 0x70 | 3.400 V |
| 0x11 | 1.025 V | 0x31 | 1.825 V | 0x51 | 2.625 V | 0x71 | 3.400 V |
| 0x12 | 1.050 V | 0x32 | 1.850 V | 0x52 | 2.650 V | 0x72 | 3.400 V |
| 0x13 | 1.075 V | 0x33 | 1.875 V | 0x53 | 2.675 V | 0x73 | 3.400 V |
| 0x14 | 1.100 V | 0x34 | 1.900 V | 0x54 | 2.700 V | 0x74 | 3.400 V |
| 0x15 | 1.125 V | 0x35 | 1.925 V | 0x55 | 2.725 V | 0x75 | 3.400 V |
| 0x16 | 1.150 V | 0x36 | 1.950 V | 0x56 | 2.750 V | 0x76 | 3.400 V |
| 0x17 | 1.175 V | 0x37 | 1.975 V | 0x57 | 2.775 V | 0x77 | 3.400 V |
| 0x18 | 1.200 V | 0x38 | 2.000 V | 0x58 | 2.800 V | 0x78 | 3.400 V |
| 0x19 | 1.225 V | 0x39 | 2.025 V | 0x59 | 2.825 V | 0x79 | 3.400 V |
| 0x1A | 1.250 V | 0x3A | 2.050 V | 0x5A | 2.850 V | 0x7A | 3.400 V |
| 0x1B | 1.275 V | 0x3B | 2.075 V | 0x5B | 2.875 V | 0x7B | 3.400 V |
| 0x1C | 1.300 V | 0x3C | 2.100 V | 0x5C | 2.900 V | 0x7C | 3.400 V |
| 0x1D | 1.325 V | 0x3D | 2.125 V | 0x5D | 2.925 V | 0x7D | 3.400 V |
| 0x1E | 1.350 V | 0x3E | 2.150 V | 0x5E | 2.950 V | 0x7E | 3.400 V |
| 0x1F | 1.375 V | 0x3F | 2.175 V | 0x5F | 2.975 V | 0x7F | 3.400 V |

8.2.31 0x20 LDO_AD_CTRL

LDO active discharge resistor configuration register

Table 53. 0x20 LDO_AD_CTRL

| 0x20 – LDO_AD_CTRL | | | | Reset Type | O |
|--------------------|---------|------|-------|---|---|
| Bit | Name | Type | Reset | Description | |
| 7 | LDO1_AD | R/W | 1 | LDO1 Active discharge enable 0b = Always disable Active discharge resistor 1b = Enable Active discharge resistor when regulator is OFF | |
| 6 | LDO2_AD | R/W | 1 | LDO2 Active discharge enable 0b = Always disable Active discharge resistor 1b = Enable Active discharge resistor when regulator is OFF | |
| 5 | LDO3_AD | R/W | 1 | LDO3 Active discharge enable 0b = Always disable Active discharge resistor 1b = Enable Active discharge resistor when regulator is OFF | |
| 4 | LDO4_AD | R/W | 1 | LDO4 Active discharge enable 0b = Always disable Active discharge resistor 1b = Enable Active discharge resistor when regulator is OFF | |
| 3 | LDO5_AD | R/W | 1 | LDO5 Active discharge enable 0b = Always disable Active discharge resistor 1b = Enable Active discharge resistor when regulator is OFF | |
| 2 | RSVD | R/W | 0 | Reserved | |
| 1 | RSVD | R/W | 0 | Reserved | |
| 0 | RSVD | R/W | 0 | Reserved | |

8.2.32 0x21 LDO1CTRL

LDO1 control register for enable and voltage

Table 54. 0x21 LDO1CTRL

| 0x21 – LDO1CTRL | | | | Reset Type | O |
|-----------------|--------|------|-------|--|---|
| Bit | Name | Type | Reset | Description | |
| 7:6 | ENMODE | R/W | 11 | LDO1 Enable mode 00b = OFF 01b = ON by PMIC_ON_REQ = H 10b = ON by PMIC_ON_REQ = H && PMIC_STBY_REQ = L 11b = Always ON * When LDO1 is turned off, PCA9450/A transitions to READY mode | |
| 5:3 | RSVD | R/W | 000 | Reserved | |

Table 54. 0x21 LDO1CTRL...continued

| 0x21 – LDO1CTRL | | | | Reset Type | O |
|-----------------|--------|------|-------|---|---|
| Bit | Name | Type | Reset | Description | |
| 2:0 | L1_OUT | R/W | 010 | LDO1 output voltage Programmable from 1.6 V – 1.9 V, 3.0 V – 3.3 V in 100 mV step 000b = 1.6 V 001b = 1.7 V 010b = 1.8 V 011b = 1.9 V 100b = 3.0 V 101b = 3.1 V 110b = 3.2 V 111b = 3.3 V | |

8.2.33 0x22 LDO2CTRL

LDO2 control register for enable and voltage

Table 55. 0x22 LDO2CTRL

| 0x22 – LDO2CTRL | | | | Reset Type | O |
|-----------------|--------|------|-------|---|---|
| Bit | Name | Type | Reset | Description | |
| 7:6 | ENMODE | R/W | 11 | LDO2 Enable mode 00b = OFF 01b = ON by PMIC_ON_REQ = H 10b = ON by PMIC_ON_REQ = H && PMIC_STBY_REQ = L 11b = Always ON * When LDO2 is turned off, PCA9450/A transitions to READY mode | |
| 5:3 | RSVD | R/W | 000 | Reserved | |
| 2:0 | L2_OUT | R/W | 001 | LDO2 output voltage Programmable from 0.8 V to 1.15 V in 50 mV step 000b = 0.8 V 001b = 0.85 V 010b = 0.9 V 011b = 0.95 V 100b = 1.0 V 101b = 1.05 V 110b = 1.1 V 111b = 1.15 V | |

8.2.34 0x23 LDO3CTRL

LDO3 control register for enable and voltage

Table 56. 0x23 LDO3CTRL

| 0x23 – LDO3CTRL | | | | Reset Type | O |
|-----------------|--------|------|--------|--|---|
| Bit | Name | Type | Reset | Description | |
| 7:6 | ENMODE | R/W | 01 | LDO3 Enable mode 00b = OFF 01b = ON by PMIC_ON_REQ = H 10b = ON by PMIC_ON_REQ = H && PMIC_STBY_REQ = L 11b = Always ON | |
| 5 | RSVD | R/W | 0 | Reserved | |
| 4:0 | L3_OUT | R/W | 0 1010 | LDO3 output voltage Programmable from 0.8 V to 3.3 V in 100 mV step, see Table 57 | |

Table 57. LDO3 output voltage

| | | | |
|---------------|---------------------|---------------|---------------|
| 0x00 : 0.80 V | 0x8 : 1.60 V | 0x10 : 2.40 V | 0x18 : 3.20 V |
| 0x01 : 0.90 V | 0x9 : 1.70 V | 0x11 : 2.50 V | 0x19 : 3.30 V |
| 0x02 : 1.00 V | 0xA : 1.80 V | 0x12 : 2.60 V | 0x1A : 3.30 V |
| 0x03 : 1.10 V | 0xB : 1.90 V | 0x13 : 2.70 V | 0x1B : 3.30 V |
| 0x04 : 1.20 V | 0xC : 2.00 V | 0x14 : 2.80 V | 0x1C : 3.30 V |
| 0x05 : 1.30 V | 0xD : 2.10 V | 0x15 : 2.90 V | 0x1D : 3.30 V |
| 0x06 : 1.40 V | 0xE : 2.20 V | 0x16 : 3.00 V | 0x1E : 3.30 V |
| 0x07 : 1.50 V | 0xF : 2.30 V | 0x17 : 3.10 V | 0x1F : 3.30 V |

8.2.35 0x24 LDO4CTRL

LDO4 control register for enable and voltage

Table 58. 0x24 LDO4CTRL

| 0x24 – LDO4CTRL | | | | Reset Type | O |
|-----------------|--------|------|--------|---|---|
| Bit | Name | Type | Reset | Description | |
| 7:6 | ENMODE | R/W | 01 | LDO4 Enable mode 00b = OFF (PCA9450B/PCA9450C) 01b = ON by PMIC_ON_REQ = H (PCA9450AA) 10b = ON by PMIC_ON_REQ = H && PMIC_STBY_REQ = L 11b = Always ON | |
| 5 | RSVD | R/W | 0 | Reserved | |
| 4:0 | L4_OUT | R/W | 0 0001 | LDO4 output voltage Programmable from 0.8 V to 3.3 V in 100 mV step, see Table 59 | |

Table 59. LDO4 output voltage

| | | | |
|----------------------|--------------|---------------|---------------|
| 0x00 : 0.80 V | 0x8 : 1.60 V | 0x10 : 2.40 V | 0x18 : 3.20 V |
| 0x01 : 0.90 V | 0x9 : 1.70 V | 0x11 : 2.50 V | 0x19 : 3.30 V |
| 0x02 : 1.00 V | 0xA : 1.80 V | 0x12 : 2.60 V | 0x1A : 3.30 V |

Table 59. LDO4 output voltage...continued

| | | | |
|---------------|--------------|---------------|---------------|
| 0x03 : 1.10 V | 0xB : 1.90 V | 0x13 : 2.70 V | 0x1B : 3.30 V |
| 0x04 : 1.20 V | 0xC : 2.00 V | 0x14 : 2.80 V | 0x1C : 3.30 V |
| 0x05 : 1.30 V | 0xD : 2.10 V | 0x15 : 2.90 V | 0x1D : 3.30 V |
| 0x06 : 1.40 V | 0xE : 2.20 V | 0x16 : 3.00 V | 0x1E : 3.30 V |
| 0x07 : 1.50 V | 0xF : 2.30 V | 0x17 : 3.10 V | 0x1F : 3.30 V |

8.2.36 0x25 LDO5CTRL_L

LDO5 control register for enable and voltage when SD_VSEL is low

Table 60. 0x25 LDO5CTRL_L

| 0x25 – LDO5CTRL_L | | | | Reset Type | O |
|-------------------|----------|------|-------|--|---|
| Bit | Name | Type | Reset | Description | |
| 7:6 | ENMODE | R/W | 01 | LDO5 Enable mode 00b = OFF 01b = ON by PMIC_ON_REQ = H 10b = ON by PMIC_ON_REQ = H && PMIC_STBY_REQ = L 11b = Always ON | |
| 5:4 | RSVD | R/W | 00 | Reserved | |
| 3:0 | L5_OUT_L | R/W | 1111 | LDO5 output voltage when SD_VSEL = Low Programmable from 1.8 V to 3.3 V in 100 mV step, see Table 61 | |

Table 61. LDO5 output voltage when SD_VSEL = Low

| | | | |
|---------------|--------------|--------------|---------------------|
| 0x00 : 1.80 V | 0x4 : 2.20 V | 0x8 : 2.60 V | 0xC : 3.00 V |
| 0x01 : 1.90 V | 0x5 : 2.30 V | 0x9 : 2.70 V | 0xD : 3.10 V |
| 0x02 : 2.00 V | 0x6 : 2.40 V | 0xA : 2.80 V | 0xE : 3.20 V |
| 0x03 : 2.10 V | 0x7 : 2.50 V | 0xB : 2.90 V | 0xF : 3.30 V |

8.2.37 0x26 LDO5CTRL_H

LDO5 control register for enable and voltage when SD_VSEL is High

Table 62. 0x26 LDO5CTRL_H

| 0x26 – LDO5CTRL_H | | | | Reset Type | O |
|-------------------|----------|------|-------|--|---|
| Bit | Name | Type | Reset | Description | |
| 7:6 | RSVD | R/W | 00 | Reserved | |
| 5:4 | RSVD | R/W | 00 | Reserved | |
| 3:0 | L5_OUT_H | R/W | 0000 | LDO5 output voltage when SD_VSEL = High Programmable from 1.8 V to 3.3 V in 100 mV step, see Table 63 | |

Table 63. LDO5 output voltage when SD_VSEL = High

| | | | |
|----------------------|--------------|--------------|--------------|
| 0x00 : 1.80 V | 0x4 : 2.20 V | 0x8 : 2.60 V | 0xC : 3.00 V |
|----------------------|--------------|--------------|--------------|

Table 63. LDO5 output voltage when SD_VSEL = High...continued

| | | | |
|---------------|--------------|--------------|--------------|
| 0x01 : 1.90 V | 0x5 : 2.30 V | 0x9 : 2.70 V | 0xD : 3.10 V |
| 0x02 : 2.00 V | 0x6 : 2.40 V | 0xA : 2.80 V | 0xE : 3.20 V |
| 0x03 : 2.10 V | 0x7 : 2.50 V | 0xB : 2.90 V | 0xF : 3.30 V |

8.2.38 0x2A LOADSW_CTRL

Load switch control register for active discharge, short/over current and enable

Table 64. 0x2A LOADSW_CTRL

| 0x2A – LOADSW_CTRL | | | | Reset Type | O |
|--------------------|-------|------|-------|---|---|
| Bit | Name | Type | Reset | Description | |
| 7 | SW_AD | R/W | 1 | Load switch active discharge 0b = Always disable active discharge resistor 1b = Enable active discharge resistor when it is OFF | |
| 6:5 | RSVD | R/W | 00 | Reserved | |
| 4 | SW_SC | R/W | 0 | When switch detects short circuit current 0b = Turned OFF and set SWEN[1:0] are set to 00b automatically 1b = Turned off and restart in 100 ms | |
| 3:2 | SW_OC | R/W | 01 | When load switch detects over current 00b = Turned OFF and set SWEN[1:0] are set to 00b automatically 01b = Turned off and restart in 100 ms 10b, 11b = stay ON | |
| 1:0 | SWEN | R/W | 01 | SW Enable control 00b = Forced OFF 01b = Enabled by SW_EN pin 10b = Forced ON 11b = Forced ON | |

8.2.39 0x2B VRFLT1_STS

Voltage regulator fault status register. It is latched to 1 once corresponding regulator detects fault. If the bit is overwritten to 1, the corresponding bit is newly updated by current status.

Table 65. 0x2B VRFLT1_STS

| 0x2B – VRFLT1_STS | | | | Reset Type | S |
|-------------------|-----------|-------|-------|--|---|
| Bit | Name | Type | Reset | Description | |
| 7 | SW_OCP | R/W/C | 0 | Load SW OCP status, deglitched with $t_{DEB_POKB_SW}$ 0 = Load SW doesn't exceed current limit or is OFF 1 = Load SW exceeded current limit | |
| 6 | RSVD | R/W/C | 0 | Reserved | |
| 5 | BUCK6_FLT | R/W/C | 0 | BUCK6 Fault status, deglitched with t_{DEB_POKB} 0b = BUCK6 output is good or BUCK6 is OFF 1b = BUCK6 output falls below 80 % of target | |

Table 65. 0x2B VRFLT1_STS...continued

| 0x2B – VRFLT1_STS | | | | Reset Type | S |
|-------------------|-----------|-------|-------|---|---|
| Bit | Name | Type | Reset | Description | |
| 4 | BUCK5_FLT | R/W/C | 0 | BUCK5 Fault status, deglitched with t_{DEB_POKB} 0b = BUCK5 output is good or BUCK5 is OFF 1b = BUCK5 output falls below 80 % of target | |
| 3 | BUCK4_FLT | R/W/C | 0 | BUCK4 Fault status, deglitched with t_{DEB_POKB} 0b = BUCK4 output is good or BUCK4 is OFF 1b = BUCK4 output is below 80 % | |
| 2 | BUCK3_FLT | R/W/C | 0 | BUCK3 Fault status, deglitched with t_{DEB_POKB} 0b = BUCK3 output is good or BUCK3 is OFF 1b = BUCK3 output falls below 80 % of target | |
| 1 | BUCK2_FLT | R/W/C | 0 | BUCK2 Fault status, deglitched with t_{DEB_POKB} 0b = BUCK2 output is good or BUCK2 is OFF 1b = BUCK2 output falls below 80 % of target | |
| 0 | BUCK1_FLT | R/W/C | 0 | BUCK1 Fault status, deglitched with t_{DEB_POKB} 0b = BUCK1 output is good or BUCK1 is OFF 1b = BUCK1 output falls below 80 % of target | |

8.2.40 0x2C VRFLT2_STS

Voltage regulator fault status register. It is latched to 1 once corresponding regulator detects fault. If the bit is overwritten to 1, the corresponding bit is newly updated by current status.

Table 66. 0x2C VRFLT2_STS

| 0x2C – VRFLT2_STS | | | | Reset Type | S |
|-------------------|----------|-------|-------|---|---|
| Bit | Name | Type | Reset | Description | |
| 7:5 | RSVD | R/W/C | 000 | Reserved | |
| 4 | LDO5_FLT | R/W/C | 0 | LDO5 Fault status, deglitched with t_{DEB_POKB} 0b = LDO5 output is good or LDO5 is OFF 1b = LDO5 output falls below 80 % of target | |
| 3 | LDO4_FLT | R/W/C | 0 | LDO4 Fault status, deglitched with t_{DEB_POKB} 0b = LDO4 output is good or LDO4 is OFF 1b = LDO4 output falls below 80 % of target | |
| 2 | LDO3_FLT | R/W/C | 0 | LDO3 Fault status, deglitched with t_{DEB_POKB} 0b = LDO3 output is good or LDO3 is OFF 1b = LDO3 output falls below 80 % of target | |
| 1 | LDO2_FLT | R/W/C | 0 | LDO2 Fault status, deglitched with t_{DEB_POKB} 0b = LDO2 output is good or LDO2 is OFF 1b = LDO2 output falls below 80 % of target | |
| 0 | LDO1_FLT | R/W/C | 0 | LDO1 Fault status, deglitched with t_{DEB_POKB} 0b = LDO1 output is good or LDO1 is OFF 1b = LDO1 output falls below 80 % of target | |

8.2.41 0x2D VRFLT1_MASK

VR fault mask bit. Once the bit is masked, PCA9450 doesn't enter Fault shutdown even if fault condition of corresponding regulator happens

Table 67. 0x2D VRFLT1_MASK

| 0x2D – VRFLT1_MASK | | | | Reset Type | S |
|--------------------|-------------|------|-------|---|---|
| Bit | Name | Type | Reset | Description | |
| 7 | RSVD | R/W | 0 | Reserved | |
| 6 | RSVD | R/W | 0 | Reserved | |
| 5 | BUCK6_FLT_M | R/W | 1 | BUCK6 FLT mask 0b = Unmask 1b = Masked | |
| 4 | BUCK5_FLT_M | R/W | 1 | BUCK5 FLT mask 0b = Unmask 1b = Masked | |
| 3 | BUCK4_FLT_M | R/W | 1 | BUCK4 FLT mask 0b = Unmask 1b = Masked | |
| 2 | BUCK3_FLT_M | R/W | 1 | BUCK3 FLT mask 0b = Unmask 1b = Masked | |
| 1 | BUCK2_FLT_M | R/W | 1 | BUCK2 FLT mask 0b = Unmask 1b = Masked | |
| 0 | BUCK1_FLT_M | R/W | 1 | BUCK1 FLT mask 0b = Unmask 1b = Masked | |

8.2.42 0x2E VRFLT2_MASK

VR fault mask bit. Once the bit is masked, PCA9450 doesn't enter Fault shutdown even if fault condition of corresponding regulator happens

Table 68. 0x2E VRFLT2_MASK

| 0x2E – VRFLT2_MASK | | | | Reset Type | S |
|--------------------|------------|-------|-------|--|---|
| Bit | Name | Type | Reset | Description | |
| 7 | RSVD | R/W/C | 0 | Reserved | |
| 6 | RSVD | R/W/C | 0 | Reserved | |
| 5 | RSVD | R/W/C | 0 | Reserved | |
| 4 | LDO5_FLT_M | R/W | 1 | LDO5 FLT mask 0b = Unmask 1b = Masked | |
| 3 | LDO4_FLT_M | R/W | 1 | LDO4 FLT mask 0b = Unmask 1b = Masked | |

Table 68. 0x2E VRFLT2_MASK...continued

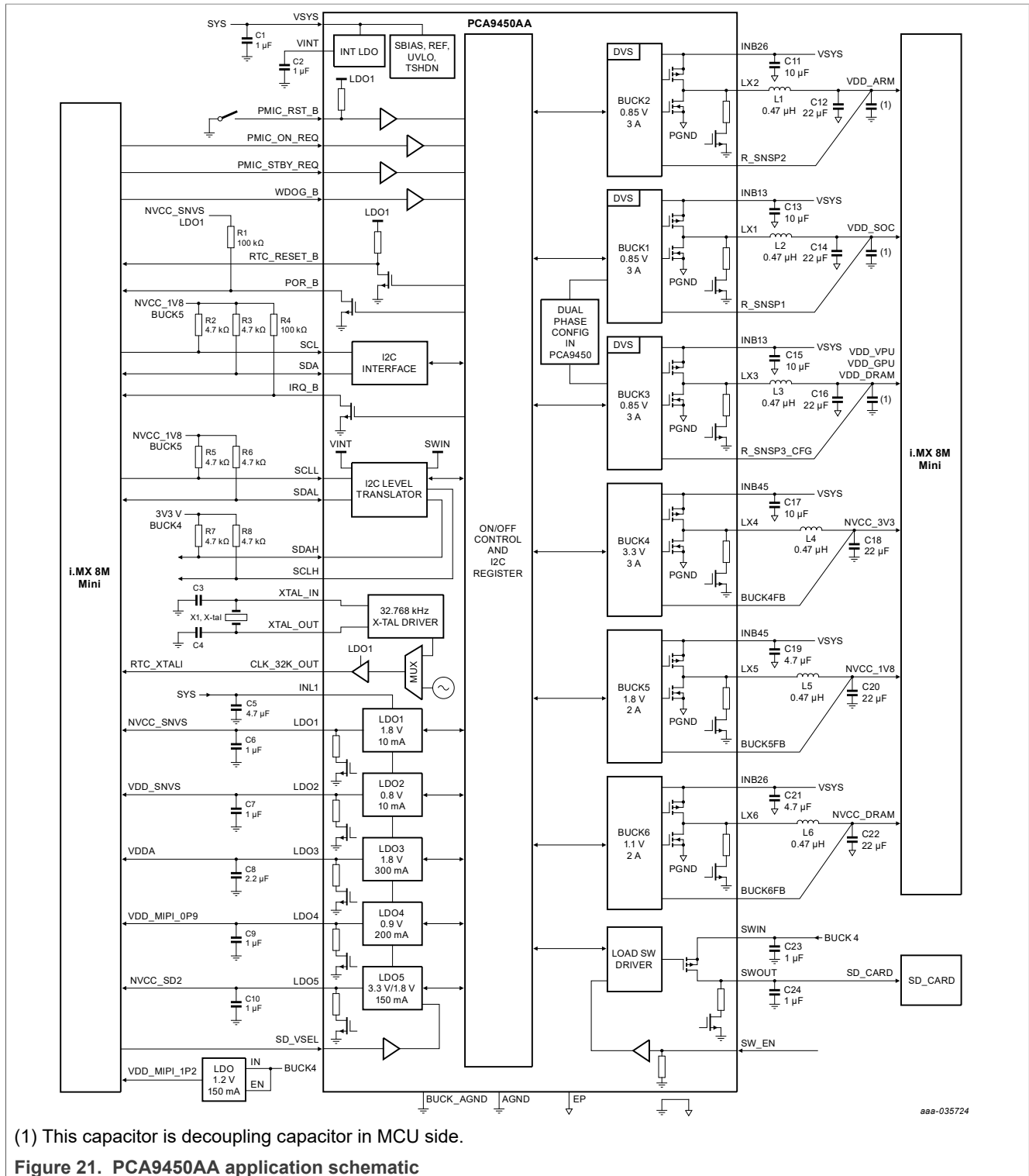
| 0x2E – VRFLT2_MASK | | | | Reset Type | S |
|--------------------|------------|------|-------|--|---|
| Bit | Name | Type | Reset | Description | |
| 2 | LDO3_FLT_M | R/W | 1 | LDO3 FLT mask 0b = Unmask 1b = Masked | |
| 1 | LDO2_FLT_M | R/W | 1 | LDO2 FLT mask 0b = Unmask 1b = Masked | |
| 0 | LDO1_FLT_M | R/W | 1 | LDO1 FLT mask 0b = Unmask 1b = Masked | |

9 Application design-in information

9.1 Reference schematic

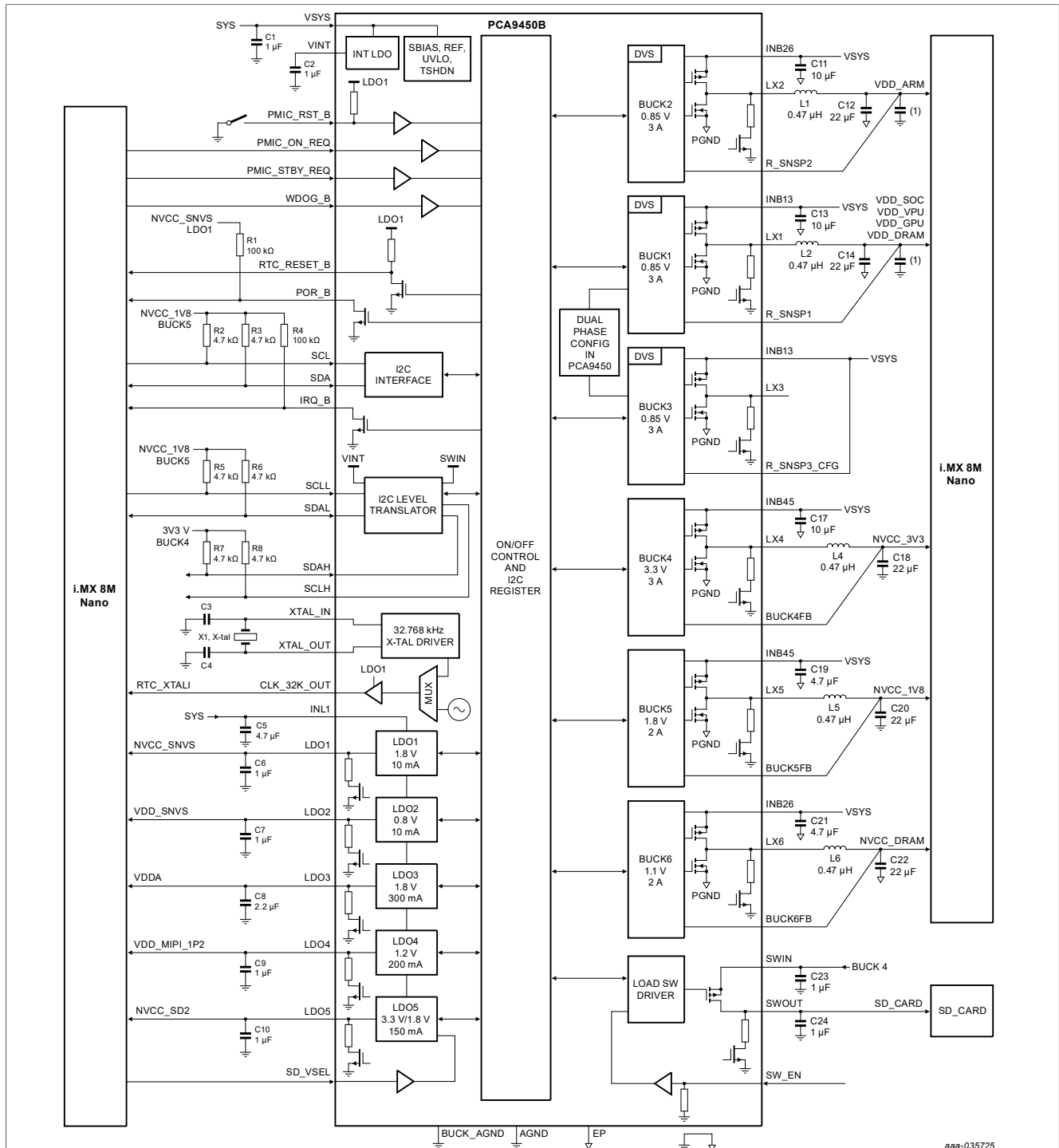
9.1.1 PCA9450AA reference schematic

PCA9450AA reference schematic with i.MX 8M Mini is illustrated in [Figure 21](#).



9.1.2 PCA9450B reference schematic

PCA9450B reference schematic with i.MX 8M Nano is illustrated in [Figure 22](#).

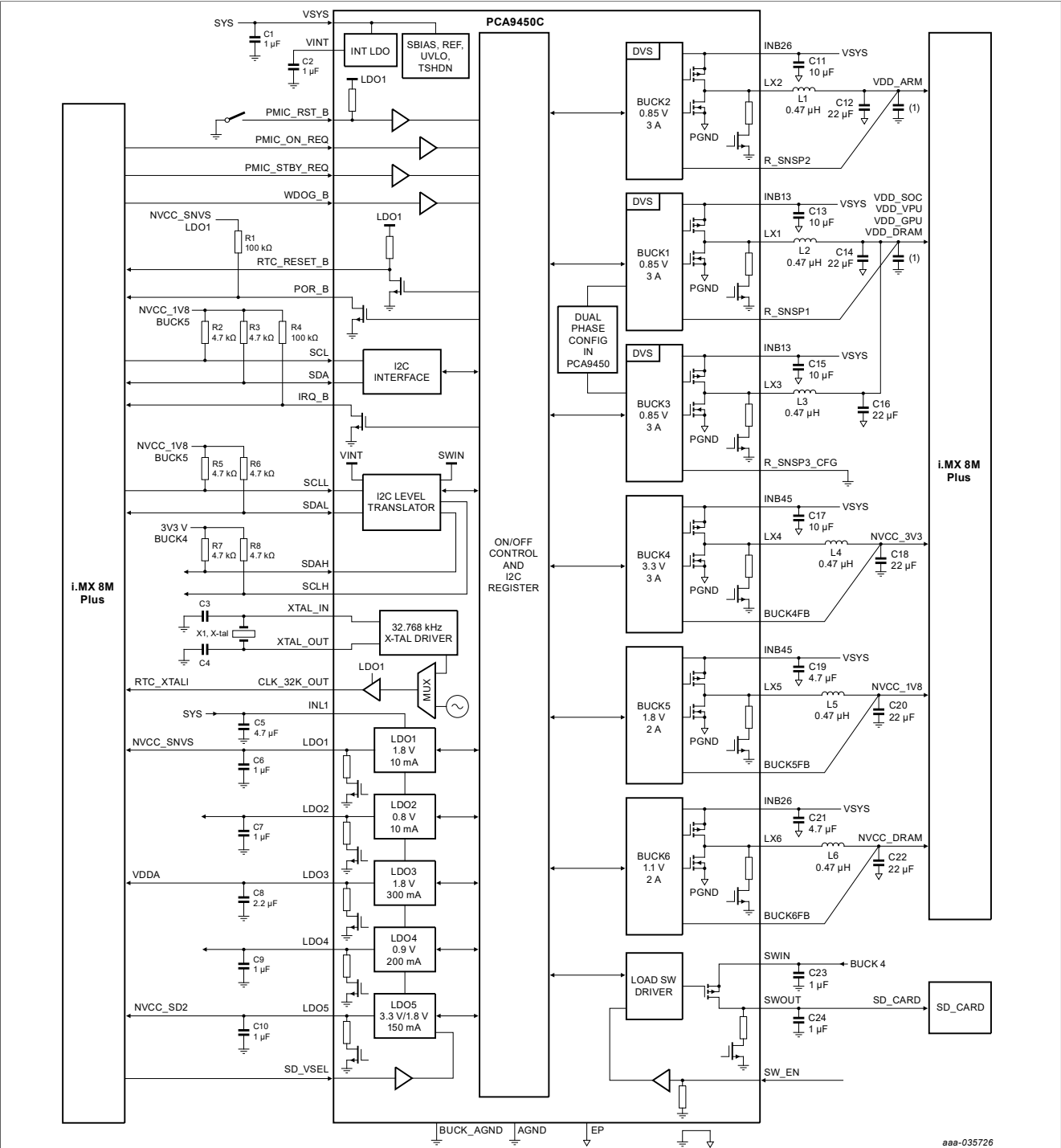


(1) This capacitor is decoupling capacitor in MCU side.

Figure 22. PCA9450B application schematic

9.1.3 PCA9450C reference schematic

PCA9450C reference schematic with i.MX 8M Plus is illustrated in [Figure 23](#)



(1) This capacitor is decoupling capacitor in MCU side.

Figure 23. PCA9450C application schematic

9.2 Typical application

Please follow the recommendations below for your schematic/PCB layout design:

- 1 μ F bypass capacitor on VINT and VSYS, located as close as possible to those pins to ground
- Input capacitors must be present on the INB and INL supplies if used
- Output inductors and capacitors must be used on the outputs of the BUCK converters if used
- Output capacitors must be used on the outputs of the LDOs

9.2.1 Buck regulators

9.2.1.1 Inductor selection for buck converters

Each of the converters on PCA9450 typically uses a 0.47 μ H output inductor which has to be rated for its DC resistance and saturation current. The DC resistance of the inductance influences directly the efficiency of the converter. Therefore, an inductor with lowest DC resistance must be selected for highest efficiency.

Equation 1 calculates the maximum inductor current under static load conditions. The saturation current of the inductor must be rated higher than the maximum inductor current as calculated with Equation 2. This is needed because during heavy load transient the inductor current rises above the calculated value.

| | |
|--|-----|
| $\Delta I_L = V_{out} \times \frac{1 - \frac{V_{out}}{V_{inmax}}}{L \times f}$ | (1) |
| $I_{Lmax} = I_{out,max} + \frac{\Delta I_L}{2}$ | (2) |

Where

- f = switching frequency (2 MHz)
- L = Inductance
- ΔI_L = Peak to peak inductor ripple current
- $I_{L,max}$ = Maximum inductor current

A conservative approach is to select the inductor current rating just for the maximum switch current of the PCA9450

[Table 69](#) shows possible inductors list.

Table 69. Tested inductor list

| Buck | Vendor | Part number | Size | DCR [m Ω] | Isat [A] | Itemp [A] |
|----------------------------|---------|-----------------|------|-------------------|----------|-----------|
| BUCK1, BUCK2, BUCK3, BUCK4 | Sunlord | WPN252012HR47MT | 2520 | 29 | 5.6 | 4.0 |
| | Murata | 1239AS-H-R47M | 2520 | 39 | 3.8 | 3.7 |
| BUCK5, BUCK6 | Sunlord | WPN201610UR47MT | 2016 | 28 | 5.0 | 4.1 |

Table 69. Tested inductor list...continued

| Buck | Vendor | Part number | Size | DCR [mΩ] | Isat [A] | Itemp [A] |
|------|--------|---------------|------|----------|----------|-----------|
| | Murata | 1286AS-H-R47M | 2016 | 52 | 3.4 | 3.2 |

9.2.1.2 Output capacitor selection for buck converters

The fast response adaptive constant ON time control scheme of the buck converters implemented on PCA9450 allows the use of a single typical 22 µF ceramic capacitor for each converter output without compromising on output overshoot/undershoot voltage ripple during heavy load transients. Ceramic capacitors having low ESR values have the lowest output voltage ripple and are recommended.

If ceramic output capacitors are used, the capacitor RMS ripple current rating always meets the application requirements. Just for completeness, the RMS ripple current is calculated in Equation 3.

$$I_{RMS.COUT} = V_{out} \times \frac{1 - \frac{V_{out}}{V_{in}}}{L \times f} \times \frac{1}{2\sqrt{3}} \quad (3)$$

At nominal load current, the inductive converters operate in PWM mode. The overall output voltage ripple is the sum of the voltage spike caused by the output capacitor ESR plus the voltage ripple caused by charging and discharging the output capacitor:

$$\Delta V_{out} = V_{out} \times \frac{1 - \frac{V_{out}}{V_{in}}}{L \times f} \times \left(\frac{1}{8 \times C_{out} \times f} + ESR \right) \quad (4)$$

Where

- The highest output voltage ripple occurs at the highest input voltage V_{in} .

At light load currents, the converters operate in PFM mode and the output voltage ripple is dependent on the output capacitor value. The output voltage ripple is set by the internal comparator delay and the external capacitor. The typical output voltage ripple is less than 1 % of the nominal output voltage.

9.2.1.3 Input capacitor selection for buck converters

Low ESR input capacitor is highly recommended for best input voltage filtering and minimizing the interference with other circuits caused by high input voltage spikes because of the nature of buck converter. Each DC-DC converter requires a 10 µF ceramic input capacitor on its input pins. The input capacitor could be increased without any limit for better input voltage filtering.

9.2.2 Crystal oscillator

9.2.2.1 Crystal selection

The most important parameters when choosing a crystal are:

- Crystal's required effective load capacitance (typically 6 pF to 15 pF)
- Crystal's ESR (typically 30 kΩ to 100 kΩ)
- Tolerance (typically 5 ppm to 30 ppm)

All of these crystal parameters can usually be found in the crystal datasheet.

9.2.2.2 Effective load capacitance

The crystal oscillator (see [Figure 24](#)) uses two load capacitors, C_{L1} and C_{L2} , as load for the crystal. These capacitors generate, together with the crystal's inductance, the required 180° phase shift of the feedback loop.

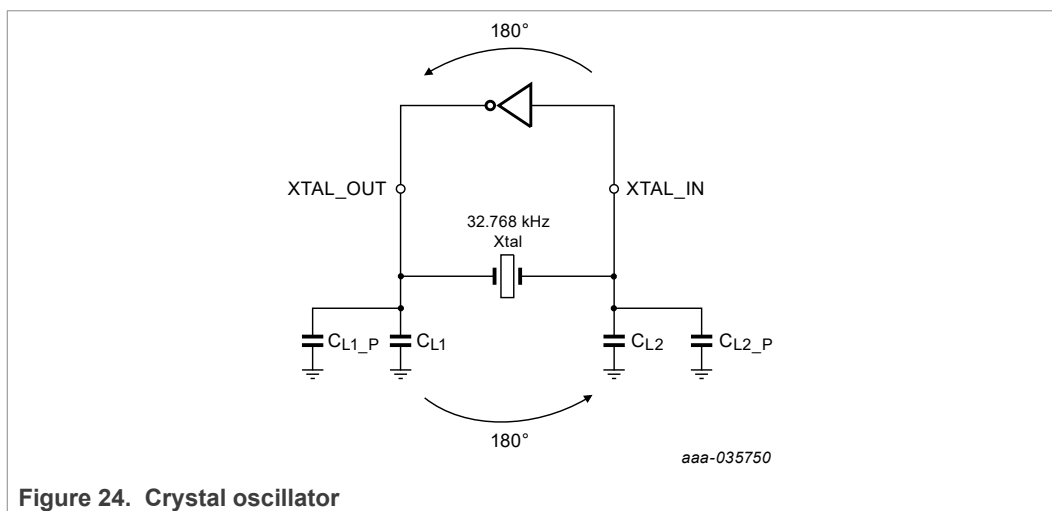


Figure 24. Crystal oscillator

From the view of the crystal, these capacitors are a serial connection through GND. Hence, if using two equal capacitors, the values of these capacitors must be twice the required load capacitance. It is also important to consider PCB parasitic capacitances for the calculation of the necessary capacitors according to Equation 5.

$$C_{LOAD} = \frac{C'_{L1} \times C'_{L2}}{C'_{L1} + C'_{L2}} \quad (5)$$

Where:

- $C'_{L1} = C_{L1} + C_{L1_P}$, C_{L1_P} is PCB parasitic capacitance.
- $C'_{L2} = C_{L2} + C_{L2_P}$, C_{L2_P} is PCB parasitic capacitance.

When using equal capacitors for C_{L1} and C_{L2} and a symmetric layout with equal parasitic capacitance on both crystal pins, the effective load capacitance is shown in Equation 6.

$$C_{LOAD} = (C_{L1} + C_{L1_P}) / 2 \quad (6)$$

Example:

Crystal requires 12 pF load.

Parasitic capacitance per pin is 2 pF.

$$C_{L1} = (2 \times C_{Load}) - C_{L1_P} = (2 \times 12 \text{ pF}) - 2 \text{ pF} = 22 \text{ pF}$$

$$C_{L2} = C_{L1} = 22 \text{ pF}$$

9.2.2.3 Frequency tuning

The crystal oscillator frequency is very much dependent on the load capacitance that is connected. Therefore, measuring the oscillator frequency gives a good indication if the load capacitors that are used match the crystal requirements. This measurement also automatically includes the parasitic PCB and pin capacitances of the application.

It is strongly recommended not to measure the oscillator frequency directly at the crystal pins. The capacitance at the crystal pins is in the range of 10 pF, and the impedance on this signal line is several megaohms. A typical passive probe has a capacitance in the range of 10 pF and an input impedance of approximately 10 MΩ. Both values are in the range of the oscillator characteristics and heavily influence the behavior of the crystal oscillators. Instead, it is recommended to measure frequency at CLK_32K_OUT pin.

Assuming the crystal itself has no tolerance, too low a capacitive load results in a higher oscillator frequency than expected and, vice versa, the frequency is lower than the nominal value, if the load is too high. Therefore, if the oscillation frequency is too high, the value of load capacitors must be increased. When too low frequency is measured, it is necessary to decrease the value of the load capacitors. Comparing the finally optimized capacitors with the crystal data sheet value for load capacitance gives the parasitic capacitance added by the PCB layout and pins.

9.3 Layout guide

Layout guide is shown in [Figure 25](#).

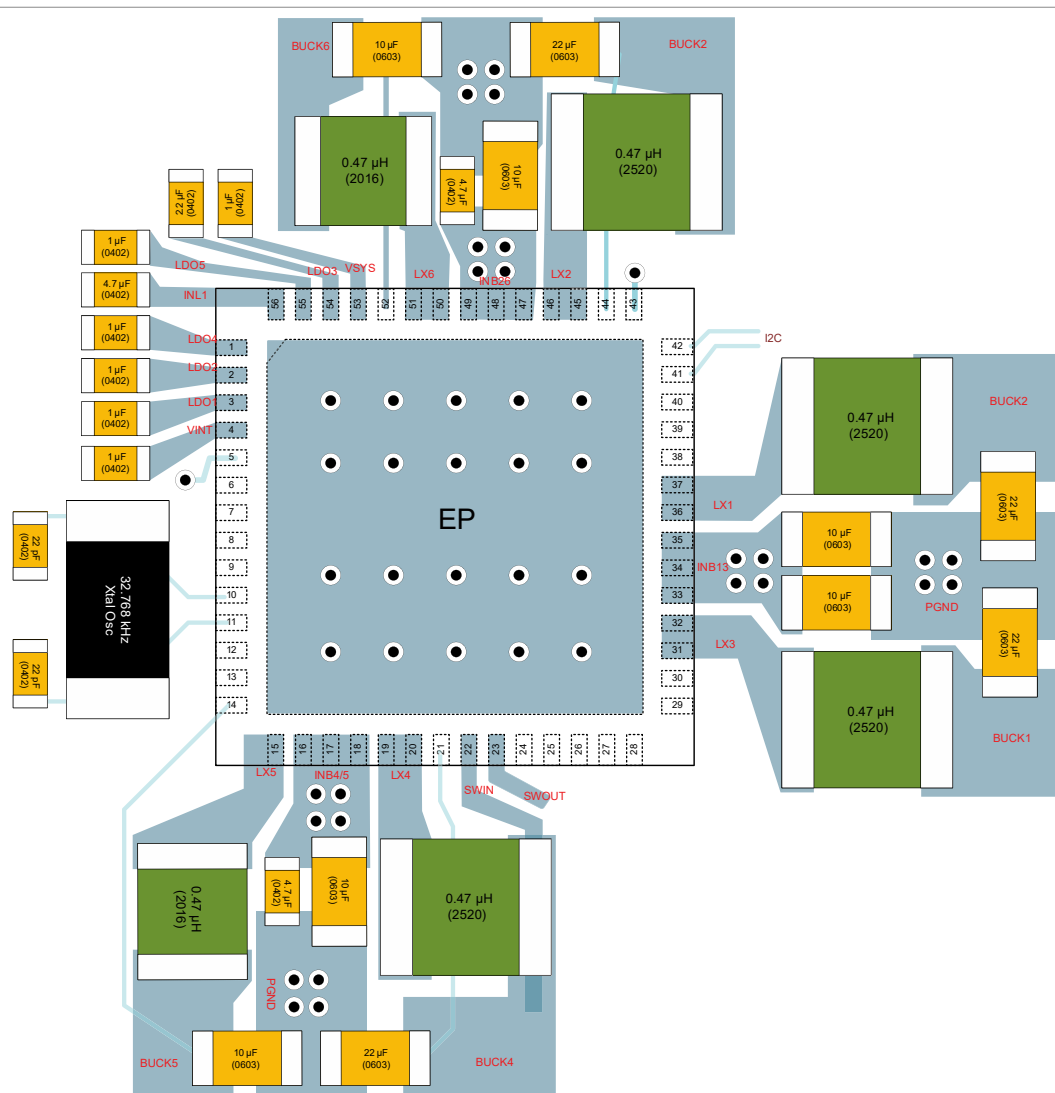


Figure 25. PCA9450 layout

aaa-035727

10 Limiting values

Table 70. Limiting values
(Absolute maximum ratings)

| Explanation | Pin | Conditions | Min | Max | Unit |
|---------------------------------------|---|--------------------|------|-------------------------|------|
| Voltage range (with respect to EP) | VSYS, INB13, INB26, INB45, INL1, SWIN | | -0.5 | +6.0 | V |
| | SWOUT | | -0.5 | SWIN + 0.5 | V |
| | LX1, LX3 | | -0.5 | INB13 + 0.5 | V |
| | LX2, LX6 | | -0.5 | INB26 + 0.5 | V |
| | LX4, LX5 | | -0.5 | INB45 + 0.5 | V |
| | R_SNSP1, R_SNSP2, R_SNSP3_CFG | | -0.5 | VSYS + 0.5 | V |
| | BUCK_AGND, AGND | | -0.5 | +0.5 | V |
| | BUCK4FB, BUCK5FB, BUCK6FB | | -0.5 | VSYS + 0.5 | V |
| | LDO1, LDO2, LDO3, LDO4, LDO5 | | -0.5 | V _{INL1} + 0.5 | V |
| | XTAL_IN, XTAL_OUT | | -0.5 | VSYS + 0.5 | V |
| | RTC_RESET_B, PMIC_RST_B, CLK_32K_OUT | | -0.5 | LDO1 + 0.5 | V |
| | PMIC_ON_REQ, POR_B PMIC_STBY_REQ, WDOG_B, IRQ_B, SCL, SDA, SD_VSEL, SW_EN | | -0.5 | VSYS + 0.5 | V |
| | SCLH, SDAH | | -0.5 | SWIN + 0.5 | V |
| | SCLL, SDAL | | -0.5 | VINT + 0.5 | V |
| | VINT | | -0.5 | +2.0 | V |
| Output Current | LX1, LX2, LX3, LX4 | RMS current | | 5.0 | A |
| | LX5, LX6 | RMS current | | 4.0 | A |
| | SWIN, SWOUT | RMS current | | 0.5 | A |
| Junction temperature | | | -40 | +150 | °C |
| V _{ESD} | All pins | HBM (JESD22-001) | -2 | +2 | kV |
| | | CDM (JESD22-C101E) | -500 | +500 | V |

11 Recommended operating conditions

Table 71. Recommended Operating Conditions

| Explanation | Pin | Conditions | Min | Max | Unit |
|------------------------------------|---------------------|------------|-----|------|------|
| Voltage range (with respect to EP) | VSYS, INL1 | | 2.7 | 5.5 | V |
| | INB13, INB26, INB45 | | 2.7 | 5.5 | V |
| | SWIN | | 2.7 | 5.5 | V |
| Junction temperature | | | -40 | +125 | °C |
| Ambient temperature | | | -40 | +105 | °C |

12 Thermal characteristics

Table 72. Thermal characteristics

| Symbol | Parameter | Conditions | | Typ | Unit |
|----------|---|------------|---------|------|------|
| Rth(j-a) | thermal resistance from junction to ambient | | [1] [2] | 32.1 | °C/W |

[1] Determined in accordance to JEDEC JESD51-2A natural convection environment. Thermal resistance data in this report is solely for a thermal performance comparison of one package to another in a standardized specified environment. It is not meant to predict the performance of a package in an application-specific environment

[2] Thermal test board meets JEDEC specification for this package (JESD51-9)

13 Electrical characteristics

13.1 Top level parameter

Table 73. Top level parameter

Unless otherwise specified, $V_{SYS} = 3.8\text{ V}$, $V_{INBx} = 3.8\text{ V}$, $V_{INL1} = 3.8\text{ V}$, $T_{amb} = -40\text{ °C} \sim +105\text{ °C}$

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|----------------------------------|---------------------------|--|------|-----|------|--------------------|
| Quiescent Current | | | | | | |
| I_{Q_SNVS} | VSYS SNVS Current | LDO1 and LDO2 are ON and no load, other regulators are OFF, CLK_32K_OUT enabled, PMIC_ON_REQ = L, $T_{amb} = 25\text{ °C}$ | | 23 | 50 | μA |
| | | LDO1 and LDO2 are ON and no load, other regulators are OFF, CLK_32K_OUT enabled, PMIC_ON_REQ = L, $T_{amb} = -40\text{ °C} \sim 105\text{ °C}$ | | 23 | 120 | μA |
| $I_{Q_STADNDBY}$ | VSYS Standby current | LDO1, LDO2, LDO3, LDO4, LDO5, BUCK1, BUCK3, BUCK4, BUCK5, BUCK6 are ON and no load. PMIC_ON_REQ = H, PMIC_STBY_REQ = H | | 220 | 350 | μA |
| VSYS | | | | | | |
| V_{SYS_UVLO} | VSYS UVLO | VSYS Rising | 2.85 | 3.0 | 3.15 | V |
| $V_{SYS_UVLO_H}$ | VSYS UVLO Hysteresis | VSYS Falling | | 200 | | mV |
| V_{SYS_POR} | VSYS POR | VSYS Rising | 2.2 | 2.4 | 2.6 | V |
| $V_{SYS_POR_H}$ | VSYS POR Hysteresis | VSYS Falling | | 200 | | mV |
| VINT | | | | | | |
| V_{INT} | Internal Power supply LDO | $V_{SYS} = 3.8\text{ V}$ | 1.7 | 1.8 | 1.9 | V |
| Low VSYS | | | | | | |
| V_{LOW_VSYS} | Low VSYS | Low VSYS threshold above V_{SYS_UVLO} , $LOW_VSYS [7:6] = 01b$ | 150 | 200 | 250 | mV |
| $V_{LOW_VSYS_HYS}$ | Low VSYS Hysteresis | | | 110 | | mV |
| Thermal Shutdown | | | | | | |
| T_{JSHDN} | Thermal Shutdown | T_j Rising, 15 °C hysteresis | | 150 | | $^{\circ}\text{C}$ |
| T_{J105} | Thermal interrupt1 | T_j Rising, 15 °C hysteresis | 95 | 105 | 125 | $^{\circ}\text{C}$ |
| T_{J125} | Thermal interrupt2 | T_j Rising, 15 °C hysteresis | 115 | 125 | 145 | $^{\circ}\text{C}$ |
| Logic and Control signals | | | | | | |
| V_{IL} | Input Low level | PMIC_ON_REQ, PMIC_STBY_REQ, WDOG_B, SD_VSEL, SW_EN, PMIC_RST_B | | | 0.4 | V |

Table 73. Top level parameter...continued

Unless otherwise specified, VSYS = 3.8 V, VINBx = 3.8 V, VINL1 = 3.8 V, T_{amb} = -40 °C ~ +105 °C

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|--|--|------|-----|------|------|
| V _{IH} | Input High level | PMIC_ON_REQ, PMIC_STBY_REQ, WDOG_B, SD_VSEL, SW_EN, PMIC_RST_B | 1.4 | | | V |
| I _{LEAK} | Logic Input leakage current | PMIC_ON_REQ, PMIC_STBY_REQ, WDOG_B, SD_VSEL: V _{Logic} = 5.5 V, VSYS = 5.5 V | -0.5 | | +0.5 | μA |
| R _{PD} | Internal Pull-down resistor | SW_EN | | 1.2 | | MΩ |
| V _{OL} | Output Low level | RTC_RESET_B, IRQB, POR_B, I _{OL} = 6 mA | | | 0.4 | V |
| R _{PU} | Internal Pull-up resistor | RTC_RESET_B, PMIC_RST_B to LDO1 | | 100 | | KΩ |
| Logic signal (PCA9450B/ PCA9450C) | | | | | | |
| V _{IL} | Input Low level | R_SNSP3_CFG | | | 0.4 | V |
| V _{IH} | Input High level | R_SNSP3_CFG | 1.4 | | | V |
| I _{LEAK} | Logic Input leakage current | R_SNSP3_CFG V _{Logic} = 5.5 V, VSYS = 5.5 V | -1 | | +1 | μA |
| Timing spec | | | | | | |
| t _{DEB_POKB} | Debounce time of regulator POKB | | 320 | 400 | 480 | μs |
| t _{DEB_POKB_SW} | Debounce time of Load SW POKB | | 240 | 300 | 360 | μs |
| t _{DEB_WDOGB} | Debounce time of WDOG_B | | 90 | 120 | 150 | μs |
| t _{DEB_PMIC_RST_B} | Debounce time of PMIC_RST_B | T_PMIC_RST_DEB[2:0] = 001b | 40 | 50 | 60 | ms |
| t _{SNVS_PU} | Time to 90 % of LDO1 from VSYS UVLO detected | | 16 | 20 | 24 | ms |
| t _{RTC_RST} | Time to RTC_RESET_B release from LDO2 POK | | 16 | 20 | 24 | ms |
| t _{32K_EN} | Time to 32K buffer enable from LDO2 POK | | 8 | 10 | 12 | ms |
| t _{RTC_TRAN} | Time to transition to Xtal osc after RTC_RESET_B release | | 0.8 | 1 | 1.2 | sec |
| t _{ON_DEB} | PMIC_ON_REQ high debounce time | Programmable, Ton_Deb[1:0] = 01b | 16 | 20 | 24 | ms |
| t _{STEP} | Time step to turn on each regulator | Programmable, Tstep[1:0] = 01b | 1.6 | 2 | 2.4 | ms |
| t _{OFF_STEP} | Time step to turn off each regulator | Programmable, Toff_step[1:0] = 10b | 6 | 8 | 10 | ms |

Table 73. Top level parameter...continued

Unless otherwise specified, $V_{SYS} = 3.8\text{ V}$, $V_{INBx} = 3.8\text{ V}$, $V_{INL1} = 3.8\text{ V}$, $T_{amb} = -40\text{ °C} \sim +105\text{ °C}$

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---------------------|---|---|-----|-----|-----|---------------|
| t_{OFF_DEB} | PMIC_ON_REQ low debounce time | Programmable, Toff_Deb = 0b | 90 | 120 | 150 | μs |
| t_{PORB} | Time from LDO5 POK to POR_B release during Power on seq | | 16 | 20 | 24 | ms |
| $t_{FLT_SD_PU}$ | Fault time to POK after regulator enable during power up sequence | At power up sequence | 8 | 10 | 12 | ms |
| $t_{FLT_POK_MSK}$ | POK mask time when regulator is enabled at RUN/Standby mode | | 1.6 | 2 | 2.4 | ms |
| t_{FLT_THSD} | Time to enter FAULT_SD when thermal Fault occurs | | 170 | 210 | 250 | μs |
| $t_{FLT_SD_STAY}$ | Time to stay at FAULT_SD to move other mode | | 80 | 100 | 120 | ms |
| $t_{FLT_SD_WAIT}$ | Wait time to enter FAULT_SD after fault interrupt | At Standby and Run mode, programmable, tFLT_SD_WAIT = 0b1 | 80 | 100 | 120 | ms |
| $t_{RESTART}$ | Wait time to start power up after power down at cold reset | Programmable, Trestart = 0b | 200 | 250 | 300 | ms |
| t_{WRESET} | POR_B low time at Warm reset | | 16 | 20 | 24 | ms |

13.2 I2C level translator

Table 74. I2C level translator

Unless otherwise specified, $V_{SYS} = 3.8\text{ V}$, $V_{INBx} = 3.8\text{ V}$, $V_{INL1} = 3.8\text{ V}$, $T_{amb} = -40\text{ }^{\circ}\text{C} \sim +105\text{ }^{\circ}\text{C}$

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|----------------------------------|-------------------------------|---|------------------------|-----|------|------|
| VDDH | Operating voltage | Internally tied to SWIN | 2.7 | | 5.5 | V |
| I _{VDDH} | Shutdown current | SWIN = 3.3 V, I2C_LT_EN bit = 0b | | 1 | 5 | μA |
| I _{VDDH} | Active current | SWIN = 3.3 V, I2C_LT_EN bit = 1b, SCLL, SDAL = 1.8 V | | 60 | 90 | μA |
| I _{VDDH} | Active current | SWIN = 3.3 V, I2C_LT_EN bit = 1b, SCLL, SDAL = 0 V | | 715 | 850 | μA |
| V _{IH} | High level input voltage | SWIN = 3.3 V, I2C_LT_EN bit = 1b | V _{INT} – 0.2 | | | V |
| V _{IL} | Low level input voltage | SWIN = 3.3 V, I2C_LT_EN bit = 1b | | | 0.15 | V |
| V _{OH} | High level output voltage | SWIN = 3.3 V, I2C_LT_EN bit = 1b, I _{OL} = 20 μA | 0.75 * SWIN | | | V |
| V _{OL} | Low level output voltage | SWIN = 3.3 V, I2C_LT_EN bit = 1b, I _{OL} = 1 mA | | | 0.4 | V |
| C _{I/O} ^[1] | Input Output capacitance | SWIN = 3.3 V | | 5 | | pF |
| t _{PHL} ^[1] | High to Low propagation delay | SWIN = 3.3 V, SCL/SDA to SCLH/SDAH | | 4.0 | 4.7 | ns |
| t _{PLH} ^[1] | Low to High propagation delay | SWIN = 3.3 V, SCL/SDA to SCLH/SDAH | | 5.0 | 6.8 | ns |
| t _{PHL} ^[1] | High to Low propagation delay | SWIN = 3.3 V, SCLH/SDAH to SCL/SDA | | 4.0 | 4.5 | ns |
| t _{PLH} ^[1] | Low to High propagation delay | SWIN = 3.3 V, SCLH/SDAH to SCL/SDA | | 4.0 | 4.5 | ns |
| t _{en} ^[1] | Enable time | SWIN = 3.3 V, from I2C enable | | 100 | | μs |
| f _{data} ^[1] | Data rate | | | | 20 | Mbps |

[1] Guaranteed by design

13.3 BUCK1 (PCA9450AA/PCA9450B)

Table 75. BUCK1 (PCA9450AA/PCA9450B)

Unless otherwise specified, $V_{SYS} = 3.8\text{ V}$, $V_{INBx} = 3.8\text{ V}$, $V_{INL1} = 3.8\text{ V}$, $V_{BUCK1} = 0.85\text{ V}$, $C_{OUT} = 22\text{ }\mu\text{F}$, $T_{amb} = -40\text{ }^{\circ}\text{C} \sim +105\text{ }^{\circ}\text{C}$

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|------------------------------------|--|------|------|--------|-------------------------|
| V_{INB13} | Input voltage range | INB13 pin | 2.85 | | 5.5 | V |
| $I_{Shutdown}$ | Shutdown current | Regulator disabled, $V_{INB13} = 5.0\text{ V}$ | | 0.1 | | μA |
| I_Q | Quiescent current | Regulator enabled, No load, No switching | | 20 | | μA |
| I_{OUT_MAX} | Max Output Current | | 3000 | | | mA |
| V_{BUCK1} | Programmable Output voltage range | I2C programmable, 12.5 mV step | 0.6 | | 2.1875 | V |
| V_{BUCK1_OUT} | DC Output Voltage Accuracy | $V_{INB13} = 3.8\text{ V}$, $V_{BUCK1_OUT} = 0.85\text{ V}$, $I_{OUT} = 0\text{ A}$, FPWM mode, $25\text{ }^{\circ}\text{C}$ | -0.6 | | +0.6 | % |
| | | $V_{INB13} = 3.8\text{ V}$, $V_{BUCK1_OUT} = 0.85\text{ V}$, $I_{OUT} = 0\text{ A}$, FPWM mode | -2 | | +2 | % |
| $\Delta V_{OUT(\Delta V_{INB})}^{[1]}$ | DC Line regulation | $V_{INB13} = 3\text{ V}$ to 5 V , $I_{OUT} = I_{OUT_MAX}$ | | 2 | | mV/V |
| $\Delta V_{OUT(\Delta I_{OUT})}^{[1]}$ | DC Load regulation | $0\text{ mA} < I_{OUT} < I_{OUT_MAX}$, $V_{BUCK1_OUT} = 0.85\text{ V}$ | | 3 | | mV/A |
| $\Delta V_{OUT(\Delta I_{OUT})}^{[1]}$ | Transient Load Response | I_{OUT} changes 0 to I_{OUT_MAX} ($1\text{ A}/\mu\text{s}$ slope), $V_{BUCK1_OUT} = 0.85\text{ V}$ | | 50 | | mV |
| $\Delta V_{OUT}^{[1]}$ | Output voltage Ripple | FPWM mode | | 10 | | mV |
| f_{SW} | Switching Frequency in CCM | | | 2 | | MHz |
| $R_{DS(on)}$ | High Side P-FET $R_{DS(on)}$ | $V_{INB13} = 3.8\text{ V}$, including bonding wire | | 87 | | $\text{m}\Omega$ |
| | Low Side N-FET $R_{DS(on)}$ | $V_{INB13} = 3.8\text{ V}$, including bonding wire | | 45 | | $\text{m}\Omega$ |
| I_{LIM} | High side current limit | $V_{INB13} = 3.8\text{ V}$ | 4.0 | 4.5 | 5.0 | A |
| | Low side current limit | $V_{INB13} = 3.8\text{ V}$ | 2.5 | 3.0 | 3.7 | A |
| $t_{START}^{[1]}$ | Startup time | EN rising to 90 % of output voltage | | 250 | 500 | μs |
| $V_{RAMP}^{[1]}$ | Output voltage slew rate | Programmable, $RAMP[1:0] = 01b$ | | 12.5 | | $\text{mV}/\mu\text{s}$ |
| $V_{soft_strup}^{[1]}$ | Soft-start slew rate | | | 12.5 | | $\text{mV}/\mu\text{s}$ |
| R_{DIS} | Output Active Discharge Resistance | | | 100 | 150 | Ω |
| POK | Output Power good | | | 85 | 95 | % |
| $L^{[1]}$ | Inductor value | | | 0.47 | | μH |
| $C_{OUT}^{[1]}$ | Output capacitance | Minimum nominal capacitance | 22 | | | μF |

[1] Guaranteed by design

13.4 Dual Phase BUCK1 (PCA9450C)

Table 76. Dual Phase BUCK1 (PCA9450C)

Unless otherwise specified, $V_{SYS} = 3.8\text{ V}$, $V_{INBx} = 3.8\text{ V}$, $V_{INL1} = 3.8\text{ V}$, $V_{BUCK1} = 0.85\text{ V}$, $C_{OUT} = 44\text{ }\mu\text{F}$, $T_{amb} = -40\text{ }^{\circ}\text{C} \sim +105\text{ }^{\circ}\text{C}$

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|------------------------------------|--|------|------|--------|-------------------|
| V_{INB13} | Input voltage range | INB13 pin | 2.85 | | 5.5 | V |
| $I_{Shutdown}$ | Shutdown current | Regulator disabled, $V_{INB13} = 5.0\text{ V}$ | | 0.2 | | μA |
| I_Q | Quiescent current | Regulator enabled, No load, No switching | | 20 | | μA |
| I_{OUT_MAX} | Max Output Current | | 6000 | | | mA |
| V_{BUCK1} | Programmable Output voltage range | I2C programmable, 12.5 mV step | 0.6 | | 2.1875 | V |
| V_{BUCK1_OUT} | DC Output Voltage Accuracy | $V_{INB13} = 3.8\text{ V}$, $V_{BUCK1_OUT} = 0.85\text{ V}$, $I_{OUT} = 0\text{ A}$, FPWM mode, $25\text{ }^{\circ}\text{C}$ | -0.6 | | +0.6 | % |
| | | $V_{INB13} = 3.8\text{ V}$, $V_{BUCK1_OUT} = 0.85\text{ V}$, $I_{OUT} = 0\text{ A}$, FPWM mode | -2 | | +2 | % |
| $\Delta V_{OUT(\Delta V_{INB})}^{[1]}$ | DC Line regulation | $V_{INB13} = 3\text{ V to }5\text{ V}$, $I_{OUT} = I_{OUT_MAX}$ | | 2 | | mV/V |
| $\Delta V_{OUT(\Delta I_{OUT})}^{[1]}$ | DC Load regulation | $0\text{ mA} < I_{OUT} < I_{OUT_MAX}$, $V_{BUCK1_OUT} = 0.85\text{ V}$ | | 3 | | mV/A |
| $\Delta V_{OUT(\Delta I_{OUT})}^{[1]}$ | Transient Load Response | I_{OUT} changes 0 to I_{OUT_MAX} (1 A/ μs slope), $V_{BUCK1_OUT} = 0.85\text{ V}$ | | 50 | | mV |
| $\Delta V_{OUT}^{[1]}$ | Output voltage Ripple | FPWM mode | | 10 | | mV |
| f_{SW} | Switching Frequency in CCM | | | 2 | | MHz |
| $R_{DS(on)}$ | High Side P-FET $R_{DS(on)}$ | $V_{INB13} = 3.8\text{ V}$, including bonding wire | | 87 | | m Ω |
| | Low Side N-FET $R_{DS(on)}$ | $V_{INB13} = 3.8\text{ V}$, including bonding wire | | 45 | | m Ω |
| I_{LIM} | High side current limit | $V_{INB13} = 3.8\text{ V}$, each phase | 4.0 | 4.5 | 5.0 | A |
| | Low side current limit | $V_{INB13} = 3.8\text{ V}$, each phase | 2.5 | 3.0 | 3.7 | A |
| $t_{START}^{[1]}$ | Startup time | EN rising to 90 % of output voltage | | 250 | 500 | μs |
| $V_{RAMP}^{[1]}$ | Output voltage slew rate | Programmable, RAMP[1:0] = 01b | | 12.5 | | mV/ μs |
| $V_{soft_strup}^{[1]}$ | Soft-start slew rate | | | 12.5 | | mV/ μs |
| POK | Output Power good | | 75 | 85 | 95 | % |
| R_{Dis} | Output Active Discharge Resistance | One phase buck | | 100 | 150 | Ω |
| $L^{[1]}$ | Inductor value | Each phase | | 0.47 | | μH |
| $C_{OUT}^{[1]}$ | Output capacitance | Minimum nominal capacitance | 44 | | | μF |

[1] Guaranteed by design

13.5 BUCK2

Table 77. BUCK2

Unless otherwise specified, $V_{SYS} = 3.8\text{ V}$, $V_{INBx} = 3.8\text{ V}$, $V_{INL1} = 3.8\text{ V}$, $V_{BUCK2} = 0.85\text{ V}$, $C_{OUT} = 22\text{ }\mu\text{F}$, $T_{amb} = -40\text{ }^{\circ}\text{C} \sim +105\text{ }^{\circ}\text{C}$

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|------------------------------------|--|------|------|--------|-------------------|
| V_{INB26} | Input voltage range | INB26 pin | 2.85 | | 5.5 | V |
| $I_{Shutdown}$ | Shutdown current | Regulator disabled, $V_{INB26} = 5.0\text{ V}$ | | 0.1 | | μA |
| I_Q | Quiescent current | Regulator enabled, No load, No switching | | 20 | | μA |
| I_{OUT_MAX} | Max Output Current | | 3000 | | | mA |
| V_{BUCK2} | Programmable Output voltage range | I2C programmable, 12.5 mV step | 0.6 | | 2.1875 | V |
| V_{BUCK2_OUT} | DC Output Voltage Accuracy | $V_{INB26} = 3.8\text{ V}$, $V_{BUCK2_OUT} = 0.85\text{ V}$, $I_{OUT} = 0\text{ A}$, FPWM mode, $25\text{ }^{\circ}\text{C}$ | -0.6 | | +0.6 | % |
| | | $V_{INB26} = 3.8\text{ V}$, $V_{BUCK2_OUT} = 0.85\text{ V}$, $I_{OUT} = 0\text{ A}$, FPWM mode | -2 | | +2 | % |
| $\Delta V_{OUT(\Delta V_{INB})}^{[1]}$ | DC Line regulation | $V_{INB26} = 3\text{ V to }5\text{ V}$, $I_{OUT} = I_{OUT_MAX}$ | | 2 | | mV/V |
| $\Delta V_{OUT(\Delta I_{OUT})}^{[1]}$ | DC Load regulation | $0\text{ mA} < I_{OUT} < I_{OUT_MAX}$, $V_{BUCK2_OUT} = 0.85\text{ V}$ | | 3 | | mV/A |
| $\Delta V_{OUT(\Delta I_{OUT})}^{[1]}$ | Transient Load Response | I_{OUT} changes 0 to I_{OUT_MAX} (1 A/ μs slope), $V_{BUCK2_OUT} = 0.85\text{ V}$ | | 50 | | mV |
| $\Delta V_{OUT}^{[1]}$ | Output voltage Ripple | FPWM mode | | 10 | | mV |
| f_{sw} | Switching Frequency in CCM | | | 2 | | MHz |
| $R_{DS(on)}$ | High Side P-FET $R_{DS(on)}$ | $V_{INB26} = 3.8\text{ V}$, including bonding wire | | 87 | | m Ω |
| | Low Side N-FET $R_{DS(on)}$ | $V_{INB26} = 3.8\text{ V}$, including bonding wire | | 45 | | m Ω |
| I_{LIM} | High side current limit | $V_{INB26} = 3.8\text{ V}$ | 4.0 | 4.5 | 5.0 | A |
| | Low side current limit | $V_{INB26} = 3.8\text{ V}$ | 2.5 | 3.0 | 3.7 | A |
| $t_{START}^{[1]}$ | Startup time | EN rising to 90 % of output voltage | | 250 | 500 | μs |
| $V_{RAMP}^{[1]}$ | Output voltage slew rate | Programmable, RAMP[1:0] = 01b | | 12.5 | | mV/ μs |
| $V_{soft_strup}^{[1]}$ | Soft-start slew rate | | | 12.5 | | mV/ μs |
| POK | Output Power good | | 75 | 85 | 95 | % |
| R_{DIS} | Output Active Discharge Resistance | | | 100 | 150 | Ω |
| $L^{[1]}$ | Inductor value | | | 0.47 | | μH |
| $C_{OUT}^{[1]}$ | Output capacitance | Minimum nominal capacitance | 22 | | | μF |

[1] Guaranteed by design

13.6 BUCK3 (PCA9450AA)

Table 78. BUCK3 (PCA9450AA)

Unless otherwise specified, $V_{SYS} = 3.8\text{ V}$, $V_{INBx} = 3.8\text{ V}$, $V_{INL1} = 3.8\text{ V}$, $V_{BUCK3} = 0.85\text{ V}$, $C_{OUT} = 22\text{ }\mu\text{F}$, $T_{amb} = -40\text{ }^{\circ}\text{C} \sim +105\text{ }^{\circ}\text{C}$

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|------------------------------------|--|------|------|--------|-------------------|
| V_{INB13} | Input voltage range | INB13 pin | 2.85 | | 5.5 | V |
| $I_{Shutdown}$ | Shutdown current | Regulator disabled, $V_{INB13} = 5.0\text{ V}$ | | 0.1 | | μA |
| I_Q | Quiescent current | Regulator enabled, No load, No switching | | 20 | | μA |
| I_{OUT_MAX} | Max Output Current | | 3000 | | | mA |
| V_{BUCK3} | Programmable Output voltage range | I2C programmable, 12.5 mV step | 0.6 | | 2.1875 | V |
| V_{BUCK3_OUT} | DC Output Voltage Accuracy | $V_{INB13} = 3.8\text{ V}$, $V_{BUCK3_OUT} = 0.85\text{ V}$, $I_{OUT} = 0\text{ A}$, FPWM mode, $25\text{ }^{\circ}\text{C}$ | -0.6 | | +0.6 | % |
| | | $V_{INB13} = 3.8\text{ V}$, $V_{BUCK3_OUT} = 0.85\text{ V}$, $I_{OUT} = 0\text{ A}$, FPWM mode | -2 | | +2 | % |
| $\Delta V_{OUT(\Delta V_{INB})}^{[1]}$ | DC Line regulation | $V_{INB13} = 3\text{ V to }5\text{ V}$, $I_{OUT} = I_{OUT_MAX}$ | | 2 | | mV/V |
| $\Delta V_{OUT(\Delta I_{OUT})}^{[1]}$ | DC Load regulation | $0\text{ mA} < I_{OUT} < I_{OUT_MAX}$, $V_{BUCK3_OUT} = 0.85\text{ V}$ | | 3 | | mV/A |
| $\Delta V_{OUT(\Delta I_{OUT})}^{[1]}$ | Transient Load Response | I_{OUT} changes 0 to I_{OUT_MAX} (1 A/ μs slope), $V_{BUCK3_OUT} = 0.85\text{ V}$ | | 50 | | mV |
| $\Delta V_{OUT}^{[1]}$ | Output voltage Ripple | FPWM mode | | 10 | | mV |
| f_{SW} | Switching Frequency in CCM | | | 2 | | MHz |
| $R_{DS(on)}$ | High Side P-FET $R_{DS(on)}$ | $V_{INB13} = 3.8\text{ V}$, including bonding wire | | 87 | | m Ω |
| | Low Side N-FET $R_{DS(on)}$ | $V_{INB13} = 3.8\text{ V}$, including bonding wire | | 45 | | m Ω |
| I_{LIM} | High side current limit | $V_{INB13} = 3.8\text{ V}$ | 4.0 | 4.5 | 5.0 | A |
| | Low side current limit | $V_{INB13} = 3.8\text{ V}$ | 2.5 | 3.0 | 3.7 | A |
| $t_{START}^{[1]}$ | Startup time | EN rising to 90 % of output voltage | | 250 | 500 | μs |
| $V_{RAMP}^{[1]}$ | Output voltage slew rate | Programmable, RAMP[1:0] = 01b | | 12.5 | | mV/ μs |
| $V_{soft_strup}^{[1]}$ | Soft-start slew rate | | | 12.5 | | mV/ μs |
| POK | Output Power good | | 75 | 85 | 95 | % |
| R_{DIS} | Output Active Discharge Resistance | | | 100 | 150 | Ω |
| $L^{[1]}$ | Inductor value | | | 0.47 | | μH |
| $C_{OUT}^{[1]}$ | Output capacitance | Minimum nominal capacitance | 22 | | | μF |

[1] Guaranteed by design

13.7 BUCK4

Table 79. BUCK4

Unless otherwise specified, $V_{SYS} = 3.8\text{ V}$, $V_{INBx} = 3.8\text{ V}$, $V_{INL1} = 3.8\text{ V}$, $V_{BUCK4} = 3.3\text{ V}$, $C_{OUT} = 22\text{ }\mu\text{F}$, $T_{amb} = -40\text{ }^{\circ}\text{C} \sim +105\text{ }^{\circ}\text{C}$

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|------------------------------------|---|------|------|------|-------------------|
| V_{INB45} | Input voltage range | INB45 pin | 2.85 | | 5.5 | V |
| $I_{Shutdown}$ | Shutdown current | Regulator disabled, $V_{INB45} = 5.0\text{ V}$ | | 0.1 | | μA |
| I_Q | Quiescent current | Regulator enabled, No load, No switching | | 20 | | μA |
| I_{OUT_MAX} | Max Output Current | | 3000 | | | mA |
| V_{BUCK4} | Programmable Output voltage range | I2C programmable, 25 mV step | 0.6 | | 3.4 | V |
| V_{BUCK4_OUT} | DC Output Voltage Accuracy | $V_{INB45} = 3.8\text{ V}$, $V_{BUCK4_OUT} = 3.3\text{ V}$, $I_{OUT} = 0\text{ A}$, FPWM mode, $25\text{ }^{\circ}\text{C}$ | -0.5 | | +0.5 | % |
| | | $V_{INB45} = 3.8\text{ V}$, $V_{BUCK4_OUT} = 3.3\text{ V}$, $I_{OUT} = 0\text{ A}$, FPWM mode | -2 | | +2 | % |
| $\Delta V_{OUT(\Delta V_{INB})}^{[1]}$ | DC Line regulation | $V_{INB45} = 4\text{ V to } 5\text{ V}$, $I_{OUT} = I_{OUT_MAX}$ | | 2 | | mV/V |
| $\Delta V_{OUT(\Delta I_{OUT})}^{[1]}$ | DC Load regulation | $0\text{ mA} < I_{OUT} < I_{OUT_MAX}$, $V_{BUCK4_OUT} = 3.3\text{ V}$ | | 6 | | mV/A |
| $\Delta V_{OUT(\Delta I_{OUT})}^{[1]}$ | Transient Load Response | I_{OUT} changes 0 to I_{OUT_MAX} ($1\text{ A}/\mu\text{s}$ slope), $V_{BUCK4_OUT} = 3.3\text{ V}$ | | 160 | | mV |
| $\Delta V_{OUT}^{[1]}$ | Output voltage Ripple | FPWM mode | | 10 | | mV |
| f_{SW} | Switching Frequency in CCM | | | 2 | | MHz |
| $R_{DS(on)}$ | High Side P-FET $R_{DS(on)}$ | $V_{INB45} = 3.8\text{ V}$, including bonding wire | | 87 | | m Ω |
| | Low Side N-FET $R_{DS(on)}$ | $V_{INB45} = 3.8\text{ V}$, including bonding wire | | 45 | | m Ω |
| I_{LIM} | High side current limit | $V_{INB45} = 3.8\text{ V}$ | 4.0 | 4.5 | 5.0 | A |
| | Low side current limit | $V_{INB45} = 3.8\text{ V}$ | 2.5 | 3.0 | 3.7 | A |
| $t_{START}^{[1]}$ | Startup time | EN rising to 90 % of output voltage | | 250 | 500 | μs |
| $V_{soft_strup}^{[1]}$ | Soft-start slew rate | | | 12.5 | | mV/ μs |
| POK | Output Power good | | 75 | 85 | 95 | % |
| R_{DIS} | Output Active Discharge Resistance | | | 100 | 150 | Ω |
| $L^{[1]}$ | Inductor value | | | 0.47 | | μH |
| $C_{OUT}^{[1]}$ | Output capacitance | Minimum nominal capacitance | 22 | | | μF |

[1] Guaranteed by design

13.8 BUCK5

Table 80. BUCK5

Unless otherwise specified, $V_{SYS} = 3.8\text{ V}$, $V_{INBx} = 3.8\text{ V}$, $V_{INL1} = 3.8\text{ V}$, $V_{BUCK5} = 1.8\text{ V}$, $C_{OUT} = 22\text{ }\mu\text{F}$, $T_{amb} = -40\text{ }^{\circ}\text{C} \sim +105\text{ }^{\circ}\text{C}$

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|------------------------------------|---|------|------|------|-------------------|
| V_{INB45} | Input voltage range | INB45 pin | 2.85 | | 5.5 | V |
| $I_{Shutdown}$ | Shutdown current | Regulator disabled, $V_{INB45} = 5.0\text{ V}$ | | 0.1 | | μA |
| I_Q | Quiescent current | Regulator enabled, No load, No switching | | 20 | | μA |
| I_{OUT_MAX} | Max Output Current | | 2000 | | | mA |
| V_{BUCK5} | Programmable Output voltage range | I2C programmable, 25 mV step | 0.6 | | 3.4 | V |
| V_{BUCK5_OUT} | DC Output Voltage Accuracy | $V_{INB45} = 3.8\text{ V}$, $V_{BUCK5_OUT} = 1.8\text{ V}$, $I_{OUT} = 0\text{ A}$, FPWM mode, $25\text{ }^{\circ}\text{C}$ | -0.5 | | +0.5 | % |
| | | $V_{INB45} = 3.8\text{ V}$, $V_{BUCK5_OUT} = 1.8\text{ V}$, $I_{OUT} = 0\text{ A}$, FPWM mode | -2 | | +2 | % |
| $\Delta V_{OUT(\Delta V_{INB})}^{[1]}$ | DC Line regulation | $V_{INB45} = 3\text{ V to }5\text{ V}$, $I_{OUT} = I_{OUT_MAX}$ | | 2 | | mV/V |
| $\Delta V_{OUT(\Delta I_{OUT})}^{[1]}$ | DC Load regulation | $0\text{ mA} < I_{OUT} < I_{OUT_MAX}$, $V_{BUCK5_OUT} = 1.8\text{ V}$ | | 7 | | mV/A |
| $\Delta V_{OUT(\Delta I_{OUT})}^{[1]}$ | Transient Load Response | I_{OUT} changes 0 to I_{OUT_MAX} (1 A/ μs slope), $V_{BUCK5_OUT} = 1.8\text{ V}$ | | 50 | | mV |
| $\Delta V_{OUT}^{[1]}$ | Output voltage Ripple | FPWM mode | | 22 | | mV |
| f_{SW} | Switching Frequency in CCM | | | 2 | | MHz |
| $R_{DS(on)}$ | High Side P-FET $R_{DS(on)}$ | $V_{INB45} = 3.8\text{ V}$, including bonding wire | | 130 | | m Ω |
| | Low Side N-FET $R_{DS(on)}$ | $V_{INB45} = 3.8\text{ V}$, including bonding wire | | 70 | | m Ω |
| I_{LIM} | High side current limit | $V_{INB45} = 3.8\text{ V}$ | 3.0 | 3.5 | 4.0 | A |
| | Low side current limit | $V_{INB45} = 3.8\text{ V}$ | 1.5 | 2 | 2.7 | A |
| $t_{START}^{[1]}$ | Startup time | EN rising to 90 % of output voltage | | 250 | 500 | μs |
| $V_{soft_strup}^{[1]}$ | Soft-start slew rate | | | 12.5 | | mV/ μs |
| POK | Output Power good | | 75 | 85 | 95 | % |
| R_{DIS} | Output Active Discharge Resistance | | | 100 | 150 | Ω |
| $L^{[1]}$ | Inductor value | | | 0.47 | | μH |
| $C_{OUT}^{[1]}$ | Output capacitance | Minimum nominal capacitance | 22 | | | μF |

[1] Guaranteed by design

13.9 BUCK6

Table 81. BUCK6

Unless otherwise specified, $V_{SYS} = 3.8\text{ V}$, $V_{INBx} = 3.8\text{ V}$, $V_{INL1} = 3.8\text{ V}$, $V_{BUCK6} = 1.1\text{ V}$, $C_{OUT} = 22\text{ }\mu\text{F}$, $T_{amb} = -40\text{ }^{\circ}\text{C}$ to $+105\text{ }^{\circ}\text{C}$

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|------------------------------------|---|------|------|------|-------------------|
| V_{INB26} | Input voltage range | INB26 pin | 2.85 | | 5.5 | V |
| $I_{Shutdown}$ | Shutdown current | Regulator disabled, $V_{INB26} = 5.0\text{ V}$ | | 0.1 | | μA |
| I_Q | Quiescent current | Regulator enabled, No load, No switching | | 20 | | μA |
| I_{OUT_MAX} | Max Output Current | | 2000 | | | mA |
| V_{BUCK6} | Programmable Output voltage range | I2C programmable, 25 mV step | 0.6 | | 3.4 | V |
| V_{BUCK6_OUT} | DC Output Voltage Accuracy | $V_{INB26} = 3.8\text{ V}$, $V_{BUCK6_OUT} = 1.1\text{ V}$, $I_{OUT} = 0\text{ A}$, FPWM mode, $25\text{ }^{\circ}\text{C}$ | -0.8 | | +0.8 | % |
| | | $V_{INB26} = 3.8\text{ V}$, $V_{BUCK6_OUT} = 1.1\text{ V}$, $I_{OUT} = 0\text{ A}$, FPWM mode | -2 | | +2 | % |
| $\Delta V_{OUT(\Delta V_{INB})}^{[1]}$ | DC Line regulation | $V_{INB26} = 3\text{ V}$ to 5 V , $I_{OUT} = I_{OUT_MAX}$ | | 2 | | mV/V |
| $\Delta V_{OUT(\Delta I_{OUT})}^{[1]}$ | DC Load regulation | $0\text{ mA} < I_{OUT} < I_{OUT_MAX}$, $V_{BUCK6_OUT} = 1.1\text{ V}$ | | 6 | | mV/A |
| $\Delta V_{OUT(\Delta I_{OUT})}^{[1]}$ | Transient Load Response | I_{OUT} changes 0 to I_{OUT_MAX} (1 A/ μs slope), $V_{BUCK6_OUT} = 1.1\text{ V}$ | | 50 | | mV |
| $\Delta V_{OUT}^{[1]}$ | Output voltage Ripple | FPWM mode | | 18 | | mV |
| f_{SW} | Switching Frequency in CCM | | | 2 | | MHz |
| $R_{DS(on)}$ | High Side P-FET $R_{DS(on)}$ | $V_{INB26} = 3.8\text{ V}$, including bonding wire | | 130 | | m Ω |
| | Low Side N-FET $R_{DS(on)}$ | $V_{INB26} = 3.8\text{ V}$, including bonding wire | | 70 | | m Ω |
| I_{LIM} | High side current limit | $V_{INB26} = 3.8\text{ V}$ | 3.0 | 3.5 | 4.0 | A |
| | Low side current limit | $V_{INB26} = 3.8\text{ V}$ | 1.5 | 2 | 2.7 | A |
| $t_{START}^{[1]}$ | Startup time | EN rising to 90 % of output voltage | | 250 | 500 | μs |
| $V_{soft_strup}^{[1]}$ | Soft-start slew rate | | | 12.5 | | mV/ μs |
| POK | Output Power good | | 75 | 85 | 95 | % |
| R_{DIS} | Output Active Discharge Resistance | | | 100 | 150 | Ω |
| $L^{[1]}$ | Inductor value | | | 0.47 | | μH |
| $C_{OUT}^{[1]}$ | Output capacitance | Minimum nominal capacitance | 22 | | | μF |

[1] Guaranteed by design

13.10 LDO1

Table 82. LDO1

Unless otherwise specified, $V_{SYS} = 3.8\text{ V}$, $V_{INBx} = 3.8\text{ V}$, $V_{INL1} = 3.8\text{ V}$, $V_{LDO1} = 1.8\text{ V}$, $C_{INL1} = 4.7\text{ }\mu\text{F}$, $C_{OUT} = 1\text{ }\mu\text{F}$, $T_{amb} = -40\text{ }^{\circ}\text{C} \sim +105\text{ }^{\circ}\text{C}$

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------------------------------|------------------------------|---|------|-----|-----|-------------------|
| V_{IN} | Input voltage range | INL1 pin | 2.85 | | 5.5 | V |
| I_Q | Quiescent current | Regulator enabled, No load | | 2 | | μA |
| I_{OUT_MAX} | Maximum Output DC Current | $V_{IN} > 2.85\text{ V}$, $V_{LDO1} = 1.8\text{ V}$ | 10 | | | mA |
| I_{LIMIT} | Short Current Limit | Output shorted to GND | 30 | | 60 | mA |
| V_{DO} | Dropout Voltage | $I_{OUT} = I_{OUT_MAX}$, $V_{IN} = 3.2\text{ V}$, $L1_OUT[2:0] = 0x7$, 3.3 V | | 35 | 60 | mV |
| V_{LDO1} | Nominal output voltage | I ² C Programmable, 100 mV step | 1.6 | | 3.3 | V |
| | Default voltage | | | 1.8 | | V |
| | DC accuracy | $V_{LDO1} = 1.8\text{ V}$, $I_{Load} = 5\text{ mA}$ | -3 | | 3 | % |
| $V_{NOISE}^{[1]}$ | Output noise | $f = 10\text{ Hz to } 10\text{ kHz}$, $I_{OUT} = 10\%$ of I_{MAX} , $V_{LDO1} = 1.8\text{ V}$ | | 400 | | μV |
| $\Delta V_{OUT(\Delta VINL)}$ | DC Line regulation | $V_{LDO1} + 0.3\text{ V} < V_{IN} < 5.5\text{ V}$, $I_{OUT(LDO1)} = 10\%$ of I_{OUT_MAX} | | 0.2 | 0.5 | %/V |
| $\Delta V_{OUT(\Delta IOUT)}$ | DC Load regulation | $V_{IN} = V_{LDO1} + 0.3\text{ V to } 5.5\text{ V}$, $0\text{ mA} < I_{OUT} < I_{OUT_MAX}$ | | 0.5 | 1 | % |
| $\Delta V_{OUT(\Delta VINL)}^{[1]}$ | Transient Line Response | $V_{LDO1} + 0.3\text{ V} < V_{IN} < 5.5\text{ V}$, $I_{OUT(LDO1)} = 10\%$ of I_{OUT_MAX} , $t_r = 10\text{ }\mu\text{s}$ | | 0.5 | | %/V |
| $\Delta V_{OUT(\Delta IOUT)}^{[1]}$ | Transient Load Response | $V_{IN} = V_{LDO1} + 0.3\text{ V to } 5.5\text{ V}$, $1\text{ mA} < I_{OUT} < I_{OUT_MAX}$, $t_r = 10\text{ }\mu\text{s}$, $V_{LDO1} = 1.8\text{ V}$ | -3 | | 3 | % |
| $PSRR^{[1]}$ | Power Supply Rejection ratio | $f = 10\text{ Hz to } 10\text{ kHz}$, $I_{OUT} = 10\%$ of I_{OUT_MAX} | | 45 | | dB |
| $V_{soft_strup}^{[1]}$ | Soft-start slew rate | $I_{OUT} = 0\text{ mA}$, 10 % to 90 % of V_{LDO1} | | 15 | | mV/ μs |
| $V_{ov_srup}^{[1]}$ | Overshoot at startup | $I_{OUT} = 0\text{ mA}$ | | | 10 | mV |
| $t_{EN}^{[1]}$ | Enable time | EN rising to 90 % of output voltage | | 150 | | μs |
| POK | Output Power good | Percentage of V_{LDO1} configuration | 75 | 85 | 92 | % |
| R_{DIS} | Active Discharge Resistance | | | 100 | 150 | Ω |
| $C_{OUT}^{[1]}$ | Output capacitance | Minimum nominal capacitance | 1 | | | μF |

[1] Guaranteed by design

13.11 LDO2

Table 83. LDO2

Unless otherwise specified, $V_{SYS} = 3.8\text{ V}$, $V_{INBx} = 3.8\text{ V}$, $V_{INL1} = 3.8\text{ V}$, $V_{LDO2} = 0.85\text{ V}$, $C_{INL1} = 4.7\text{ }\mu\text{F}$, $C_{OUT} = 1\text{ }\mu\text{F}$, $T_{amb} = -40\text{ }^{\circ}\text{C} \sim +105\text{ }^{\circ}\text{C}$

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------------------------------|------------------------------|---|------|------|-----|-------------------|
| V_{IN} | Input voltage range | INL1 pin | 2.85 | | 5.5 | V |
| I_Q | Quiescent current | Regulator enabled, No load | | 2 | | μA |
| I_{OUT_MAX} | Maximum Output DC Current | $V_{IN} > 2.8\text{ V}$, $V_{LDO2} = 0.8\text{ V}$ | 10 | | | mA |
| I_{LIMIT} | Short Current Limit | Output shorted to GND | 30 | | 60 | mA |
| V_{DO} | Dropout Voltage | $I_{OUT} = I_{OUT_MAX}$ | | 35 | 60 | mV |
| V_{LDO2} | Nominal output voltage | I ² C Programmable, 50 mV step | 0.8 | | 1.5 | V |
| | Default voltage | | | 0.85 | | V |
| | DC accuracy | $V_{LDO2} = 0.8\text{ V}$, $I_{Load} = 5\text{ mA}$ | -3 | | 3 | % |
| $V_{NOISE}^{[1]}$ | Output noise | $f = 10\text{ Hz to } 10\text{ kHz}$, $I_{OUT} = 10\text{ % of } I_{MAX}$, $V_{LDO2} = 0.8\text{ V}$ | | 400 | | μV |
| $\Delta V_{OUT(\Delta VINL)}$ | DC Line regulation | $V_{LDO2} + 0.3\text{ V} < V_{IN} < 5.5\text{ V}$, $I_{OUT(LDO2)} = 10\text{ % of } I_{OUT_MAX}$ | | 0.2 | 0.5 | %/V |
| $\Delta V_{OUT(\Delta IOUT)}$ | DC Load regulation | $V_{IN} = V_{LDO2} + 0.3\text{ V to } 5.5\text{ V}$, $0\text{ mA} < I_{OUT} < I_{OUT_MAX}$ | | 0.5 | 1 | % |
| $\Delta V_{OUT(\Delta VINL)}^{[1]}$ | Transient Line Response | $V_{LDO2} + 0.3\text{ V} < V_{IN} < 5.5\text{ V}$, $I_{OUT(LDO2)} = 10\text{ % of } I_{OUT_MAX}$, $t_r = 10\text{ }\mu\text{s}$ | | 0.5 | | %/V |
| $\Delta V_{OUT(\Delta IOUT)}^{[1]}$ | Transient Load Response | $V_{IN} = V_{OUT} + 0.3\text{ V to } 5.5\text{ V}$, $1\text{ mA} < I_{OUT} < I_{OUT_MAX}$, $t_r = 10\text{ }\mu\text{s}$, $V_{LDO2} = 0.8\text{ V}$ | -3 | | 3 | % |
| $PSRR^{[1]}$ | Power Supply Rejection ratio | $f = 10\text{ Hz to } 10\text{ kHz}$, $I_{OUT} = 10\text{ % of } I_{OUT_MAX}$ | | 60 | | dB |
| $V_{soft_strup}^{[1]}$ | Soft-start slew rate | $I_{OUT} = 0\text{ mA}$, 10 % to 90 % of V_{LDO2} | | 15 | | mV/ μs |
| $V_{ov_srup}^{[1]}$ | Overshoot at startup | $I_{OUT} = 0\text{ mA}$ | | | 10 | mV |
| $t_{EN}^{[1]}$ | Enable time | EN rising to 90 % of output voltage | | 100 | | μs |
| POK | Output Power good | Percentage of V_{LDO2} configuration | 75 | 85 | 92 | % |
| R_{DIS} | Active Discharge Resistance | | | 100 | 150 | Ω |
| $C_{OUT}^{[1]}$ | Output capacitance | Minimum nominal capacitance | 1 | | | μF |

[1] Guaranteed by design

13.12 LDO3

Table 84. LDO3

Unless otherwise specified, $V_{SYS} = 3.8\text{ V}$, $V_{INBx} = 3.8\text{ V}$, $V_{INL1} = 3.8\text{ V}$, $V_{LDO3} = 1.8\text{ V}$, $C_{INL1} = 4.7\text{ }\mu\text{F}$, $C_{OUT} = 2.2\text{ }\mu\text{F}$, $T_{amb} = -40\text{ }^{\circ}\text{C} \sim +105\text{ }^{\circ}\text{C}$

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------------------------------|------------------------------|---|------|-----|-----|-------------------|
| V_{IN} | Input voltage range | INL1 | 2.85 | | 5.5 | V |
| $I_{Shutdown}$ | Shutdown current | Regulator disabled, $V_{IN} = 5.0\text{ V}$ | | 0.1 | | μA |
| I_Q | Quiescent current | Regulator enabled, No load | | 15 | | μA |
| I_{OUT_MAX} | Maximum Output DC Current | $V_{IN} > 2.8\text{ V}$, $V_{LDO3} = 1.8\text{ V}$ | 300 | | | mA |
| I_{LIMIT} | Short Current Limit | Output shorted to GND | 310 | | 480 | mA |
| V_{DO} | Dropout Voltage | $I_{OUT} = I_{OUT_MAX}$, $V_{IN} = 3.2\text{ V}$, $L3_OUT[4:0] = 0x1F$, 3.3 V | | 70 | 100 | mV |
| V_{LDO3} | Nominal output voltage | I ² C Programmable, 100 mV step | 0.8 | | 3.3 | V |
| | Default voltage | | | 1.8 | | V |
| | DC accuracy | $V_{LDO3} = 1.8\text{ V}$, $I_{Load} = 5\text{ mA}$ | -3 | | 3 | % |
| V_{NOISE} | Output noise | $f = 10\text{ Hz to } 10\text{ kHz}$, $I_{OUT} = 10\%$ of I_{MAX} , $V_{LDO3} = 1.8\text{ V}$ | | 150 | | μV |
| $\Delta V_{OUT(\Delta VINL)}$ | DC Line regulation | $V_{LDO3} + 0.3\text{ V} < V_{IN} < 5.5\text{ V}$, $I_{OUT(LDO3)} = 10\%$ of I_{OUT_MAX} | | 0.2 | 0.5 | %/V |
| $\Delta V_{OUT(\Delta IOUT)}$ | DC Load regulation | $V_{IN} = V_{LDO3} + 0.3\text{ V to } 5.5\text{ V}$, $0\text{ mA} < I_{OUT} < I_{OUT_MAX}$ | | 0.6 | | % |
| $\Delta V_{OUT(\Delta VINL)}^{[1]}$ | Transient Line Response | $V_{LDO3} + 0.3\text{ V} < V_{IN} < 5.5\text{ V}$, $I_{OUT(LDO3)} = 10\%$ of I_{OUT_MAX} , $t_r = 10\text{ }\mu\text{s}$ | | 0.5 | | %/V |
| $\Delta V_{OUT(\Delta IOUT)}^{[1]}$ | Transient Load Response | $V_{IN} = V_{LDO3} + 0.3\text{ V to } 5.5\text{ V}$, $1\text{ mA} < I_{OUT} < I_{OUT_MAX}$, $t_r = 10\text{ }\mu\text{s}$, $V_{LDO3} = 1.8\text{ V}$, $T_{amb} = 25\text{ }^{\circ}\text{C}$ | -3 | | 3 | % |
| $PSRR^{[1]}$ | Power Supply Rejection ratio | $f = 10\text{ Hz to } 10\text{ kHz}$, $I_{OUT} = 10\%$ of I_{OUT_MAX} | | 55 | | dB |
| $V_{soft_strup}^{[1]}$ | Soft-start slew rate | $I_{OUT} = 0\text{ mA}$, 10 % to 90 % of V_{LDO3} | | 15 | | mV/ μs |
| $V_{ov_strup}^{[1]}$ | Overshoot at startup | $I_{OUT} = 0\text{ mA}$ | | | 10 | mV |
| $t_{EN}^{[1]}$ | Enable time | EN rising to 90 % of output voltage | | 150 | | μs |
| POK | Output Power good | Percentage of V_{LDO3} configuration | 75 | 85 | 92 | % |
| R_{DIS} | Active Discharge Resistance | | | 100 | 150 | Ω |
| $C_{OUT}^{[1]}$ | Output capacitance | Minimum nominal capacitance | 2.2 | | | μF |

[1] Guaranteed by design

13.13 LDO4

Table 85. LDO4

Unless otherwise specified, $V_{SYS} = 3.8\text{ V}$, $V_{INBx} = 3.8\text{ V}$, $V_{INL1} = 3.8\text{ V}$, $V_{LDO4} = 0.9\text{ V}$, $C_{INL1} = 4.7\text{ }\mu\text{F}$, $C_{OUT} = 1\text{ }\mu\text{F}$, $T_{amb} = -40\text{ }^{\circ}\text{C} \sim +105\text{ }^{\circ}\text{C}$

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------------------------------|------------------------------|---|------|-----|-----|-------------------|
| V_{IN} | Input voltage range | INL1 | 2.85 | | 5.5 | V |
| $I_{Shutdown}$ | Shutdown current | Regulator disabled, $V_{IN} = 5.0\text{ V}$ | | 0.1 | | μA |
| I_Q | Quiescent current | Regulator enabled, No load | | 15 | | μA |
| I_{OUT_MAX} | Maximum Output DC Current | $V_{IN} > 2.8$, $V_{LDO4} = 0.9\text{ V}$ | 200 | | | mA |
| I_{LIMIT} | Short Current Limit | Output shorted to GND | 210 | | 330 | mA |
| V_{DO} | Dropout Voltage | $I_{OUT} = I_{OUT_MAX}$, $V_{IN} = 3.2\text{ V}$, $L4_OUT[4:0] = 0x1F$, 3.3 V | | 60 | 100 | mV |
| V_{LDO4} | Nominal output voltage | I ² C Programmable, 100 mV step | 0.8 | | 3.3 | V |
| | Default voltage | | | 0.9 | | V |
| | DC accuracy | $V_{LDO4} = 0.9\text{ V}$, $I_{Load} = 5\text{ mA}$ | -3 | | 3 | % |
| V_{NOISE} | Output noise | $f = 10\text{ Hz to } 10\text{ kHz}$, $I_{OUT} = 10\text{ \% of } I_{MAX}$, $V_{LDO4} = 0.9\text{ V}$ | | 150 | | μV |
| $\Delta V_{OUT(\Delta VINL)}$ | DC Line regulation | $V_{LDO4} + 0.3\text{ V} < V_{IN} < 5.5\text{ V}$, $I_{OUT(LDO4)} = 10\text{ \% of } I_{OUT_MAX}$ | | 0.2 | 0.5 | %/V |
| $\Delta V_{OUT(\Delta IOUT)}$ | DC Load regulation | $V_{IN} = V_{LDO4} + 0.3\text{ V to } 5.5\text{ V}$, $0\text{ mA} < I_{OUT} < I_{OUT_MAX}$ | | 0.9 | | % |
| $\Delta V_{OUT(\Delta VINL)}^{[1]}$ | Transient Line Response | $V_{LDO4} + 0.3\text{ V} < V_{IN} < 5.5\text{ V}$, $I_{OUT(LDO4)} = 10\text{ \% of } I_{OUT_MAX}$, $t_r = 10\text{ }\mu\text{s}$ | | 0.5 | | %/V |
| $\Delta V_{OUT(\Delta IOUT)}^{[1]}$ | Transient Load Response | $V_{IN} = V_{LDO4} + 0.3\text{ V to } 5.5\text{ V}$, $1\text{ mA} < I_{OUT} < I_{OUT_MAX}$, $t_r = 10\text{ }\mu\text{s}$, $V_{LDO4} = 0.9\text{ V}$, $T_{amb} = 25\text{ }^{\circ}\text{C}$ | -4 | | 4 | % |
| $PSRR^{[1]}$ | Power Supply Rejection ratio | $f = 10\text{ Hz to } 10\text{ kHz}$, $I_{OUT} = 10\text{ \% of } I_{OUT_MAX}$ | | 60 | | dB |
| $V_{soft_strup}^{[1]}$ | Soft-start slew rate | $I_{OUT} = 0\text{ mA}$, $10\text{ \% to } 90\text{ \% of } V_{LDO4}$ | | 20 | | mV/ μs |
| $V_{ov_strup}^{[1]}$ | Overshoot at startup | $I_{OUT} = 0\text{ mA}$ | | | 10 | mV |
| $t_{EN}^{[1]}$ | Enable time | EN rising to $90\text{ \% of output voltage}$ | | 100 | | μs |
| POK | Output Power good | Percentage of V_{LDO4} configuration | 75 | 85 | 92 | % |
| R_{DIS} | Active Discharge Resistance | | | 100 | 150 | Ω |
| $C_{OUT}^{[1]}$ | Output capacitance | Minimum nominal capacitance | 1 | | | μF |

[1] Guaranteed by design

13.14 LDO5

Table 86. LDO5

Unless otherwise specified, $V_{SYS} = 3.8\text{ V}$, $V_{INBx} = 3.8\text{ V}$, $V_{INL1} = 3.8\text{ V}$, $V_{LDO5} = 3.3\text{ V}$, $C_{INL1} = 4.7\text{ }\mu\text{F}$, $C_{OUT} = 1\text{ }\mu\text{F}$, $T_{amb} = -40\text{ }^{\circ}\text{C} \sim +105\text{ }^{\circ}\text{C}$

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------------------------------|------------------------------|--|---------------------|-----|-----|-------------------|
| V_{IN} | Input voltage range | INL1 pin | 2.85 | | 5.5 | V |
| | | INL1 pin, when $V_{LDO5} = 3.3\text{ V}$ | $V_{LDO5} + V_{DO}$ | | 5.5 | V |
| $I_{Shutdown}$ | Shutdown current | Regulator disabled, $V_{IN} = 5.0\text{ V}$ | | 0.1 | | μA |
| I_Q | Quiescent current | Regulator enabled, No load | | 15 | | μA |
| I_{OUT_MAX} | Maximum Output DC Current | $V_{IN} > V_{LDO5} + V_{DO(MAX)}$, $V_{LDO5} = 3.3\text{ V}$ | 150 | | | mA |
| I_{LIMIT} | Short Current Limit | Output shorted to GND | 160 | | 280 | mA |
| V_{DO} | Dropout Voltage | $I_{OUT} = I_{OUT_MAX}$, $V_{IN} = 3.2\text{ V}$, $L5_OUT_L[3:0] = 0xF$, 3.3 V | | 50 | 100 | mV |
| V_{LDO5} | Nominal output voltage | I ² C Programmable, 100 mV step | 1.8 | | 3.3 | V |
| | Default voltage | SD_VSEL = Low | | 3.3 | | V |
| | | SD_VSEL = High | | 1.8 | | V |
| | DC accuracy | $V_{LDO5} = 1.8\text{ V}$, $I_{Load} = 5\text{ mA}$ | -3 | | 3 | % |
| V_{NOISE} | Output noise | $f = 10\text{ Hz to }10\text{ kHz}$, $I_{OUT} = 10\%$ of I_{MAX} , $V_{LDO5} = 3.3\text{ V}$ | | 300 | | μV |
| $\Delta V_{OUT(\Delta VINL)}$ | DC Line regulation | $V_{LDO5} + 0.3\text{ V} < V_{IN} < 5.5\text{ V}$, $I_{OUT(LDO5)} = 10\%$ of I_{OUT_MAX} | | 0.2 | 0.5 | %/V |
| $\Delta V_{OUT(\Delta IOUT)}$ | DC Load regulation | $V_{IN} = V_{LDO5} + 0.3\text{ V to }5.5\text{ V}$, $0\text{ mA} < I_{OUT} < I_{OUT_MAX}$ | | 0.3 | | % |
| $\Delta V_{OUT(\Delta VINL)}^{[1]}$ | Transient Line Response | $V_{LDO5} + 0.3\text{ V} < V_{IN} < 5.5\text{ V}$, $I_{OUT(LDO5)} = 10\%$ of I_{OUT_MAX} | | 0.5 | | %/V |
| $\Delta V_{OUT(\Delta IOUT)}^{[1]}$ | Transient Load Response | $V_{IN} = V_{LDO5} + 0.3\text{ V to }5.5\text{ V}$, $1\text{ mA} < I_{OUT} < I_{OUT_MAX}$, $t_r = 10\text{ }\mu\text{s}$, $V_{LDO5} = 3.3\text{ V}$, $T_{amb} = 25\text{ }^{\circ}\text{C}$ | -3 | | 3 | % |
| PSRR ^[1] | Power Supply Rejection ratio | $f = 10\text{ Hz to }10\text{ kHz}$, $I_{OUT} = 10\%$ of I_{OUT_MAX} | | 50 | | dB |
| $V_{soft_strup}^{[1]}$ | Soft-start slew rate | $I_{OUT} = 0\text{ mA}$, 10 % to 90 % of V_{LDO5} | | 15 | | mV/ μs |
| $V_{ov_strup}^{[1]}$ | Overshoot at startup | $I_{OUT} = 0\text{ mA}$ | | | 10 | mV |
| $t_{EN}^{[1]}$ | Enable time | EN rising to 90 % of output voltage | | 200 | | μs |
| POK | Output Power good | Percentage of V_{LDO5} configuration | 75 | 85 | 92 | % |
| R_{DIS} | Active Discharge Resistance | | | 100 | 150 | Ω |
| $C_{OUT}^{[1]}$ | Output capacitance | Minimum nominal capacitance | 1 | | | μF |

[1] Guaranteed by design

13.15 Load SW

Table 87. Load SW

Unless otherwise specified, $V_{SYS} = 3.8\text{ V}$, $V_{INBx} = 3.8\text{ V}$, $V_{INL1} = 3.8\text{ V}$, $V_{SWIN} = 3.8\text{ V}$, $C_{SWIN} = C_{SWOUT} = 1\text{ }\mu\text{F}$, $T_{amb} = -40\text{ }^{\circ}\text{C} \sim +105\text{ }^{\circ}\text{C}$

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|----------------|---------------------------------|--|-----|-----|-----|---------------|
| V_{SWIN} | Input voltage range | SWIN | 2.8 | | 5.5 | V |
| I_Q | Quiescent current | Switch enabled, No load, $V_{SWIN} = 3.3\text{ V}$ | | 5 | 8 | μA |
| I_{SHDN} | Shut down current | $SWEN = 0\text{ V}$, $V_{SWIN} = 3.3\text{ V}$ | | 1 | 2.5 | μA |
| $I_{OC}^{[1]}$ | OverCurrent Threshold | | 450 | 800 | | mA |
| $I_{SC}^{[1]}$ | Short circuit current threshold | | | 2 | | A |
| R_{DSON} | Switch ON resistance | $V_{SWIN} = 3.3\text{ V}$, $I_{LOAD} = 200\text{ mA}$, including bonding wire resistance | | 150 | 210 | m Ω |
| $t_{EN}^{[1]}$ | Enable time | Time to SWOUT 10 % from EN pin high, $V_{SWIN} = 3.3\text{ V}$ | | 90 | 120 | μs |
| $t_{ON}^{[1]}$ | Output rise time | $CL = 10\text{ }\mu\text{F}$, $V_{SWIN} = 3.3\text{ V}$, SWOUT 10 % to 90 % | | 200 | 500 | μs |
| R_{DIS} | Active Discharge Resistance | $SWEN = 0\text{ V}$ | | 80 | 120 | Ω |

[1] Guaranteed by design

13.16 32 kHz Xtal driver

Table 88. 32 kHz Xtal driver

Unless otherwise specified, $V_{SYS} = 3.8\text{ V}$, $V_{INBx} = 3.8\text{ V}$, $V_{INL1} = 3.8$, $T_{amb} = -40\text{ }^{\circ}\text{C} \sim +105\text{ }^{\circ}\text{C}$

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---------------------|-------------------------------|--|-----|--------|-----|------|
| f_{OSC_32K} | Clock frequency | Internal Oscillator | 29 | 32.77 | 36 | kHz |
| $f_{CLK}^{[1]}$ | Clock frequency | External 32.768 kHz crystal oscillator | | 32.768 | | kHz |
| $t_{RTCSTB}^{[1]}$ | Oscillator stabilization time | | | 1000 | | ms |
| Duty ^[1] | Output Duty cycle | External 32.768 kHz crystal oscillator | 30 | 50 | 70 | % |
| V_{OL} | Output Low level | $I_{OL} = 1\text{ mA}$ | | | 0.4 | V |
| V_{OH} | Output High level | $V_{LDO1} = 1.8\text{ V}$, $I_{OL} = 1\text{ mA}$ | 1.6 | | | V |

[1] Guaranteed by design

13.17 I²C-bus interface and logic I/O

Table 89. I²C-bus interface and logic I/O

Unless otherwise specified, $V_{SYS} = 3.8\text{ V}$, $V_{INBx} = 3.8\text{ V}$, $V_{INL1} = 3.8$, $T_{amb} = -40\text{ }^{\circ}\text{C} \sim +105\text{ }^{\circ}\text{C}$

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--------------------|---|---|------|-----|------|---------------|
| SCL, SDA | | | | | | |
| f_{I2C} | I ² C Clock frequency | | - | - | 1 | MHz |
| V_{IH} | High-level Input voltage | SCL, SDA; $V_{SYS} = 3.0\text{ V to }5.5\text{ V}$ | 1.2 | - | - | V |
| V_{IL} | Low-level Input voltage | SCL, SDA; $V_{SYS} = 3.0\text{ V to }5.5\text{ V}$ | - | - | 0.4 | V |
| V_{hys} | Hysteresis of Schmitt trigger inputs | | 0.01 | - | - | V |
| VOL | Low-level output voltage | SDA, Iload = 20 mA, $V_{SYS} = 3.0\text{ V to }5.5\text{ V}$ | 0 | - | 0.4 | V |
| $t_{HD,STA}^{[1]}$ | Hold time (repeated) START condition | Fast mode plus; After this period, the first clock pulse is generated | 0.26 | - | - | μs |
| $t_{LOW}^{[1]}$ | LOW period of I2C clock | Fast mode plus | 0.5 | - | - | μs |
| $t_{HIGH}^{[1]}$ | HIGH period of I2C clock | Fast mode plus | 0.26 | - | - | μs |
| $t_{SU,STA}^{[1]}$ | Setup time (repeated) START condition | Fast mode plus | 0.26 | - | - | μs |
| $t_{HD,DAT}^{[1]}$ | Data Hold time | Fast mode plus | 0 | - | - | μs |
| $t_{SU,DAT}^{[1]}$ | Data Setup time | Fast mode plus | 50 | - | - | ns |
| $t_r^{[1]}$ | Rise time of I2C_SCL and I2C_SDA signals | Fast mode plus | - | - | 120 | ns |
| $t_f^{[1]}$ | Fall time of I2C_SCL and I2C_SDA signals | Fast mode plus | - | - | 120 | ns |
| $t_{SU,STO}^{[1]}$ | Setup time for STOP condition | Fast mode plus | 0.26 | - | - | μs |
| $t_{BUF}^{[1]}$ | Bus free time between STOP and START condition | Fast mode plus | 0.5 | - | - | μs |
| $t_{VD,DAT}^{[1]}$ | Data valid time | Fast mode plus | | - | 0.45 | μs |
| $t_{VD,ACK}^{[1]}$ | Data valid acknowledge time | Fast mode plus | | - | 0.45 | μs |
| $t_{SP}^{[1]}$ | Pulse width of spikes that must be suppressed by input filter | | 0 | - | 50 | ns |

[1] Guaranteed by design

14 Package outline

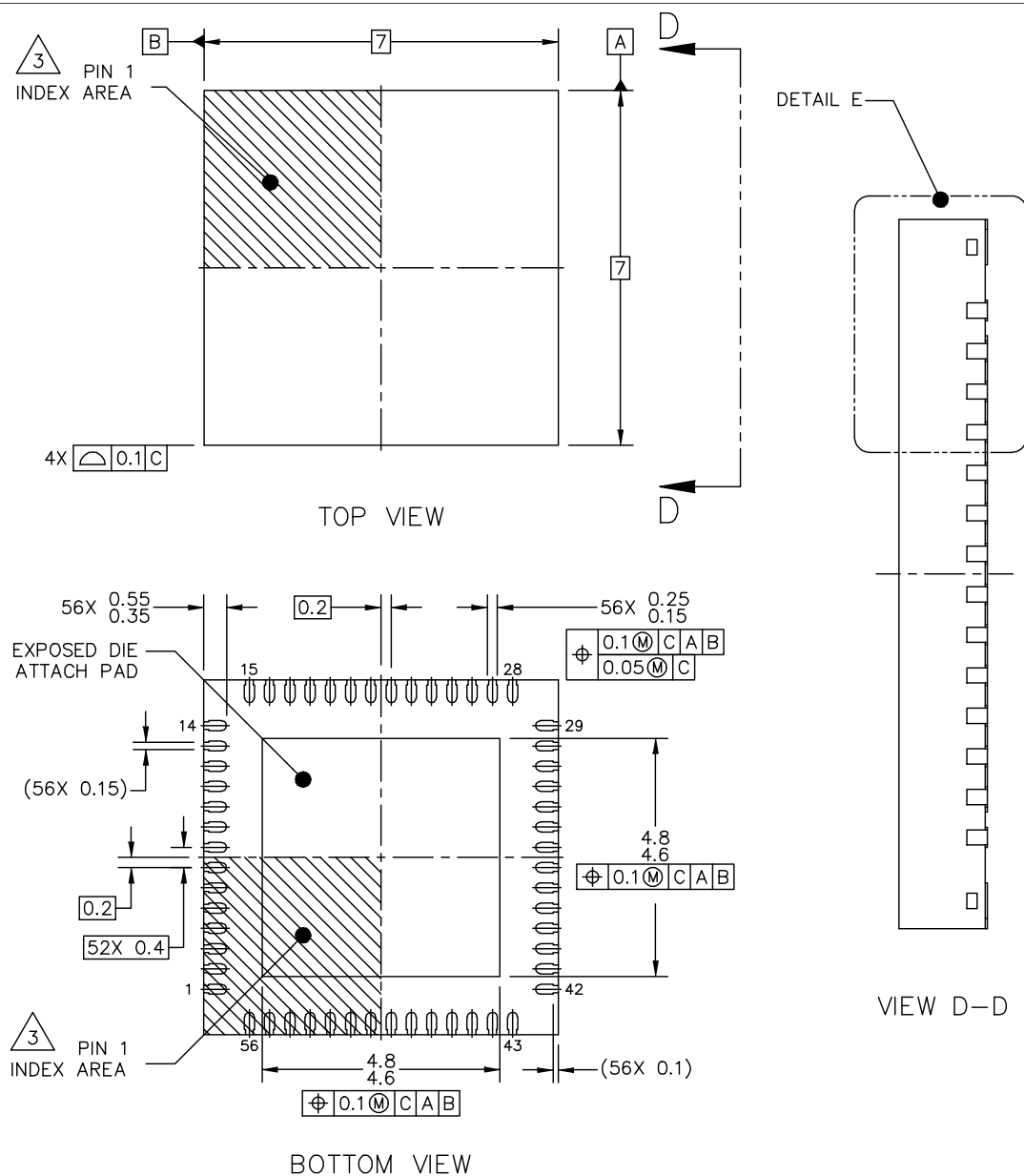
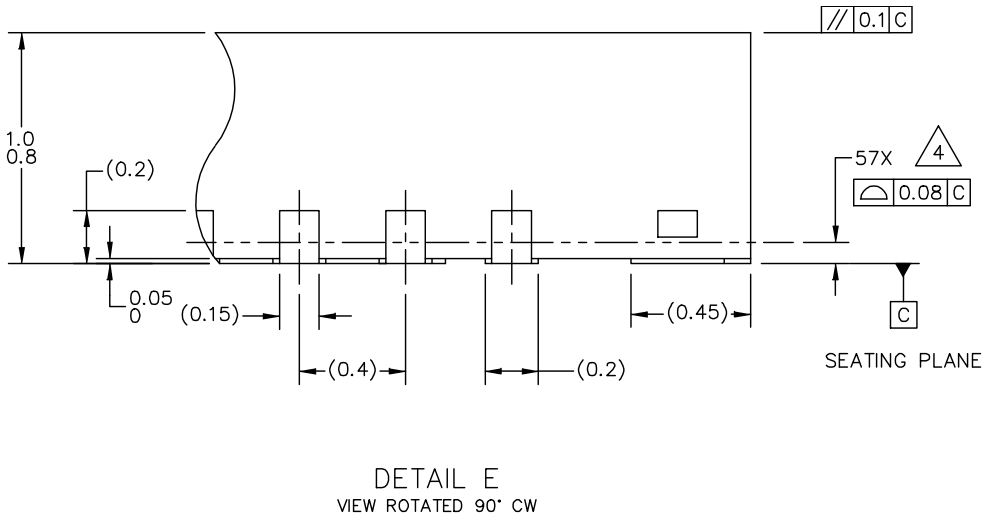
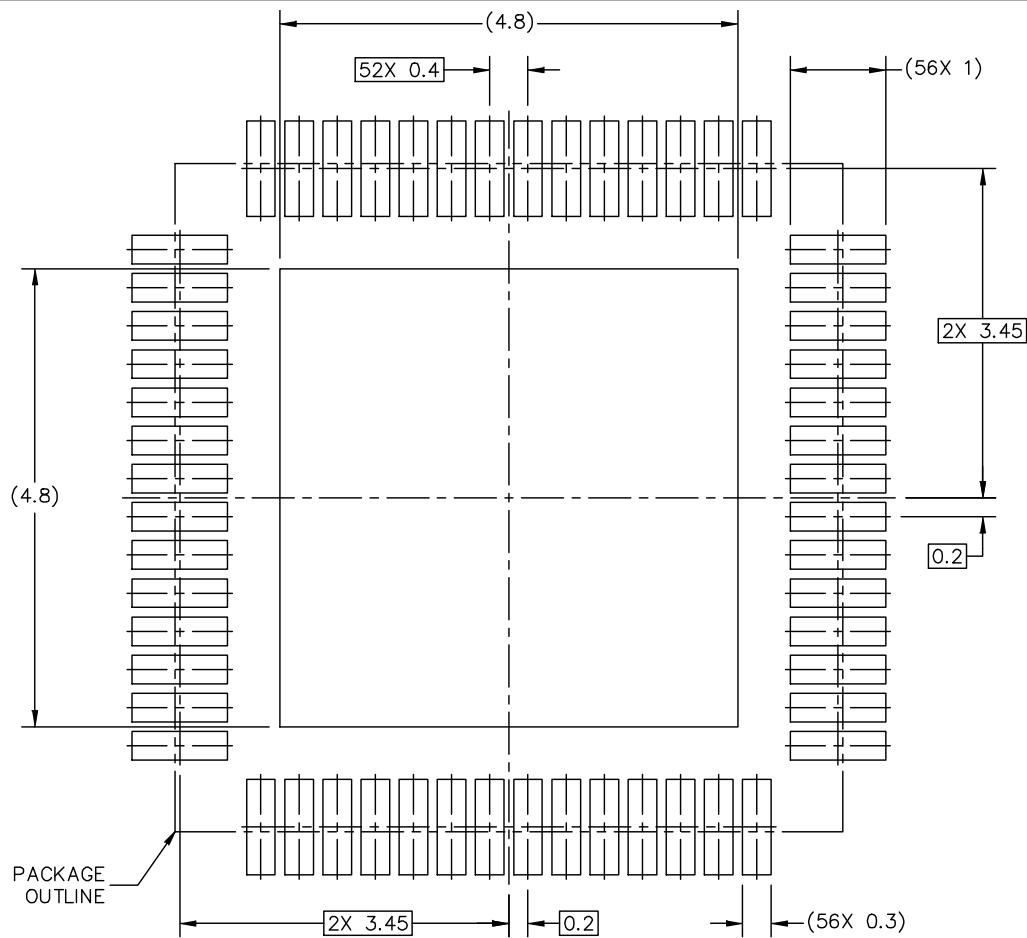


Figure 26. Package outline HVQFN56 (SOT949-6)



| | | | | |
|--|------------------------|--------------------------------|-------------------|--|
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| MECHANICAL OUTLINE PRINT VERSION NOT TO SCALE | STANDARD: NON JEDEC | DRAWING NUMBER: 98ASA01369D | REVISION: A | |

Figure 27. Package outline HVQFN56 (SOT949-6)

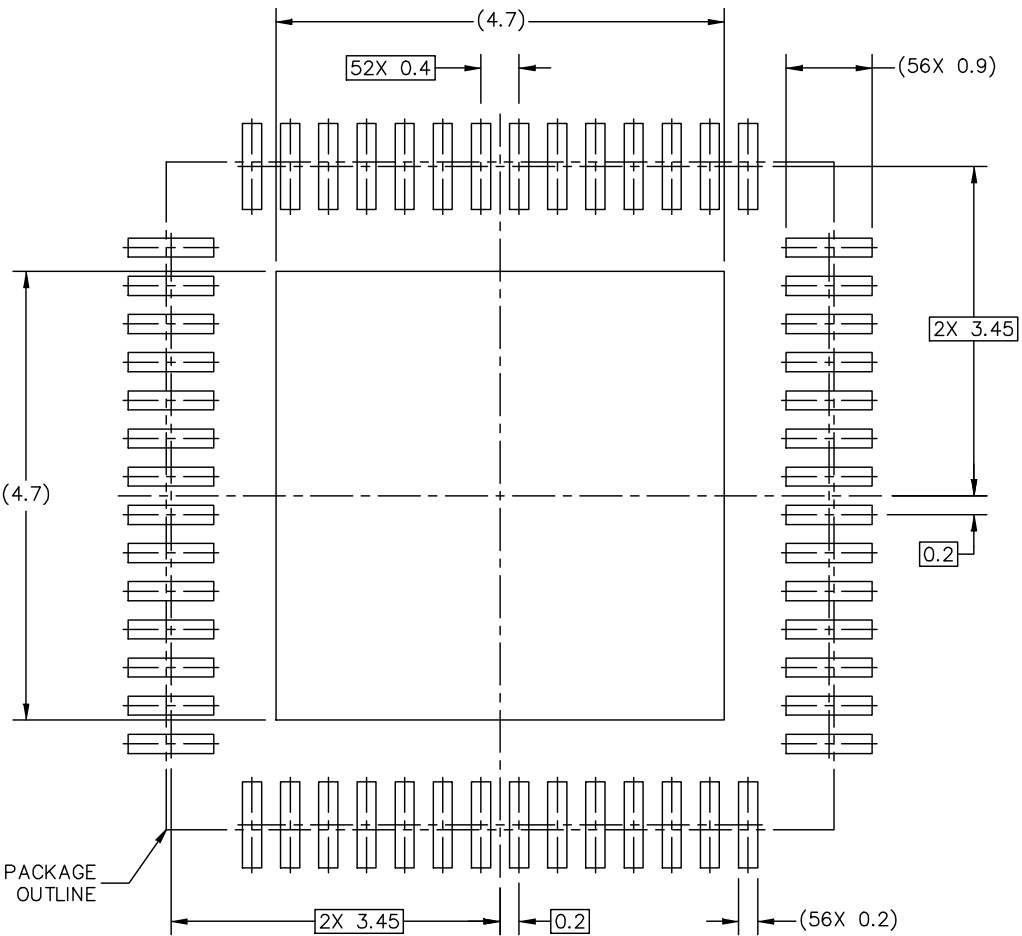


PCB DESIGN GUIDELINES – SOLDER MASK OPENING PATTERN

THIS SHEET SERVES ONLY AS A GUIDELINE TO HELP DEVELOP A USER SPECIFIC SOLUTION. DEVELOPMENT EFFORT WILL STILL BE REQUIRED BY END USERS TO OPTIMIZE PCB MOUNTING PROCESSES AND BOARD DESIGN IN ORDER TO MEET INDIVIDUAL/SPECIFIC REQUIREMENTS.

| | | | | |
|--|------------------------|--------------------------------|-------------------|--|
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Figure 28. PCB Design Guidelines – Solder Mask Opening Pattern



PCB DESIGN GUIDELINES – I/O PADS AND SOLDERABLE AREA

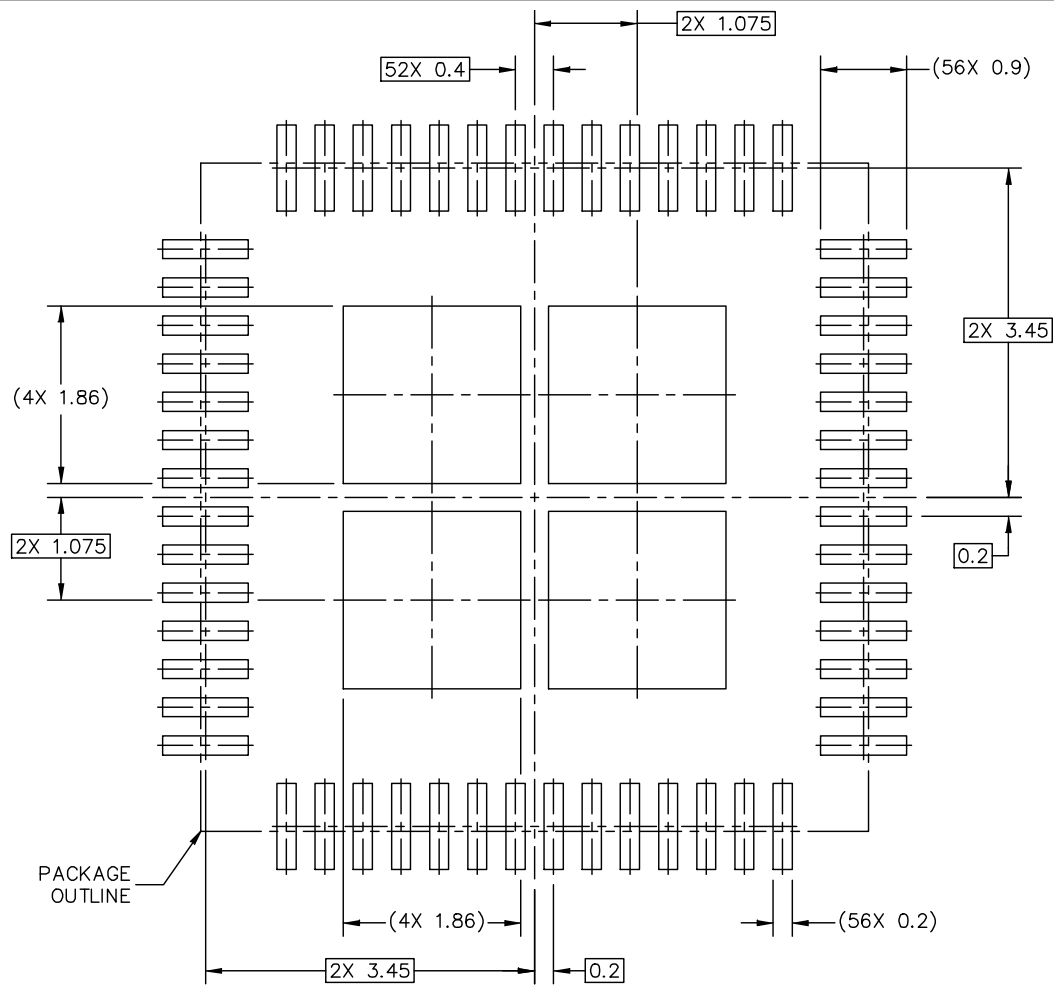
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| | | | | |
|--|------------------------|--------------------------------|----------------|--|
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|--|------------------------|--------------------------------|----------------|--|

Figure 29. PCB Design Guidelines - I/O PADS AND SOLDERABLE AREA



RECOMMENDED STENCIL THICKNESS 0.1

PCB DESIGN GUIDELINES – SOLDER PASTE STENCIL

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| | | | | |
|--|------------------------|--------------------------------|----------------|--|
| MECHANICAL OUTLINE PRINT VERSION NOT TO SCALE | STANDARD: NON JEDEC | DRAWING NUMBER: 98ASA01369D | REVISION: A | |
|--|------------------------|--------------------------------|----------------|--|

Figure 30. PCB Design Guidelines – Solder Paste Stencil

15 Revision history

Table 90. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|----------------|---|--------------------|---------------|--------------|
| PCA9450 v2.2 | 20210915 | Product data sheet | - | PCA9450 v2.1 |
| Modifications: | <ul style="list-style-type: none"> • Table 2: Added T_J column • Figure 22: Updated LDO4 voltage • Table 10; Table 29: Updated bit 5:4 11b description from "Reserved" to "Cold Reset, All voltage regulators are recycled " | | | |
| PCA9450 v2.1 | 20201207 | Product data sheet | - | PCA9450 v2.0 |
| Modifications: | <ul style="list-style-type: none"> • Table 3: Updated description for pin 22 SWIN • Table 20: Device_ID Register "Reset Value" changed from "0x10" to "0x11" • Table 21: RSVD bit changed from "0000" to "0001" | | | |
| PCA9450 v2.0 | 20200924 | Product data sheet | - | PCA9450 v1.0 |
| Modifications: | <ul style="list-style-type: none"> • Replaced "PCA9450A" with "PCA9450AA" throughout • Table 79: Added POK information • Table 86: Updated conditions for V_{IN} and I_{OUT_MAX} • Figure 1: Corrected LDO3 capacitor value; added footnote • Figure 21, Figure 22: Added footnote • Figure 23: Corrected LDO2, added footnote • Figure 5: Corrected VINT • Section 7.3.7: Corrected paragraph 1 • Section 9.2.1.1: Corrected equations (1) and (2) | | | |
| PCA9450 v1.0 | 20191119 | Product data sheet | - | - |

16 Legal information

16.1 Data sheet status

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

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Tables

| | | | | | |
|----------|--|----|----------|---|----|
| Tab. 1. | Ordering information | 2 | Tab. 47. | 0x1A BUCK4OUT | 43 |
| Tab. 2. | Ordering options | 2 | Tab. 48. | 0x1B BUCK5CTRL | 43 |
| Tab. 3. | Pin description | 4 | Tab. 49. | 0x1C BUCK5OUT | 44 |
| Tab. 4. | PCA9450 selection guide | 8 | Tab. 50. | 0x1D BUCK6CTRL | 44 |
| Tab. 5. | SNVS mode | 10 | Tab. 51. | 0x1E BUCK6OUT | 44 |
| Tab. 6. | PWRUP mode | 12 | Tab. 52. | BUCK4, BUCK5, BUCK6 Output voltage table | 45 |
| Tab. 7. | Power modes summary | 13 | Tab. 53. | 0x20 LDO_AD_CTRL | 46 |
| Tab. 8. | tFLT_THSD | 15 | Tab. 54. | 0x21 LDO1CTRL | 46 |
| Tab. 9. | tFLT_SD_WAIT | 17 | Tab. 55. | 0x22 LDO2CTRL | 47 |
| Tab. 10. | 0x08 – RESET_CTRL | 18 | Tab. 56. | 0x23 LDO3CTRL | 48 |
| Tab. 11. | 0x06 – SW_RST | 18 | Tab. 57. | LDO3 output voltage | 48 |
| Tab. 12. | tRESTART | 19 | Tab. 58. | 0x24 LDO4CTRL | 48 |
| Tab. 13. | tRESET | 20 | Tab. 59. | LDO4 output voltage | 48 |
| Tab. 14. | PCA9450AA Regulator Control summary | 20 | Tab. 60. | 0x25 LDO5CTRL_L | 49 |
| Tab. 15. | PCA9450B/PCA9450C Regulator Control summary | 21 | Tab. 61. | LDO5 output voltage when SD_VSEL = Low | 49 |
| Tab. 16. | PCA9450AA Buck Summary | 22 | Tab. 62. | 0x26 LDO5CTRL_H | 49 |
| Tab. 17. | PCA9450C Buck Summary | 22 | Tab. 63. | LDO5 output voltage when SD_VSEL = High | 49 |
| Tab. 18. | LDO summary | 24 | Tab. 64. | 0x2A LOADSW_CTRL | 50 |
| Tab. 19. | PCA9450 I2C Slave Address | 27 | Tab. 65. | 0x2B VRFLT1_STS | 50 |
| Tab. 20. | Register map | 28 | Tab. 66. | 0x2C VRFLT2_STS | 51 |
| Tab. 21. | 0x00 Device_ID | 31 | Tab. 67. | 0x2D VRFLT1_MASK | 52 |
| Tab. 22. | 0x01 INT1 | 31 | Tab. 68. | 0x2E VRFLT2_MASK | 52 |
| Tab. 23. | 0x02 INT1_MSK | 32 | Tab. 69. | Tested inductor list | 58 |
| Tab. 24. | 0x03 STATUS1 | 32 | Tab. 70. | Limiting values | 63 |
| Tab. 25. | 0x04 STATUS2 | 33 | Tab. 71. | Recommended Operating Conditions | 64 |
| Tab. 26. | 0x05 PWRON_STAT | 34 | Tab. 72. | Thermal characteristics | 65 |
| Tab. 27. | 0x06 SW_RST | 34 | Tab. 73. | Top level parameter | 66 |
| Tab. 28. | 0x07 PWR_CTRL | 34 | Tab. 74. | I2C level translator | 69 |
| Tab. 29. | 0x08 RESET_CTRL | 35 | Tab. 75. | BUCK1 (PCA9450AA/PCA9450B) | 70 |
| Tab. 30. | 0x09 CONFIG1 | 36 | Tab. 76. | Dual Phase BUCK1 (PCA9450C) | 71 |
| Tab. 31. | 0x0A CONFIG2 | 36 | Tab. 77. | BUCK2 | 72 |
| Tab. 32. | 0x0C BUCK123_DVS | 37 | Tab. 78. | BUCK3 (PCA9450AA) | 73 |
| Tab. 33. | 0x0D BUCK1OUT_LIMIT | 37 | Tab. 79. | BUCK4 | 74 |
| Tab. 34. | 0x0E BUCK2OUT_LIMIT | 37 | Tab. 80. | BUCK5 | 75 |
| Tab. 35. | 0x0F BUCK3OUT_LIMIT | 38 | Tab. 81. | BUCK6 | 76 |
| Tab. 36. | 0x10 BUCK1CTRL | 38 | Tab. 82. | LDO1 | 77 |
| Tab. 37. | 0x11 BUCK1OUT_DVS0 | 39 | Tab. 83. | LDO2 | 78 |
| Tab. 38. | 0x12 BUCK1OUT_DVS1 | 39 | Tab. 84. | LDO3 | 79 |
| Tab. 39. | 0x13 BUCK2CTRL | 39 | Tab. 85. | LDO4 | 80 |
| Tab. 40. | 0x14 BUCK2OUT_DVS0 | 40 | Tab. 86. | LDO5 | 81 |
| Tab. 41. | 0x15 BUCK2OUT_DVS1 | 40 | Tab. 87. | Load SW | 82 |
| Tab. 42. | 0x16 BUCK3CTRL | 40 | Tab. 88. | 32 kHz Xtal driver | 83 |
| Tab. 43. | 0x17 BUCK3OUT_DVS0 | 41 | Tab. 89. | I2C-bus interface and logic I/O | 84 |
| Tab. 44. | 0x18 BUCK3OUT_DVS1 | 41 | Tab. 90. | Revision history | 90 |
| Tab. 45. | BUCK1, BUCK2, BUCK3 Output voltage table | 42 | | | |
| Tab. 46. | 0x19 BUCK4CTRL | 43 | | | |

Figures

| | | | | | |
|---------|--|---|---------|--|----|
| Fig. 1. | Block diagram | 3 | Fig. 5. | SNVS mode ON/OFF sequence | 10 |
| Fig. 2. | PCA9450 pin map – Top View | 4 | Fig. 6. | PCA9450AA power ON/OFF sequence | 11 |
| Fig. 3. | PCA9450 functional block diagram | 8 | Fig. 7. | PCA9450B/C power ON/OFF sequence | 12 |
| Fig. 4. | Power States Diagram | 9 | Fig. 8. | PCA9450AA mode transition | 13 |

| | | | | | |
|----------|--|----|----------|---|----|
| Fig. 9. | PCA9450 FAULT_SD from Thermal shutdown | 15 | Fig. 20. | Interrupt diagram | 27 |
| Fig. 10. | PCA9450 Fault event | 16 | Fig. 21. | PCA9450AA application schematic | 55 |
| Fig. 11. | PCA9450 FAULT_SD from VR Fault except LDO1/LDO2 in RUN/STANDBY | 17 | Fig. 22. | PCA9450B application schematic | 56 |
| Fig. 12. | PCA9450AA Cold reset | 19 | Fig. 23. | PCA9450C application schematic | 57 |
| Fig. 13. | Warm reset | 20 | Fig. 24. | Crystal oscillator | 60 |
| Fig. 14. | DVS functional diagram | 23 | Fig. 25. | PCA9450 layout | 62 |
| Fig. 15. | DVS timing | 23 | Fig. 26. | Package outline HVQFN56 (SOT949-6) | 85 |
| Fig. 16. | BUCK1/3 configuration | 24 | Fig. 27. | Package outline HVQFN56 (SOT949-6) | 86 |
| Fig. 17. | 32 kHz Crystal oscillator driver block diagram | 25 | Fig. 28. | PCB Design Guidelines – Solder Mask Opening Pattern | 87 |
| Fig. 18. | Load switch internal block diagram | 25 | Fig. 29. | PCB Design Guidelines - I/O PADS AND SODERABLE AREA | 88 |
| Fig. 19. | Architecture of I2C Level translator (One channel) | 26 | Fig. 30. | PCB Design Guidelines – Solder Paste Stencil | 89 |

Contents

| | | | | | |
|----------|--|-----------|-----------|--|-----------|
| 1 | General description | 1 | 8.2.22 | 0x16 BUCK3CTRL | 40 |
| 2 | Features and benefits | 1 | 8.2.23 | 0x17 BUCK3OUT_DVS0 | 41 |
| 3 | Applications | 2 | 8.2.24 | 0x18 BUCK3OUT_DVS1 | 41 |
| 4 | Ordering information | 2 | 8.2.25 | 0x19 BUCK4CTRL | 42 |
| 5 | Block diagram | 3 | 8.2.26 | 0x1A BUCK4OUT | 43 |
| 6 | Pinning information | 4 | 8.2.27 | 0x1B BUCK5CTRL | 43 |
| 6.1 | Pinning | 4 | 8.2.28 | 0x1C BUCK5OUT | 44 |
| 6.2 | Pin description | 4 | 8.2.29 | 0x1D BUCK6CTRL | 44 |
| 7 | Functional description | 7 | 8.2.30 | 0x1E BUCK6OUT | 44 |
| 7.1 | Features | 7 | 8.2.31 | 0x20 LDO_AD_CTRL | 46 |
| 7.2 | Functional diagram | 8 | 8.2.32 | 0x21 LDO1CTRL | 46 |
| 7.3 | Power modes | 9 | 8.2.33 | 0x22 LDO2CTRL | 47 |
| 7.3.1 | Off mode | 9 | 8.2.34 | 0x23 LDO3CTRL | 47 |
| 7.3.2 | READY mode | 9 | 8.2.35 | 0x24 LDO4CTRL | 48 |
| 7.3.3 | SNVS mode | 9 | 8.2.36 | 0x25 LDO5CTRL_L | 49 |
| 7.3.4 | PWRUP mode | 10 | 8.2.37 | 0x26 LDO5CTRL_H | 49 |
| 7.3.5 | PWRDN mode | 12 | 8.2.38 | 0x2A LOADSW_CTRL | 50 |
| 7.3.6 | RUN mode | 12 | 8.2.39 | 0x2B VRFLT1_STS | 50 |
| 7.3.7 | STANDBY mode | 13 | 8.2.40 | 0x2C VRFLT2_STS | 51 |
| 7.3.8 | FAULT_SD | 14 | 8.2.41 | 0x2D VRFLT1_MASK | 52 |
| 7.4 | PMIC reset | 18 | 8.2.42 | 0x2E VRFLT2_MASK | 52 |
| 7.5 | Regulator control in each power mode | 20 | 9 | Application design-in information | 54 |
| 7.6 | Regulator summary | 21 | 9.1 | Reference schematic | 54 |
| 7.6.1 | BUCK regulator | 21 | 9.1.1 | PCA9450AA reference schematic | 54 |
| 7.6.1.1 | Dynamic voltage scaling | 22 | 9.1.2 | PCA9450B reference schematic | 56 |
| 7.6.1.2 | BUCK output voltage limiting | 23 | 9.1.3 | PCA9450C reference schematic | 57 |
| 7.6.1.3 | Dual-phase configuration | 23 | 9.2 | Typical application | 58 |
| 7.6.2 | LDO and load switch | 24 | 9.2.1 | Buck regulators | 58 |
| 7.7 | 32 kHz Crystal Oscillator Driver | 24 | 9.2.1.1 | Inductor selection for buck converters | 58 |
| 7.8 | Load switch | 25 | 9.2.1.2 | Output capacitor selection for buck converters | 59 |
| 7.9 | I2C level translator | 25 | 9.2.1.3 | Input capacitor selection for buck converters | 59 |
| 7.10 | Interrupt management | 26 | 9.2.2 | Crystal oscillator | 59 |
| 8 | Software interface | 27 | 9.2.2.1 | Crystal selection | 59 |
| 8.1 | Register map | 28 | 9.2.2.2 | Effective load capacitance | 60 |
| 8.2 | Register details | 31 | 9.2.2.3 | Frequency tuning | 61 |
| 8.2.1 | 0x00 Device_ID | 31 | 9.3 | Layout guide | 61 |
| 8.2.2 | 0x01 INT1 | 31 | 10 | Limiting values | 63 |
| 8.2.3 | 0x02 INT1_MSK | 32 | 11 | Recommended operating conditions | 64 |
| 8.2.4 | 0x03 STATUS1 | 32 | 12 | Thermal characteristics | 65 |
| 8.2.5 | 0x04 STATUS2 | 33 | 13 | Electrical characteristics | 66 |
| 8.2.6 | 0x05 PWRON_STAT | 33 | 13.1 | Top level parameter | 66 |
| 8.2.7 | 0x06 SW_RST | 34 | 13.2 | I2C level translator | 69 |
| 8.2.8 | 0x07 PWR_CTRL | 34 | 13.3 | BUCK1 (PCA9450AA/PCA9450B) | 70 |
| 8.2.9 | 0x08 RESET_CTRL | 35 | 13.4 | Dual Phase BUCK1 (PCA9450C) | 71 |
| 8.2.10 | 0x09 CONFIG1 | 36 | 13.5 | BUCK2 | 72 |
| 8.2.11 | 0x0A CONFIG2 | 36 | 13.6 | BUCK3 (PCA9450AA) | 73 |
| 8.2.12 | 0x0C BUCK123_DVS | 37 | 13.7 | BUCK4 | 74 |
| 8.2.13 | 0x0D BUCK1OUT_LIMIT | 37 | 13.8 | BUCK5 | 75 |
| 8.2.14 | 0x0E BUCK2OUT_LIMIT | 37 | 13.9 | BUCK6 | 76 |
| 8.2.15 | 0x0F BUCK3OUT_LIMIT | 38 | 13.10 | LDO1 | 77 |
| 8.2.16 | 0x10 BUCK1CTRL | 38 | 13.11 | LDO2 | 78 |
| 8.2.17 | 0x11 BUCK1OUT_DVS0 | 39 | 13.12 | LDO3 | 79 |
| 8.2.18 | 0x12 BUCK1OUT_DVS1 | 39 | 13.13 | LDO4 | 80 |
| 8.2.19 | 0x13 BUCK2CTRL | 39 | 13.14 | LDO5 | 81 |
| 8.2.20 | 0x14 BUCK2OUT_DVS0 | 40 | | | |
| 8.2.21 | 0x15 BUCK2OUT_DVS1 | 40 | | | |

| | | |
|-----------|---------------------------------------|-----------|
| 13.15 | Load SW | 82 |
| 13.16 | 32 kHz Xtal driver | 83 |
| 13.17 | I2C-bus interface and logic I/O | 84 |
| 14 | Package outline | 85 |
| 15 | Revision history | 90 |
| 16 | Legal information | 91 |

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